

ZL50018 2 K Digital Switch with Enhanced Stratum 3 DPLL

Data Sheet

July 2005

Features

- 2048 channel x 2048 channel non-blocking digital Time Division Multiplex (TDM) switch at 8.192 and 16.384 Mbps or using a combination of ports running at 2.048, 4.096, 8.192 and/or 16.384 Mbps
- 32 serial TDM input, 32 serial TDM output streams
- Integrated Digital Phase-Locked Loop (DPLL) exceeds Telcordia GR-1244-CORE Stratum 3 specifications
- Output clocks have less than 1 ns of jitter (except for the 1.544 MHz output)
- DPLL provides holdover, freerun and jitter attenuation features with four independent reference source inputs

Ordering Information

ZL50018GAC 256 Ball PBGA Trays ZL50018QCC 256 Lead LQFP Trays -40°C to +85°C

- Programmable key DPLL parameters (filter corner frequency, locking range, auto-holdover hysteresis range, phase slope, lock detector range)
- Exceptional input clock cycle to cycle variation tolerance (20 ns for all rates)
- Output streams can be configured as bidirectional for connection to backplanes

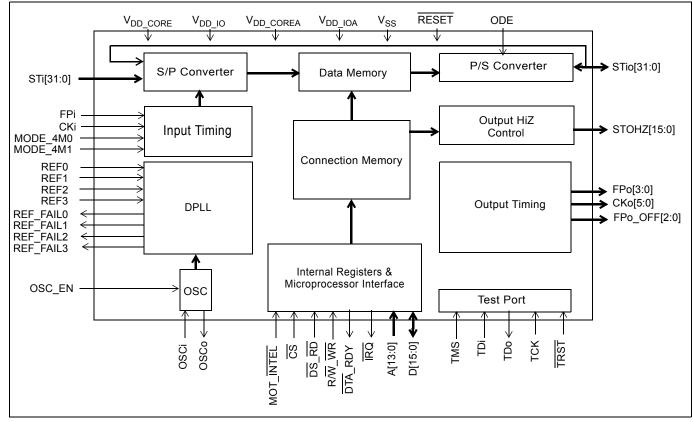


Figure 1 - ZL50018 Functional Block Diagram

Zarlink Semiconductor US Patent No. 5,602,884, UK Patent No. 0772912, France Brevete S.G.D.G. 0772912; Germany DBP No. 69502724.7-08

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- Per-stream input and output data rate conversion selection at 2.048, 4.096, 8.192 or 16.384 Mbps. Input and output data rates can differ
- Per-stream high impedance control outputs (STOHZ) for up to 16 output streams
- Per-stream input bit delay with flexible sampling point selection
- Per-stream output bit and fractional bit advancement
- Per-channel ITU-T G.711 PCM A-Law/μ-Law Translation
- Multiple frame pulse and reference clock output
- Input clock: 4.096 MHz, 8.192 MHz, 16.384 MHz
- Input frame pulses: 61 ns, 122 ns, 244 ns
- Per-channel constant or variable throughput delay for frame integrity and low latency applications
- Per Stream Bit Error Rate Test circuits
- Per-channel high impedance output control
- Per-channel message mode
- · Control interface compatible with Intel and Motorola 16-bit non-multiplexed buses
- Connection memory block programming
- · Supports ST-BUS and GCI-Bus standards for input and output timing
- IEEE-1149.1 (JTAG) test port
- 3.3 V I/O with 5 V tolerant inputs; 1.8 V core voltage

Applications

- PBX and IP-PBX
- Small and medium digital switching platforms
- · Wireless base stations and controllers
- · Remote access servers and concentrators
- Multi service access platforms
- Digital Loop Carriers
- Computer Telephony Integration

Description

The ZL50018 is a maximum 2,048 x 2,048 channel non-blocking digital Time Division Multiplex (TDM) switch. It has thirty-two input streams (STi0 - 31) and thirty-two output streams (STio0 - 31). The device can switch 64 kbps and Nx64 kbps TDM channels from any input stream to any output stream. Each of the input and output streams can be independently programmed to operate at any of the following data rates: 2.048, 4.096, 8.192 or 16.384 Mbps. The ZL50018 provides up to sixteen high impedance control outputs (STOHZ0 - 15) to support the use of external tristate drivers for the first sixteen output streams (STio0 - 15). The output streams can be configured to operate in bi-directional mode, in which case STi0 - 31 will be ignored.

The device contains two types of internal memory - data memory and connection memory. There are four modes of operation - Connection Mode, Message Mode, BER Mode and High Impedance Mode. In Connection Mode, the contents of the connection memory define, for each output stream and channel, the source stream and channel (the actual data to be output is stored in the data memory). In Message Mode, the connection memory is used for the storage of microprocessor data. Using Zarlink's Message Mode capability, microprocessor data can be broadcast to the data output streams on a per-channel basis. This feature is useful for transferring control and status information for external circuits or other TDM devices. In BER mode the output channel data is replaced with a pseudorandom bit sequence (PRBS) from one of 32 PRBS generators that generates a 2¹⁵-1 pattern. On the input side channels can be routed to one of 32 bit error detectors. In high impedance mode the selected output channel can be put into a high impedance state.

When the device is operating as a timing master, the internal digital PLL is in use. In this mode, an external 20.000 MHz crystal is required for the on-chip crystal oscillator. The DPLL is phase-locked to one of four input reference signals (which can be 8 kHz, 1.544, 2.048, 4.096, 8.192, 16.384 or 19.44 MHz provided on REF0 - 3). The on-chip DPLL operates in normal, holdover or freerun mode and offers jitter attenuation. The jitter attenuation function exceeds the Stratum 3 specification.

The configurable non-multiplexed microprocessor port allows users to program various device operating modes and switching configurations. Users can employ the microprocessor port to perform register read/write, connection memory read/write, and data memory read operations. The port is configurable to interface with either Motorola or Intel-type microprocessors.

The device also supports the mandatory requirements of the IEEE-1149.1 (JTAG) standard via the test port.

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Changes Summary

The following table captures the changes from the October 2004 issue.

Page	Item	Change
39, 76, 77	Section 12.1, "DPLL Timing Modes" on page 39 RCCR Register bits "FDM1 - 0" on page 76 RCSR Register bits "DPM1 - 0" on page 77	 The on-chip DPLL's normal, holdover, automatic, and freerun modes are now collectively referred to as DPLL timing modes instead of operation modes. This change is to avoid confusion with the two main device operating modes; the master and slave modes.
39, 40	Section 12.1.3.1, "Automatic Reference Switching Without Preferences" on page 39 and Section 12.1.3.2, "Automatic Reference Switching With Preference" on page 40	• Section 12.1.3.1 and Section 12.1.3.2 added to clarify the DPLL's automatic reference switching with and without preference operations in Automatic Timing Mode.
42, 45	Section 12.1.4, "Freerun Mode" on page 42, and Section 15.4, "Fast Locking Mode" on page 45	 Added description to specify that the device should not be in freerun and fast lock modes simultaneously. This is important in order to avoid incorrect output frame pulse generation.
72	Table 36, Lock Detector Threshold Register (LDTR) Bits	Clarified threshold calculations.
74	Table 39, "Bandwidth Control Register (BWCR) Bits" Note 3.	 Added a table footnote to specify that the DPLL's fastlock and freerun modes should not be set simultaneously.
75	Table 40, "Reference Change Control Register (RCCR) Bits" Bits "PRS1 - 0" and Bits "PMS2 - 0"	 Added description to clarify that only two consecutive references can be used in automatic timing mode with a preferred reference.
76	Table 40, "Reference Change Control Register (RCCR) Bits", Bits "FDM1 - 0"	 Added description to specify the device should not be in freerun and fast lock modes simultaneously.

1.0 Pinout Diagrams

1.1 BGA Pinout

١	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	
A	V _{SS}	STi29	STi28	STi27	STi25	STi26	STi24	NC	NC	STio22	STio23	STio21	STio20	NC	NC	V _{SS}	А
В	STi31	STi10	STi5	STi4	CKo2	STi0	CKo0	REF2	V _{DD} _ corea	FPi	CKi	IC_ OPEN	IC_ OPEN	OSCi	ODE	STio19	в
С	STi30	STi9	V _{SS}	STi7	STi6	STi1	CKo1	REF_ FAIL2	V _{SS}	IC_ OPEN	IC_ OPEN	OSC0	IC_GND	V _{SS}	STio15	STio18	с
D	STi17	STi11	V _{DD_IO}	STi3	STi2	CKo4	REF3	REF1	REF_ FAIL0	V _{SS}	FPo_ OFF1	OSC_ EN	STio13	V _{DD_IO}	STio14	STio16	D
E	STi16	STi14	STi8	V _{DD_IO}	V _{SS}	V _{DD} _ core	REF_ FAIL3	REF_ FAIL1	REF0	NC	V _{DD} _ core	V _{SS}	V _{DD_IO}	STio12	FPo2	STio17	Е
F	STi19	STi15	STi12	STi13	V _{DD_IO}	V _{DD} _ core	V _{DD} _ core	V _{SS}	V _{SS}	V _{DD} _ core	V _{DD} _ core	V _{DD_IO}	IC_ OPEN	FPo3	FPo_ OFF2	STOHZ15	F
G	STi18	RESET	IC_GND	IC_ OPEN	TDo	V _{DD_IO}	V _{SS}	V _{SS}	V _{SS}	V _{SS}	V _{DD_IO}	A12	A13	FPo1	FPo0	STOHZ14	G
н	STi21	V _{SS}	V _{SS}	V _{DD} _ COREA	CKo5	V _{SS}	V _{SS}	V _{SS}	V _{SS}	V _{SS}	A7	A9	A10	FPo_ OFF0	A11	STOHZ12	н
J	STi20	V _{DD_IOA}	V _{DD_IOA}	V _{SS}	V _{SS}	CKo3	V _{SS}	V _{SS}	V _{SS}	V _{SS}	A3	A4	A5	A8	A6	STOHZ13	J
к	STi22	V _{SS}	TMS	V _{SS}	V _{DD} _ corea	V _{DD_IO}	V _{SS}	V _{SS}	V _{SS}	V _{SS}	V _{DD_IO}	IC_ OPEN	A0	A2	A1	STOHZ11	к
L	STi23	V _{DD} _ corea	TRST	тск	V _{DD_IO}	V _{DD} _ core	V _{DD} _ core	V _{SS}	V _{SS}	V _{DD} _ core	V _{DD} _ core	V _{DD_IO}	STio10	STio11	STio9	STOHZ10	L
М	STio25	NC	TDi	D0	V _{SS}	V _{DD} _ core	V _{DD} _ core	D6	D10	V _{DD} _ core	V _{DD} _ core	V _{SS}	<u>MOT</u> _INTEL	MODE_ 4M0	STio8	STOHZ9	м
N	STio24	NC	V _{DD_IO}	STio0	STOHZ3	D1	D5	D7	D11	D13	R/W _WR	DTA_ RDY	STio4	V _{DD_IO}	STOHZ5	STOHZ8	N
Ρ	STio26	NC	V _{SS}	STio1	STio3	STOHZ1	D3	D8	D14	IRQ	STio5	STOHZ4	STOHZ6	V _{SS}	STOHZ7	NC	Р
R	STio27	NC	STOHZ0	STio2	STOHZ2	D2	D4	D9	D12	D15	CS	DS_RD	MODE_ 4M1	STio6	STio7	NC	R
Т	V _{SS}	STio28	STio29	STio31	STio30	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	V _{SS}	т
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	

Note: A1 corner identified by metallized marking.

Note: Pinout is shown as viewed through top of package.

Figure 2 - ZL50018 256-Ball 17 mm x 17 mm PBGA (as viewed through top of package)

1.2 QFP Pinout

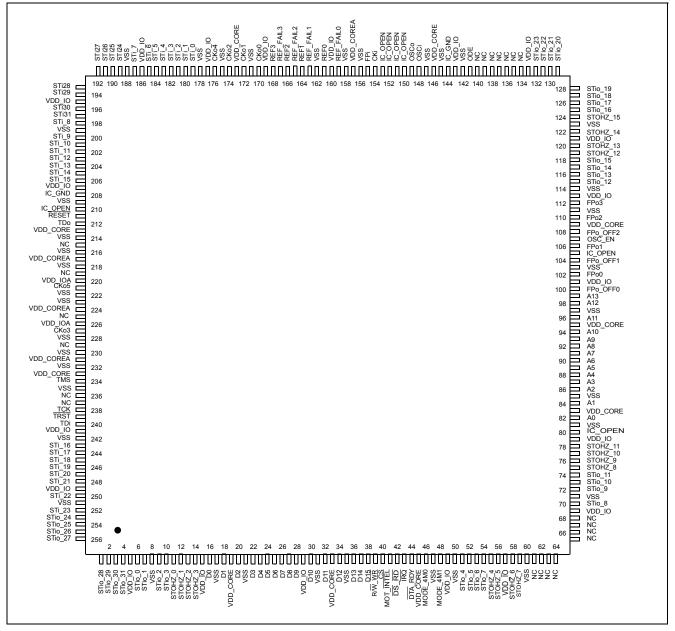


Figure 3 - ZL50018 256-Lead 28 mm x 28 mm LQFP (top view)

2.0 Pin Description

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
E6, E11, F6, F7, F10, F11, L6, L7, L10, L11, M6, M7, M10, M11	19, 33, 45, 83, 95, 109, 146, 173, 213, 233	V _{DD_CORE}	Power Supply for the core logic: +1.8 V
H4, K5, B9, L2	217, 231, 157, 224	V _{DD_COREA}	Power Supply for analog circuitry: +1.8V
D3, D14, E4, E13, F5, F12, G6, G11, K6, K11, L5, L12, N3, N14	5, 15, 29, 49, 57, 69, 79, 101, 113, 121, 133, 143, 160, 169, 177, 186, 195, 207, 241, 249	V _{DD_IO}	Power Supply for I/O: +3.3 V
J2, J3	220, 226	V _{DD_IOA}	Power Supply for the CKo5 and CKo3 outputs: +3.3 V
A1, A16, C3, C9, C14, D10, E5, E12, F8, F9, G7, G8, G9, G10, H2, H3, H6, H7, H8, H9, H10, J4, J5, J7, J8, J9, J10, K2, K4, K7, K8, K9, K10, L8, L9, M5, M12, P3, P14, T1, T16	8, 17, 21, 31, 35, 47, 50, 60, 71, 81, 85, 97, 103, 111, 114, 123, 142, 145, 147, 156, 158, 162, 171, 175, 178, 188, 199, 209, 214, 216, 218, 222, 223, 228, 230, 232, 235, 242, 251	V _{SS}	Ground

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
К3	234	TMS	Test Mode Select (5 V-Tolerant Input with Internal Pull-up) JTAG signal that controls the state transitions of the TAP controller. This pin is pulled high by an internal pull-up resistor when it is not driven.
L4	238	ТСК	Test Clock (5 V-Tolerant Schmitt-Triggered Input with Internal Pull-up) Provides the clock to the JTAG test logic.
L3	239	TRST	Test Reset (5 V-Tolerant Input with Internal Pull-up) Asynchronously initializes the JTAG TAP controller by putting it in the Test-Logic-Reset state. This pin should be pulsed low during power-up to ensure that the device is in the normal functional mode. When JTAG is not being used, this pin should be pulled low during normal operation.
M3	240	TDi	Test Serial Data In (5 V-Tolerant Input with Internal Pull-up) JTAG serial test instructions and data are shifted in on this pin. This pin is pulled high by an internal pull-up resistor when it is not driven.
G5	212	TDo	Test Serial Data Out (5 V-Tolerant Three-state Output) JTAG serial data is output on this pin on the falling edge of TCK. This pin is held in high impedance state when JTAG is not enabled.
B12, B13, C10, C11, F13, G4, K12	80, 105, 150, 151, 152, 153, 210	IC_OPEN	Internal Test Mode (5 V-Tolerant Input with Internal Pull-down) These pins may be left unconnected.
C13, G3	144, 208	IC_GND	Internal Test Mode Enable (5 V-Tolerant Input): These pins MUST be low.
A8, A9, A14, A15, E10, M2, N2, P2, P16, R2, R16, T6, T7, T8, T9, T10, T11, T12, T13, T14, T15	61, 62, 63, 64, 65, 66, 67, 68, 134, 135, 136, 137, 138, 139, 140, 215, 219, 225, 229, 236, 237	NC	No Connect These pins MUST be left unconnected.
M14, R13	46, 48	MODE_4M0, MODE_4M1	4 M Input Clock Mode 0 to 1 (5 V-Tolerant Input with internal pull-down) These two pins should be tied together and are typically used to select CKi = 4.096 MHz operation. See Table 7, "ZL50018 Operating Modes" on page 37 for a detailed explanation. See Table 18, "Control Register (CR) Bits" on page 55 for CKi and FPi selection using the CKIN1 - 0 bits.

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
D12	107	OSC_EN	Oscillator Enable (5 V-Tolerant Input with Internal Pull-down) If tied high, this pin indicates that there is a 20 MHz external oscillator interfacing with the device. If tied low, there is no oscillator and CKi will be used for master clock generation. If the DPLL is activated, an external oscillator is required and this pin MUST be tied high.
C12	149	OSCo	Oscillator Clock Output (3.3 V Output) If OSC_EN = '1', this pin should be connected to a 20 MHz crystal (See Figure 23 on page 104) or left unconnected if a clock oscillator is connected to OSCi pin under normal operation (See Figure 24 on page 105). If OSC_EN = 0, this pin MUST be left unconnected.
B14	148	OSCi	Oscillator Clock Input (3.3 V Input) If OSC_EN = '1', this pin should be connected to a 20 MHz crystal (See Figure 23 on page 104) or to a clock oscillator under normal operation (See Figure 24 on page 105). If OSC_EN = 0, this pin MUST be driven high or low by connecting either to V _{DD_IO} or to ground.
E9, D8, B8, D7	161, 164, 166, 168	REF0 - 3	DPLL Reference Inputs 0 to 3 (5 V-Tolerant Schmitt-Triggered Inputs) If the device is in Master mode, these input pins accept 8 kHz, 1.544 MHz, 2.048 MHz, 4.096 MHz, 8.192 MHz, 16.384 MHz or 19.44 MHz timing references independently. One of these inputs is defined as the preferred or forced input reference for the DPLL. The Reference Change Control Register (RCCR) selects the control of the preferred reference. These pins are ignored if the device is in slave mode unless SLV_DPLLEN (bit 13) in the Control Register (CR) is set. When these input pins are not in use, they MUST be driven high or low by connecting either to V_{DD_IO} or to ground.
D9, E8, C8, E7	159, 163, 165, 167	REF_FAIL0 - 3	Failure Indication for DPLL References 0 to 3 (5 V-Tolerant Three-state Outputs)These output pins are used to indicate input reference failure when the device is in master mode.If REF0 fails, REF_FAIL0 will be driven high.If REF1 fails, REF_FAIL1 will be driven high.If REF2 fails, REF_FAIL2 will be driven high.If REF3 fails, REF_FAIL3 will be driven high.If REF3 fails, REF_FAIL3 will be driven high.If the device is in slave mode, these pins are driven low, unlessSLV_DPLLEN (bit 13) in the Control Register (CR) is set.

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
G15, G14, E15, F14	102, 106, 110, 112	FPo0 - 3	ST-BUS/GCI-Bus Frame Pulse Outputs 0 to 3 (5 V-Tolerant Three-state Outputs) FPo0: 8 kHz frame pulse corresponding to the 4.096 MHz output clock of CKo0. FPo1: 8 kHz frame pulse corresponding to the 8.192 MHz output clock of CKo1. FPo2: 8kHz frame pulse corresponding to 16.384 MHz output clock of CKo2. FPo3: Programmable 8kHz frame pulse corresponding to 4.096, 8.192, 16.384, or 32.768 MHz output clock of CKo3. In Divided Slave modes, the frame pulse width of FPo0 - 3 cannot be narrower than the input frame pulse (FPi) width.
H14, D11	100, 104	FPo_OFF0 - 1	Generated Offset Frame Pulse Outputs 0 to 1 (5 V-Tolerant Three-state Outputs) Individually programmable 8 kHz frame pulses, offset from the output frame boundary by a programmable number of channels.
F15	108	FPo_OFF2 or FPo5	Generated Offset Frame Pulse Output 2 or 19.44 MHz Frame Pulse Output (5 V-Tolerant Three-state Output) As FPo_OFF2, this is an individually programmable 8 kHz width frame pulse, offset from the output frame boundary by a programmable number of channels. By programming the FP19EN (bit 10) of FPOFF2 register to high, this signal becomes FPo5, a non-offset frame pulse corresponding to the 19.44 MHz clock presented on CKo5. FPo5 is only available in Master mode or when the SLV_DPLLEN bit in the Control Register is set high while the device is in one of the slave modes.
B7, C7, B5, J6, D6, H5	170, 172, 174, 227, 176, 221	CKo0 - 5	ST-BUS/GCI-Bus Clock Outputs 0 to 5 (5 V-Tolerant Three-state Outputs) CKo0: 4.096 MHz output clock. CKo1: 8.192 MHz output clock. CKo2: 16.384 MHz output clock. CKo3: 4.096, 8.192, 16.384 or 32.768 MHz programmable output clock; CKo4: 1.544 or 2.048 MHz programmable output clock. CKo5: 19.44 MHz output clock. See Section 6.0 on page 24 for details. In Divided Slave mode, the frequency of CKo0 - 3 cannot be higher than input clock (CKi). CKo4 and CKo5 are only available in Master mode or when the SLV_DPLLEN bit in the Control Register is set high while the device is in one of the slave modes.

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
B10	155	FPi	ST-BUS/GCI-BusFramePulseInput(5 V-TolerantSchmitt-Triggered Input)This pin accepts the frame pulse which stays active for 61 ns,122 ns or 244 ns at the frame boundary. The frame pulsefrequency is 8 kHz.The frame pulse associated with the highest input or output datarate must be applied to this pin when the device is operating inDivided Slave mode or Master mode. The exception is if the deviceis operating in Master mode with loopback (i.e., CKi_LP is set inthe Control Register). In that case, this input must be tied high orlow externally.When the device is operating in Multiplied Slave mode, the framepulse associated with the highest input data rate must be appliedto this pin.For all modes (except Master mode with loopback), if the data rateis 16.384 Mbps, a 61 ns wide frame pulse must be used.By default, the device accepts a negative frame pulse in ST-BUSformat, but it can accept a positive frame pulse instead if theFPINP bit is set high in the Control Register (CR). It can accept aGCI-formatted frame pulse by programming the FPINPOS bit inthe Control Register (CR) to high.
B11	154	СКі	ST-BUS/GCI-Bus Clock Input (5 V-Tolerant Schmitt Triggered Input) This pin accepts a 4.096, 8.192 or 16.384 MHz clock. The clock frequency associated with twice the highest input or output data rate must be applied to this pin when the device is operating in either Divided Slave mode or Master mode. The exception is if the device is operating in Master mode with loopback (i.e., CKi_LP is set in the Control Register). In that case, this input must be tied high or low externally. The clock frequency associated with twice the highest input data rate must be applied to this pin when the device is operating in Multiplied Slave mode. In all modes of operation (except Master mode with loopback), when data is running at 16.384 Mbps, a 16.384 MHz clock must be used. By default, the clock falling edge defines the input frame boundary, but the device allows the clock rising edge to define the frame boundary by programming the CKINP bit in the Control Register (CR).

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
B6, C6, D5,	179, 180,	STi0 -31	Serial Input Streams 0 to 31 (5 V-Tolerant Inputs with Enabled
D4, B4, B3,	181, 182,		Internal Pull-downs)
C5, C4, E3,	183, 184,		The data rate of each input stream can be selected independently
C2, B2, D2,	185, 187,		using the Stream Input Control Registers (SICR[n]). In the 2.048 Mbps mode, these pins accept serial TDM data streams at 2.048
F3, F4, E2,	198, 200,		Mbps with 32 channels per frame. In the 4.096 Mbps mode, these
F2, E1, D1,	201, 202,		pins accept serial TDM data streams at 4.096 Mbps with 64
G1, F1, J1,	203, 204,		channels per frame. In the 8.192 Mbps mode, these pins accept
H1, K1, L1,	205, 206,		serial TDM data streams at 8.192 Mbps with 128 channels per
A7, A5, A6,	243, 244,		frame. In the 16.384 Mbps mode, these pins accept TDM data streams at 16.384 Mbps with 256 channels per frame.
A4, A3, A2,	245, 246,		streams at 10.304 mbps with 230 chamles per frame.
C1, B1	247, 248,		
	250, 252,		
	189, 190,		
	191, 192,		
	193, 194,		
	196, 197		
N4, P4, R4,	6, 7, 9,	STio0 - 31	Serial Output Streams 0 to 31 (5 V-Tolerant Slew-Rate-Limited
P5, N13,	10, 51,		Three-state I/Os with Enabled Internal Pull-downs)
P11, R14,	52, 53,		The data rate of each output stream can be selected
R15, M15,	54, 70,		independently using the Stream Output Control Registers (SOCR[n]). In the 2.048 Mbps mode, these pins output serial TDM
L15, L13,	72, 73,		data streams at 2.048 Mbps with 32 channels per frame. In the
L14, E14,	74, 115,		4.096 Mbps mode, these pins output serial TDM data streams at
D13, D15,	116, 117,		4.096 Mbps with 64 channels per frame. In the 8.192 Mbps mode,
C15, D16,	118, 125,		these pins output serial TDM data streams at 8.192 Mbps with 128 channels per frame. In the 16.384 Mbps mode, these pins output
E16, C16,	126, 127,		serial TDM data streams at 16.384 Mbps with 256 channels per
B16, A13,	128, 129,		frame.
A12, A10,	130, 131,		These output streams can be used as bi-directionals by
A11, N1,	132, 253,		programming BDH (bit 7) and BDL (bit 6) of Internal Mode
M1, P1, R1,	254, 255,		Selection (IMS) register.
T2, T3, T5,	256, 1, 2,		
T4	3, 4		
R3, P6, R5,	11, 12,	STOHZ0 - 15	Serial Output Streams High Impedance Control 0 to 15
N5, P12,	13, 14,		(5 V-Tolerant Slew-Rate-Limited Three-state Outputs)
N15, P13,	55, 56,		These pins are used to enable (or disable) external three-state buffers. When an output channel is in the high impedance state,
P15, N16,	58, 59,		the STOHZ drives high for the duration of the corresponding output
M16, L16,	75, 76,		channel. When the STio channel is active, the STOHZ drives low
K16, H16,	77, 78,		for the duration of the corresponding output channel. STOHZ
J16, G16,	119, 120,		outputs are available for STio0 - 15 only.
F16	122, 124		

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
B15	141	ODE	Output Drive Enable (5 V-Tolerant Input with Internal Pull-up) This is the output enable control for STio0 - 31 and the output-driven-high control for STOHZ0 - 15. When it is high, STio0 - 31 and STOHZ0 - 15 are enabled. When it is low, STio0 - 31 are tristated and STOHZ0 - 15 are driven high.
M4, N6, R6, P7, R7, N7, M8, N8, P8, R8, M9, N9, R9, N10, P9, R10	16, 18, 20, 22, 23, 24, 25, 26, 27, 28, 30, 32, 34, 36, 37, 38	D0 - 15	Data Bus 0 to 15 (5 V-Tolerant Slew-Rate-Limited Three-state I/Os) These pins form the 16-bit data bus of the microprocessor port.
N12	44	DTA_RDY	Data Transfer Acknowledgment_Ready (5 V-Tolerant Three-state Output)This active low output indicates that a data bus transfer is complete for the Motorola interface. For the Intel interface, it indicates a transfer is completed when this pin goes from low to high.An external pull-up resistor MUST hold this pin at HIGH level for the Motorola mode. An external pull-down resistor MUST hold this pin at LOW level for the Intel mode.
R11	40	CS	Chip Select (5V-Tolerant Input) Active low input used by the Motorola or Intel microprocessor to enable the microprocessor port access.
N11	39	R/W_WR	Read/Write_Write (5 V-Tolerant Input) This input controls the direction of the data bus lines (D0 - 15) during a microprocessor access. For the Motorola interface, this pin is set high and low for the read and write access respectively. For the Intel interface, a write access is indicated when this pin goes low.
R12	42	DS_RD	Data Strobe_Read (5 V-Tolerant Input) This active low input works in conjunction with CS to enable the microprocessor port read and write operations for the Motorola interface. A read access is indicated when it goes low for the Intel interface.
K13, K15, K14, J11, J12, J13, J15, H11, J14, H12, H13, H15, G12, G13	82, 84, 86, 87, 88, 89, 90, 91, 92, 93, 94, 96, 98, 99	A0 - 13	Address 0 to 13 (5 V-Tolerant Inputs) These pins form the 14-bit address bus to the internal memories and registers.

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
M13	41	MOT_INTEL	Motorola_Intel (5 V-Tolerant Input with Internal Pull-up) This pin selects the Motorola or Intel microprocessor interface to be connected to the device. When this pin is unconnected or connected to high, Motorola interface is assumed. When this pin is connected to ground, Intel interface should be used.
P10	43	ĪRQ	Interrupt (5 V-Tolerant Three-state Output) This programmable active low output indicates that the internal operating status of the DPLL has changed. An external pull-up resistor MUST hold this pin at HIGH level.
G2	211	RESET	Device Reset (5 V-Tolerant Input with Internal Pull-up) This input (active LOW) puts the device in its reset state that disables the STio0 - 31 drivers and drives the STOHZ0 - 15 outputs to high. It also preloads registers with default values and clears all internal counters. To ensure proper reset action, the reset pin must be low for longer than 1 μ s. Upon releasing the reset signal to the device, the first microprocessor access cannot take place for at least 600 μ s due to the time required to stabilize the device and the crystal oscillator from the power-down state. Refer to Section Section 17.2 on page 48 for details.

3.0 Device Overview

The device has thirty-two ST-BUS/GCI-Bus inputs (STi0 - 31) and thirty-two ST-BUS/GCI-Bus outputs (STio0 - 31). STio0 - 31 can also be configured as bi-directional pins, in which case STi0 - 31 will be ignored. It is a non-blocking digital switch with 2048 64 kbps channels and is capable of performing rate conversion between ST-BUS/GCI-Bus inputs and ST-BUS/GCI-Bus outputs. The ST-BUS/GCI-Bus inputs accept serial input data streams with data rates of 2.048, 4.096, 8.192 and 16.384 Mbps on a per-stream basis. The ST-BUS/GCI-Bus outputs deliver serial data streams with data rates of 2.048, 4.096, 8.192 and 16.384 Mbps on a per-stream basis. The device also provides sixteen high impedance control outputs (STOHZ0 - 15) to support the use of external ST-BUS/GCI-Bus tristate drivers for the first sixteen ST-BUS/GCI-Bus outputs (STio0 -15).

By using Zarlink's message mode capability, microprocessor data stored in the connection memory can be broadcast to the output streams on a per-channel basis. This feature is useful for transferring control and status information for external circuits or other ST-BUS/GCI-Bus devices.

The device uses the ST-BUS/GCI-Bus input frame pulse (FPi) and the ST-BUS/GCI-Bus input clock (CKi) to define the input frame boundary and timing for sampling the ST-BUS/GCI-Bus input streams with various data rates. The output data streams will be driven by and have their timing defined by FPi and CKi in Divided Slave mode. In Multiplied Slave mode, the output data streams will be driven by an internally generated clock, which is multiplied from CKi internally. In Master mode, the on-chip DPLL will drive the output data streams and provide output clocks and frame pulses. Refer to Application Note ZLAN-120 for further explanation of the different modes of operation.

When the device is in Master mode, the DPLL is phase-locked to one of four DPLL reference signals, REF0 - 3, which are sourced by an external 8 kHz, 1.544 MHz, 2.048 MHz, 4.096 MHz, 8.192 MHz, 16.384 MHz or 19.44 MHz reference signal. The on-chip DPLL also offers jitter attenuation, reference switching, reference monitoring, freerun and holdover functions. The jitter performance exceeds the Stratum 3 specification. The intrinsic jitter of all output clocks is less than 1 ns (except for the 1.544 MHz output).

There are two slave modes for this device:

The first is the Divided Slave mode. In this mode, output streams are clocked by input CKi. Therefore the output streams have exactly the same jitter as the input streams. The output data rate can be the same as or lower than

the input data rate, but the output data rate cannot be higher than what CKi can drive. For example, if CKi is 4.096 MHz, the output data rate cannot be higher than 2.048 Mbps. The second slave mode is called Multiplied Slave mode. In this mode, CKi is used to generate a 16.384 MHz clock internally, and output streams are driven by this 16.384 MHz clock. In Multiplied Slave mode, the data rate of output streams can be any rate, but output jitter may not be exactly the same as input jitter.

A Motorola or Intel compatible non-multiplexed microprocessor port allows users to program the device to operate in various modes under different switching configurations. Users can use the microprocessor port to perform internal register and memory read and write operations. The microprocessor port has a 16-bit data bus, a 14-bit address bus and six control signals (MOT_INTEL, CS, DS_RD, R/W_WR, IRQ and DTA_RDY).

The device supports the mandatory requirements of the IEEE-1149.1 (JTAG) standard via the test port.

4.0 Data Rates and Timing

The ZL50018 has 32 serial data inputs and 32 serial data outputs. Each stream can be individually programmed to operate at 2.048, 4.096, 8.192 or 16.384 Mbps. Depending on the data rate there will be 32 channels, 64 channels, 128 channels or 256 channels, respectively, during a 125 μ s frame.

The output streams can be programmed to operate as bi-directional streams. The output streams are divided into two groups to be programmed into bi-directional mode. By setting BDL (bit 6) in the Internal Mode Selection (IMS) register, input streams 0 - 15 (STi0 - 15) are internally tied low, and output streams 0 - 15 (STi0 - 15) are set to operate in a bi-directional mode. Similarly, when BDH (bit 7) in the Internal Mode Selection (IMS) register is set, input streams 16 - 31 (STi16 - 31) are internally tied low, and output streams 16 - 31 (STi016 - 31) are set to operate in bi-directional mode. The groups do not have to be set into the same mode. Therefore it is possible to have half of the streams operating in bi-directional mode while the other half is operating in normal input/output mode.

The input data rate is set on a per-stream basis by programming STIN[n]DR3 - 0 (bits 3 - 0) in the Stream Input Control Register 0 - 31 (SICR0 - 31). The output data rate is set on a per-stream basis by programming STO[n]DR3 - 0 (bits 3 - 0) in the Stream Output Control Register 0 - 31 (SOCR0 - 31). The output data rates do not have to match or follow the input data rates. The maximum number of channels switched is limited to 2048 channels. If all 32 input streams were operating at 16.384 Mbps (256 channels per stream), this would result in 8192 channels. Memory limitations prevent the device from operating at this capacity. A maximum capacity of 2048 channels will occur if eight of the streams are operating at 16.384 Mbps, half the streams are operating at 8.192 Mbps or all streams operating at 4.096 Mbps. With all streams operating at 2.048 Mbps, the capacity will be reduced to 1024 channels. However, as each stream can be programmed to a different data rate, any combination of data rates can be achieved, as long as the total channel count does not exceed 2048 channels. It should be noted that only full stream can be programmed for use. The device does not allow fractional streams.

4.1 External High Impedance Control, STOHZ0 - 15

There are 16 external high impedance control signals, STOHZ0 - 15, that are used to control the external drivers for per-channel high impedance operations. Only the first sixteen ST-BUS/GCI-Bus (STio0 - 15) outputs are provided with corresponding STOHZ signals. The STOHZ outputs deliver the appropriate number of control timeslot channels based on the output stream data rate. Each control timeslot lasts for one channel time. When the ODE pin is high and the OSB (bit 2) of the Control Register (CR) is also high, STOHZ0 - 15 are enabled. When the ODE pin, OSB (bit 2) of the Control Register (CR) or the RESET pin is low, STOHZ0 - 15 are driven high, together with all the ST-BUS/GCI-Bus outputs being tristated. Under normal operation, the corresponding STOHZ outputs of any unused ST-BUS/GCI-Bus channel (high impedance) are driven high. Refer to Figure 18 on page 33.

4.2 Input Clock (CKi) and Input Frame Pulse (FPi) Timing

The input clock for the ZL50018 can be arranged in one of three different ways. These different ways will be explained further in Section 11.1 to Section 11.3 on page 38. Depending on the mode of operation, the input clock, CKi, will be based on the highest data rate of either the input or both the input and output data rates. The user has to program the CKIN1 - 0 (bits 6 - 5) in the Control Register (CR) to indicate the width of the input frame pulse and the frequency of the input clock supplied to the device.

In Master mode and Divided Slave mode, the input clock, CKi, must be at least twice the highest input or output data rate. For example, if the highest input data rate is 4.096 Mbps and the highest output data rate is 8.192 Mbps, the input clock, CKi, must be 16.384 MHz, which is twice the highest overall data rate. The only exception to this is for 16.384 Mbps input or output data. In this case, the input clock, CKi, is equal to the data rate. The input frame pulse, FPi, must always follow CKi.

In Master mode, CKo2 and FPo2 can be programmed to be used as CKi and FPi by setting CKi_LP (bit 10) in the Control Register (CR). This will internally loop back the CKo2 and FPo2 timing. When this bit is set, CKi and FPi must be tied low or high externally.

Highest <u>Input or Output</u> Data Rate	CKIN 1-0 Bits	Input Clock Rate (CKi)	Input Frame Pulse (FPi)
16.384 Mbps or 8.192 Mbps	00	16.384 MHz	8 kHz (61 ns wide pulse)
4.096 Mbps	01	8.192 MHz	8 kHz (122 ns wide pulse)
2.048 Mbps	10	4.096 MHz	8 kHz (244 ns wide pulse)

Table 1 - CKi and FPi Configurations for Master and Divided Slave Modes

In Multiplied Slave mode, the input clock, CKi, must be at least twice the highest input data rate, regardless of the output data rate. Following the example above, if the highest input data rate is 4.096 Mbps, the input clock, CKi, must be 8.192 MHz, regardless of the output data rate. The only exception to this is for 16.384 Mbps input data. In this case, the input clock, CKi, is equal to the data rate. The input frame pulse, FPi, must always follow CKi.

Highest <u>Input</u> Data Rate	CKIN 1-0 Bits	Input Clock Rate (CKi)	Input Frame Pulse (FPi)
16.384 Mbps or 8.192 Mbps	00	16.384 MHz	8 kHz (61 ns wide pulse)
4.096 Mbps	01	8.192 MHz	8 kHz (122 ns wide pulse)
2.048 Mbps	10	4.096 MHz	8 kHz (244 ns wide pulse)

Table 2 - CKi and FPi Configurations for Multiplied Slave Mode

The ZL50018 accepts positive and negative ST-BUS/GCI-Bus input clock and input frame pulse formats via the programming of CKINP (bit 8) and FPINP (bit 7) in the Control Register (CR). By default, the device accepts the negative input clock format and ST-BUS format frame pulses. However, the switch can also accept a positive-going clock format by programming CKINP (bit 8) in the Control Register (CR). A GCI-Bus format frame pulse can be used by programming FPINPOS (bit 9) and FPINP (bit 7) in the Control Register (CR).

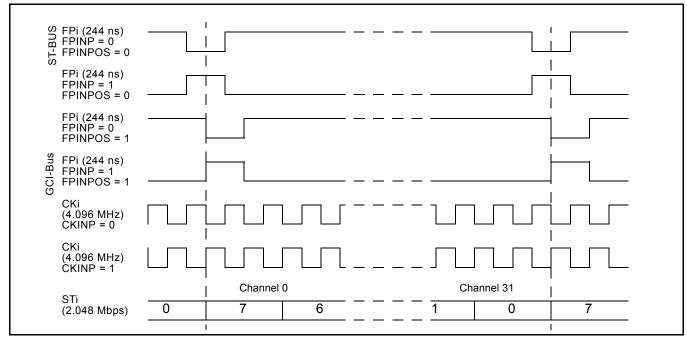


Figure 4 - Input Timing when CKIN1 - 0 bits = "10" in the CR

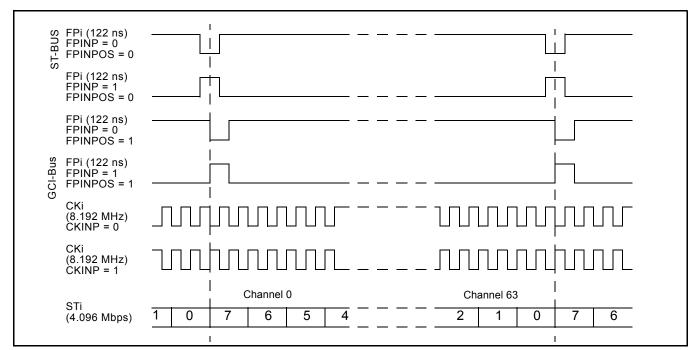


Figure 5 - Input Timing when CKIN1 - 0 bits = "01" in the CR

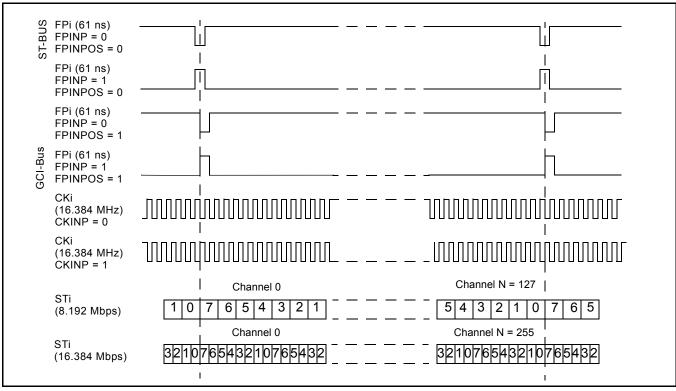


Figure 6 - Input Timing when CKIN1 - 0 = "00" in the CR

5.0 ST-BUS and GCI-Bus Timing

The ZL50018 is capable of operating using either the ST-BUS or GCI-Bus standards. The output timing that the device generates is defined by the bus standard. In the ST-BUS standard, the output frame boundary is defined by the falling edge of CKo while FPo is low. In the GCI-Bus standard, the frame boundary is defined by the rising edge of CKo while FPo goes high. The data rates define the number of channels that are available in a 125 μ s frame pulse period.

By default, the ZL50018 is configured for ST-BUS input and output timing. To set the input timing to conform to the GCI-Bus standard, FPINPOS (bit 9) and FPINP (bit 7) in the Control Register (CR) must be set. To set output timing to conform to the GCI-Bus standard, FPO[n]P and FPO[n]POS must be set in the Output Clock and Frame Pulse Selection Register (OCFSR). The CKO[n]P bits in the Output Clock and Frame Pulse Selection Register control the polarity (positive-going or negative-going) of the output clocks.

6.0 Output Timing Generation

The ZL50018 generates frame pulse and clock timing. There are five output frame pulse pins (FPo0 - 3, 5) and six output clock pins (CKo0 - 5). All output frame pulses are 8 kHz output signals. By default, the output frame boundary is defined by the falling edge of the CKo0, while FPo0 is low. At the output frame boundary, the CKo1, CKo2 and CKo3 output clocks will by default have a falling edge, while FPo1, FPo2 and FPo3 will be low. At the output frame boundary, CKo4 will by default have a falling edge while FPo0 is low (CKo4 has no corresponding output frame pulse). At the output frame boundary, CKo5 will by default have a rising edge while FPo5 (FPo_OFF2) will be low. The duration of the frame pulse low cycle and the frequency of the corresponding output clock are shown in Table 3 on page 25. Every frame pulse and clock output can be tristated by programming the enable bits in the Internal Mode Selection (IMS) register.

Pin Name	Output Timing Rate	Output Timing Unit
FPo0 pulse width	244	ns
CKo0	4.096	MHz
FPo1 pulse width	122	ns
CKo1	8.192	MHz
FPo2 pulse width	61	ns
CKo2	16.384	MHz
FPo3 pulse width	244, 122, 61 or 30	ns
CKo3	4.096, 8.192, 16.384 or 32.768	MHz
CKo4	1.544 or 2.048	MHz
FPo5 pulse width	51	ns
CKo5	19.44	MHz

 Table 3 - Output Timing Generation

The output timing is dependent on the operation mode that is selected. When the device is in Divided Slave mode, the frequencies on CKo0 - 3 cannot be greater than the input clock, CKi. For example, if the input clock is 8.192 MHz, the CKo2 pin will not produce a valid output clock and the CKo3 pin can only be programmed to output a 4.096 MHz or 8.192 MHz clock signal. The output clocks CKo4 - 5 will not generate valid outputs unless the SLV_DPLLEN (bit 13) of the Control Register (CR) is set.

In Master mode there are programmable output frame pulse, FPo3, and clock pins, CKo3 and CKo4. The outputs from FPo3 and CKo3 are programmed by the CKOFPO3SEL1 - 0 (bits 13 - 12) in the Output Clock and Frame Pulse Selection (OCFSR) register. The output clock pin, CKo4, is controlled by setting the CKO4SEL (bit 14) in the OCFSR register.

In Multiplied Slave mode, CKo4 and CKo5 are not available unless SLV_DPLLEN is set in the Control Register. All other clocks and frame pulses correspond to the timing shown in Table 3 above.

The device also delivers positive or negative output frame pulse and ST-BUS/GCI-Bus output clock formats via the programming of various bits in the Output Clock and Frame Pulse Selection Register (OCFSR). By default, the device delivers the negative output clock format. The ZL50018 can also deliver GCI-Bus format output frame pulses by programming bits of the Output Clock and Frame Pulse Selection Register (OCFSR). As there is a separate bit setting for each frame pulse output, some of the outputs can be set to operate in ST-BUS mode and others in GCI-Bus mode.

The following figures describe the usage of the FPO0P, FPO1P, FPO2P, FPO3P, CKO0P, CKO1P, CKO2P, CKO3P, CKO4P and CKO5P bits to generate the FPo0 - 3 and CKo0 - 5 timing. FPo_OFF2 is configured to provide the non-offset frame pulse corresponding to the 19.44 MHz clock on CKo5 by setting the FP19EN (bit 10) in the FPOFF2 register. In this instance, FPo_OFF2 can be labeled as FPo5.

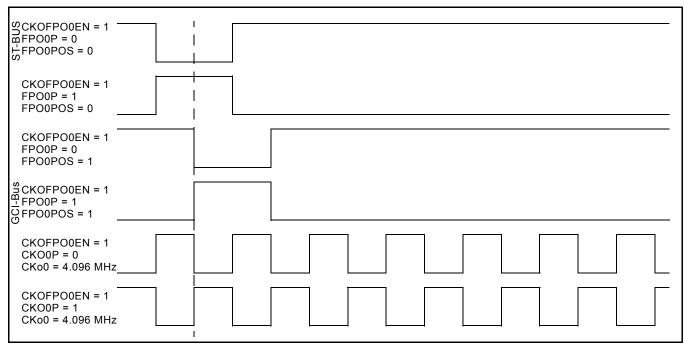


Figure 7 - Output Timing for CKo0 and FPo0

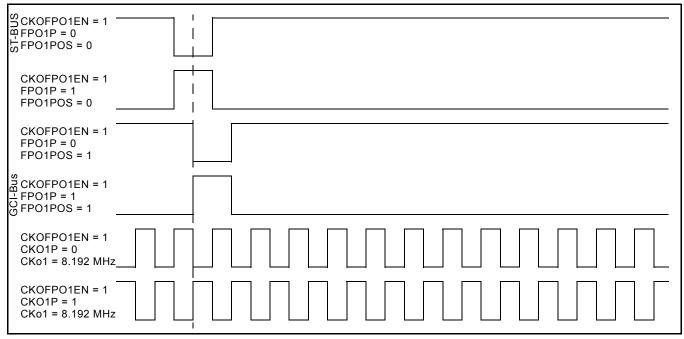


Figure 8 - Output Timing for CKo1 and FPo1

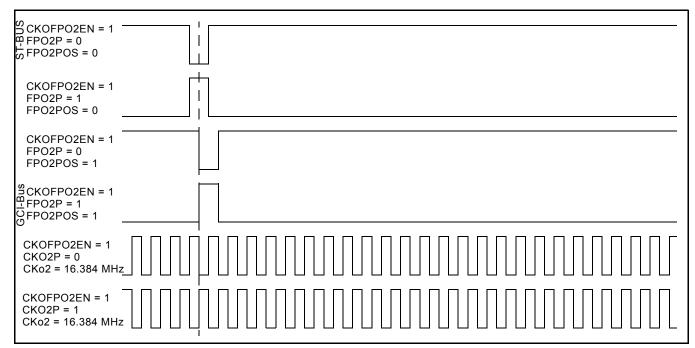


Figure 9 - Output Timing for CKo2 and FPo2

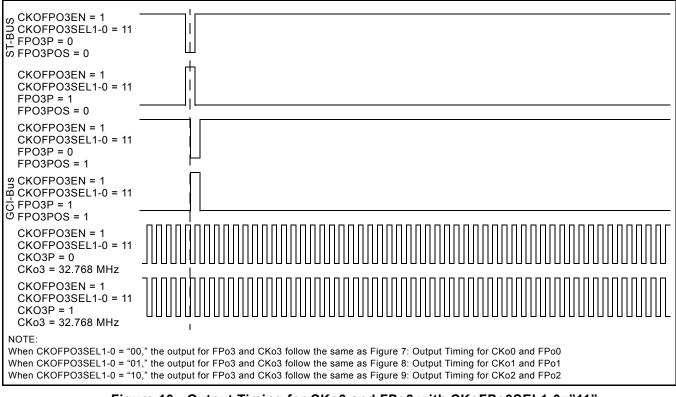


Figure 10 - Output Timing for CKo3 and FPo3 with CKoFPo3SEL1-0="11"

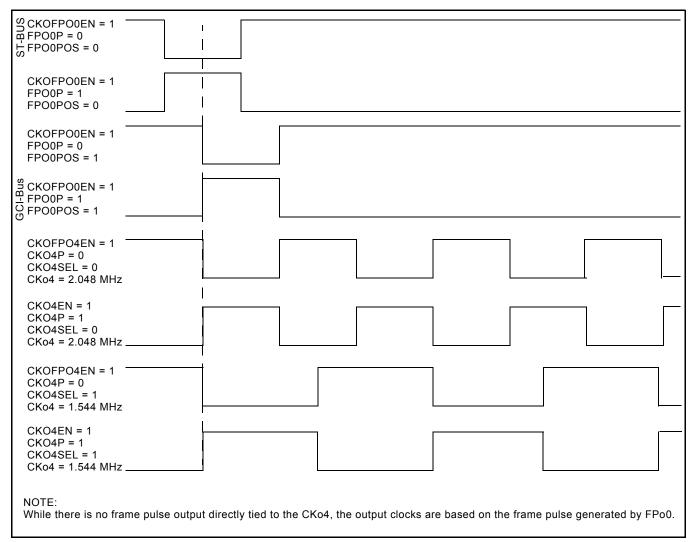


Figure 11 - Output Timing for CKo4

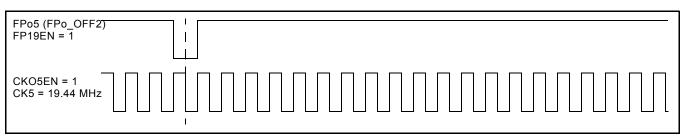


Figure 12 - Output Timing for CKo5 and FPo5 (FPo_OFF2)

7.0 Data Input Delay and Data Output Advancement

Various registers are provided to adjust the input delay and output advancement for each input and output data stream. The input bit delay and output bit advancement can vary from 0 to 7 bits for each individual stream.

If input delay of less than a bit is desired, different sampling points can be used to handle the adjustments. The sampling point can vary from 1/4 to 4/4 with a 1/4-bit increment for all input streams unless the stream is operating at 16.384 Mbps, in which case the fractional bit delay has a 1/2-bit increment. By default, the sampling point is set to the 3/4-bit location for non-16.384 Mbps data rates and the 1/2-bit location for the 16.384 Mbps data rate.

The fractional output bit advancement can vary from 0 to 3/4 bits, again with a 1/4-bit increment unless the output stream is operating at 16.384 Mbps, in which case the output fractional bit advancement has a 1/2-bit increment from 0 to 1/2 bit. By default, there is 0 output bit advancement.

Although input delay or output advancement features are available on streams which are operating in bi-directional mode it is not recommended, as it can easily cause bus contention. If users require this function, special attention must be given to the timing to ensure contention is minimized.

7.1 Input Bit Delay Programming

The input bit delay programming feature provides users with the flexibility of handling different wire delays when designing with source streams for different devices.

By default, all input streams have zero bit delay, such that bit 7 is the first bit that appears after the input frame boundary (assuming ST-BUS formatting). The input delay is enabled by STIN[n]BD2-0 (bits 8 - 6) in the Stream Input Control Register 0 - 31 (SICR0 - 31) as described in Table 61 on page 93. The input bit delay can range from 0 to 7 bits.

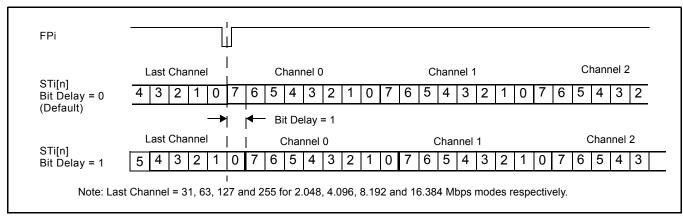


Figure 13 - Input Bit Delay Timing Diagram (ST-BUS)

7.2 Input Bit Sampling Point Programming

In addition to the input bit delay feature, the ZL50018 allows users to change the sampling point of the input bit by programming STIN[n]SMP 1-0 (bits 5 - 4) in the Stream Input Control Register 0 - 31 (SICR0 - 31). For input streams operating at any rate except 16.384 Mbps, the default sampling point is at 3/4 bit and users can change the sampling point to 1/4, 1/2, 3/4 or 4/4 bit position. When the stream is operating at 16.384 Mbps, the default sampling point is 1/2 bit and can be adjusted to a 4/4 bit position.

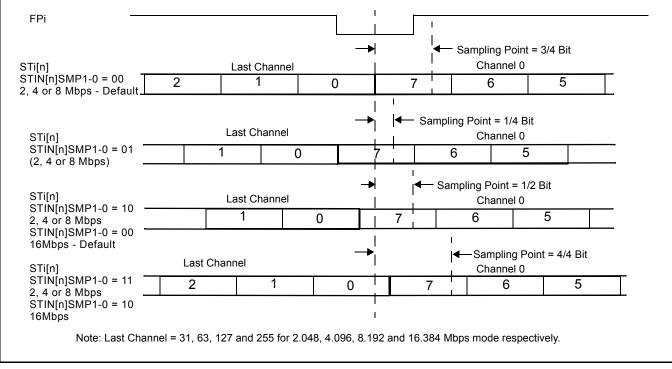
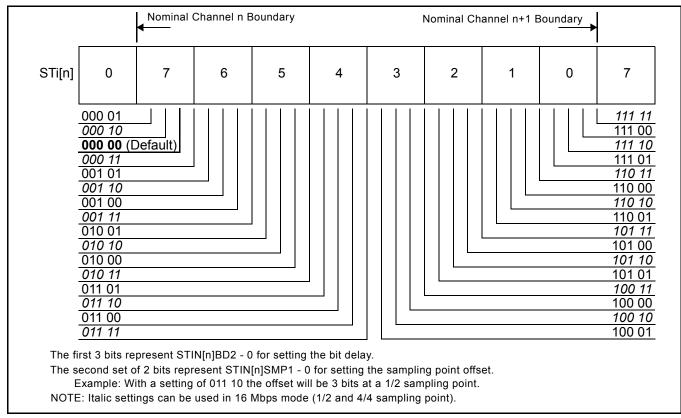
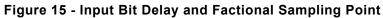


Figure 14 - Input Bit Sampling Point Programming

The input delay is controlled by STIN[n]BD2-0 (bits 8 - 6) to control the bit shift and STIN[n]SMP1 - 0 (bits 5 - 4) to control the sampling point in the Stream Input Control Register 0 - 31 (SICR0 - 31).

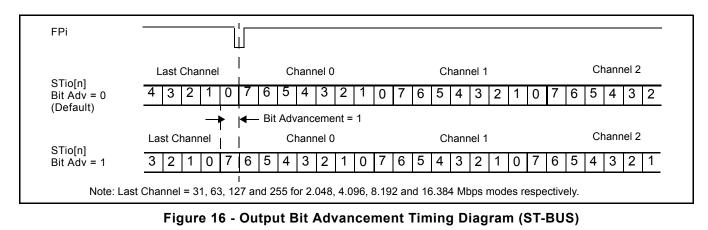




7.3 Output Advancement Programming

This feature is used to advance the output data of individual output streams with respect to the output frame boundary. Each output stream has its own bit advancement value which can be programmed in the Stream Output Control Register 0 - 31 (SOCR0 - 31).

By default, all output streams have zero bit advancement such that bit 7 is the first bit that appears after the output frame boundary (assuming ST-BUS formatting). The output advancement is enabled by STO[n]AD 2 - 0 (bits 6 - 4) of the Stream Output Control Register 0 - 31 (SOCR0 - 31) as described in Table 63 on page 97. The output bit advancement can vary from 0 to 7 bits.



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7.4 Fractional Output Bit Advancement Programming

In addition to the output bit advancement, the device has a fractional output bit advancement feature that offers better resolution. The fractional output bit advancement is useful in compensating for varying parasitic load on the serial data output pins.

By default all of the streams have zero fractional bit advancement such that bit 7 is the first bit that appears after the output frame boundary. The fractional output bit advancement is enabled by $STO[n]FA \ 1 - 0$ (bits 8 - 7) in the Stream Output Control Register 0 - 31 (SOCR0 - 31). For all streams running at any data rate except 16.384 Mbps the fractional bit advancement can vary from 0, 1/4, 1/2 to 3/4 bits. For streams operating at 16.384 Mbps, the fractional bit advancement can be set to either 0 or 1/2 bit.

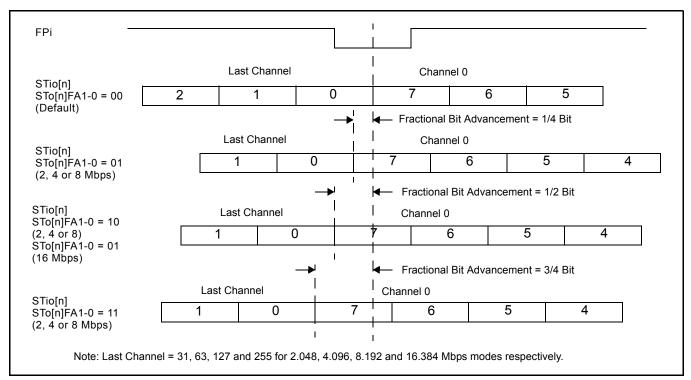


Figure 17 - Output Fractional Bit Advancement Timing Diagram (ST-BUS)

7.5 External High Impedance Control Advancement

The external high impedance signals can be programmed to better match the timing required by the external buffers. By default, the output timing of the STOHZ signals follows the programmed channel delay and bit offset of their corresponding ST-BUS/GCI-Bus output streams. In addition, for all high impedance streams operating at any data rate except 16.384 Mbps, the user can advance the STOHZ signals a further 0, 1/4, 1/2, 3/4 or 4/4 bits by programming STOHZ[n]A 2 - 0 (bit 11 - 9) in the Stream Output Control Register. When the stream is operating at 16.384 Mbps, the additional STOHZ advancement can be set to 0, 1/2 or 4/4 bits by programming the same register.

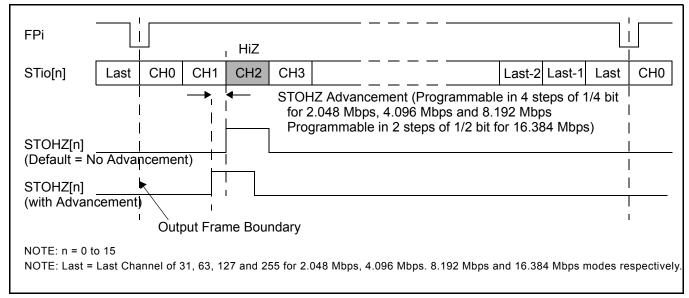


Figure 18 - Channel Switching External High Impedance Control Timing

8.0 Data Delay Through the Switching Paths

The switching of information from the input serial streams to the output serial streams results in a throughput delay. The device can be programmed to perform timeslot interchange functions with different throughput delay capabilities on a per-channel basis. For voice applications, select variable throughput delay to ensure minimum delay between input and output data. In wideband data applications, select constant delay to maintain the frame integrity of the information through the switch. The delay through the device varies according to the type of throughput delay selected by the V/ \overline{C} (bit 14) in the Connection Memory Low when CMM = 0.

8.1 Variable Delay Mode

Variable delay mode causes the output channel to be transmitted as soon as possible. This is a useful mode for voice applications where the minimum throughput delay is more important than frame integrity. The delay through the switch can vary from 7 channels to 1 frame + 7 channels. To set the device into variable delay mode, VAREN (bit 4) in the Control Register (CR) must be set before V/C (bit 14) in the Connection Memory Low when CMM = 0. If the VAREN bit is not set and the device is programmed for variable delay mode, the information read on the output stream will not be valid.

In variable delay mode, the delay depends on the combination of the source and destination channels of the input and output streams.

ZL50018

For example, if Stream 4 Channel 2 is switched to Stream 5 Channel 9 with variable delay, the data will be output in the same 125 μ s frame. Contrarily, if Stream 6 Channel 1 is switched to Stream 9 Channel 3, the information will appear in the following frame.

m = input channel number	n-m <= 0	0 < n-m < 7	r	n-m > 7	
n = output channel number			STio < STi	STio >= STi	
T = Delay between input and output	1 frame - (m-n)	1 frame	+ (n-m)	n-m	

 Table 4 - Delay for Variable Delay Mode

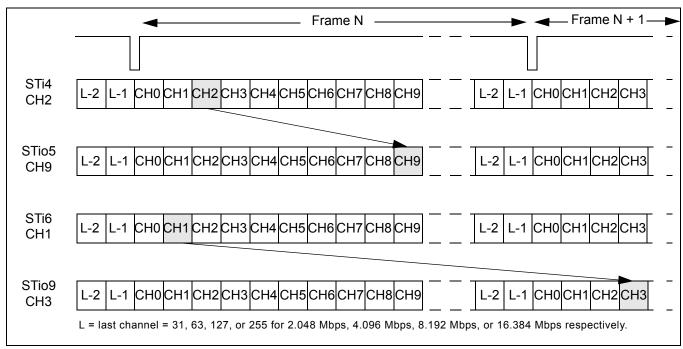


Figure 19 - Data Throughput Delay for Variable Delay

8.2 Constant Delay Mode

In this mode, frame integrity is maintained in all switching configurations. The delay though the switch is 2 frames -Input Channel + Output Channel. This can result in a minimum of 1 frame + 1 channel delay if the last channel on a stream is switched to the first channel of a stream. The maximum delay is 3 frames - 1 channel. This occurs when the first channel of a stream is switched to the last channel of a stream. The constant delay mode is available for all output channels.

The data throughput delay is expressed as a function of ST-BUS/GCI-Bus frames, input channel number (m) and output channel number (n). The data throughput delay (T) is:

T = 2 frames + (n - m)

The constant delay mode is controlled by V/\overline{C} (bit 14) in the Connection Memory Low when CMM = 0. When this bit is set low, the channel is in constant delay mode. If VAREN (bit 4) in the Control Register (CR) is set (to enable variable throughput delay on a chip-wide basis), the device can still be programmed to operate in constant delay mode.

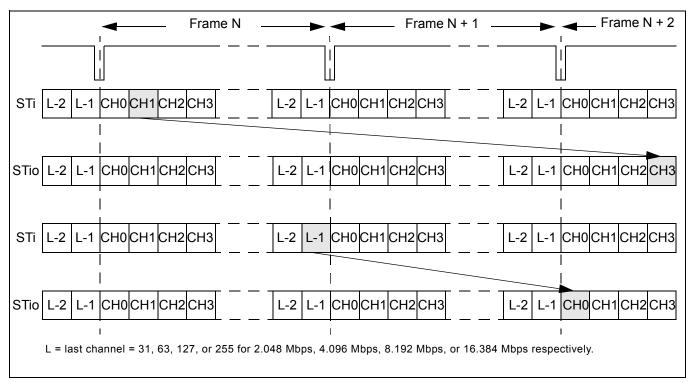


Figure 20 - Data Throughput Delay for Constant Delay

9.0 Connection Memory Description

The connection memory consists of two blocks, Connection Memory Low (CM_L) and Connection Memory High (CM_H). The CM_L is 16 bits wide and is used for channel switching and other special modes. The CM_H is 5 bits wide and is used for the voice coding function. When UAEN (bit 15) of the Connection Memory Low (CM_L) is low, μ -law/A-law conversion will be turned off and the contents of CM_H will be ignored. Each connection memory location of the CM_L or CM_H can be read or written via the 16 bit microprocessor port within one microprocessor access cycle. See Table 68 on page 100 for the address mapping of the connection memory. Any unused bits will be reset to zero on the 16-bit data bus.

For the normal channel switching operation, CMM (bit 0) of the Connection Memory Low (CM_L) is programmed low. SCA7 - 0 (bits 8 - 1) indicate the source (input) channel address and SSA4 - 0 (bits 13 - 9) indicate the source (input) stream address. The 5-bit contents of the CM_H will be ignored during the normal channel switching mode without the μ -law/A-law conversion when UAEN (bit 15) of the Connection Memory Low (CM_L) is set to zero. If μ -law/A-law conversion is required, the CM_H bits must be programmed first to provide the voice/data information, the input coding law and the output coding law before the assertion of UAEN (bit 15) in the Connection Memory Low.

When CMM (bit 0) of the Connection Memory Low (CM_L) is programmed high, the ZL50018 will operate in one of the special modes described in Table 70 on page 102. When the per-channel message mode is enabled, MSG7 - 0 (bit 10 - 3) in the Connection Memory Low (CM_L) will be output via the serial data stream as message output data. When the per-channel message mode is enabled, the μ -law/A-law conversion can also be enabled as required.

10.0 Connection Memory Block Programming

This feature allows for fast initialization of the connection memory after power up.

10.1 Memory Block Programming Procedure

- 1. Set MBPE (bit 3) in the Control Register (CR) from low to high.
- 2. Configure BPD2 0 (bits 3 1) in the Internal Mode Selection (IMS) register to the desired values to be loaded into CM_L.
- Start the block programming by setting MBPS (bit 0) in the Internal Mode Selection Register (IMS) high. The values stored in BPD2 0 will be loaded into bits 2 0 of all CM_L positions. The remaining CM_L locations (bits 15 3) and the programmable values in the CM_H (bits 4 0) will be loaded with zero values.

The following tables show the resulting values that are in the CM_L and CM_H connection memory locations.

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Value	0	0	0	0	0	0	0	0	0	0	0	0	0	BPD2	BPD1	BPD0

Table 5 - Connection Memory	/ Low After Block Programming
-----------------------------	-------------------------------

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Table 6 - Connection Memory High After Block Programming

Note: Bits 15 to 5 are reserved in Connection Memory High and should always be 0.

It takes at least two frame periods (250 µs) to complete a block program cycle.

MBPS (bit 0) in the Control Register (CR) will automatically reset to a low position after the block programming process has completed.

MBPE (bit 3) in the Internal Mode Selection (IMS) register must be cleared from high to low to terminate the block programming process. This is not an automatic action taken by the device and must be performed manually.

Note: Once the block program has been initiated, it can be terminated at any time prior to completion by setting MBPS (bit 0) in the Control Register (CR) or MBPE (bit 3) in the Internal Mode Selection (IMS) register to low. If the MBPE bit was used to terminate the block programming, the MBPS bit will have to be set low before enabling other device operations.

11.0 Device Operation in Master Mode and Slave Modes

This device has two main operating modes - Master mode and Slave mode. Each operating mode has different input/output clock and frame pulse setup requirements and usage.

If the device is programmed to work in Master mode, it is expected that the input clock and frame pulse will be supplied from the embedded DPLL, either directly using the internal loopback mode or indirectly through external loopback path. Sources and destinations of the device's serial input and output data, respectively, have to be synchronized with the device's output clock and frame pulse. In Master mode, output clocks and frame pulses are driven by the DPLL and they are always available with any of the specified frequencies.

The device can also operate in two different Slave modes: Divided Slave mode and Multiplied Slave mode. In either Slave modes, output clocks and frame pulses are generated based on CKi and FPi. The difference is that, in Divided Slave mode, the output clocks and frame pulses are directly divided from CKi/FPi, while in Multiplied Slave mode, the output clocks and frame pulses are generated from an internal high-speed clock synchronized to CKi and FPi. Therefore, in Divided Slave mode, the output clock rates cannot exceed the CKi rate (the output data rates are also limited as per Table 1), but in Multiplied Slave mode, all specified output clock rates and data rates are available on CK00-3 and STio0-31. The input data rate cannot exceed the CKi rate in either Slave modes, because input data are always sampled directly by CKi.

By default, CKo4, CKo5 and FPo5 are not available in Slave mode, as the embedded DPLL is disabled. However, the DPLL can be activated even in Slave mode by programming the SLV DPLLEN bit in the Control Register. When the DPLL is enabled in Slave mode, CKo4, CKo5 and FPo5 are generated from the DPLL synchronized to one of the REF0-3 inputs, while the other clocks, frame pulses, and input/output data are synchronized to CKi/FPi. It basically creates two separate timing domains - one for the DPLL, and one for data switch logic. The two can be totally asynchronous to each other. In this case the DPLL will be fully functional, including its capability of reference monitoring.

Note that an external oscillator is required whenever the DPLL is used.

Table 7, "ZL50018 Operating Modes" on page 37 summarizes the different modes of operation available within the ZL50018. Each Major mode has various associated Minor modes that are determined by setting the relevant Input Control pins and Control Register bits (Table 18, "Control Register (CR) Bits" on page 55) indicated in the table.

Device Operating Mode		Input Pins Control Signal			CR Register		Output Clock Pins			Data Pins				
				Signal		Bits		Reference Lock		Enabled		Clock Source		
Major	Minor	OSC_EN	MODE_4M [1:0]	OSCi	CKi	OPM [1:0]	SLV_DPLLEN	CKi_LP	CKo0-3	CK04-5	CKo0-3	CK04-5	STi	STo
Master	CKi	1	00	20 MHz	4/8/16 M	00	Х	0	Freerun, H		Yes	Yes	CKi*(Cko2
	Loopback				Х			1	or REI	-0-3			Cko2	(DPLL)
Divided Slave	4 M	1	11	20 MHz	4 M	01	1	Х	CKi	REF0-3		Yes	CKi	CKo0-3
	8/16 M		00		8/16 M									(CKi)
	4 M	0	11	Х	4 M	X0	0			Х		No		
	8/16 M		00		8/16 M									
Multiplied	4 M	1	11	20 MHz	4 M	11	1		CKi MULT	REF0-3		Yes		CKo0-3
Slave	8/16 M		00		8/16 M									(CKi MULT)
	4 M	0	11	Х	4 M	X1	0			Х		No		,
	8/16 M		00		8/16 M									

Legend:

X - Don't care or not applicable.

Reference Lock - Refers to what signal the output pins are locked to: REF0-3 = Normal Mode Cki = Bypass. Cki is passed directly through to CKo0-3. Cki MULT = Cki is passed through clock multiplier to CKo0-3. * CKi must be phase aligned (edge synchronous) to CKo0-3. Clock Source - Refers to which clock samples STi and which clock outputs STo; STi applies when STi or STio is input; STo applies when STio is output.

Table 7 - ZL50018 Operating Modes

11.1 Master Mode Operation

When the device is in Master mode, the DPLL is phase-locked to the one of four DPLL reference signals, REF0 to REF3, which are sourced by an external 8 kHz, 1.544 MHz, 2.048 MHz, 4.096 MHz, 8.192 MHz, 16.384 MHz or 19.44 MHz signal. The on-chip DPLL also offers reference switching and monitoring, jitter attenuation, freerun and holdover functions. In this mode, STio0 - 31 are driven by a clock generated by the DPLL, which also provides all the output clocks (CKo0 - 5) and frame pulses (FPo0 - 3 and FPo_OFF0 - 2). One of the output clocks and frame pulses should be looped back to CKi/FPi as reference for the input data, either by internal loopback (by setting the CKi_LP bit high in the Control Register) or through some external loopback paths. If external loopback is used, it is recommended that CKo2 (16.384MHz) and FPo2 (61ns pulse) are used so that all input data rates are available.

11.2 Divided Slave Mode Operation

When the device is in Divided Slave mode, STio0 - 31 are driven by CKi. In this mode, the output streams and clocks have the same jitter characteristics as the input clock (CKi), but the input and output data rates cannot exceed the limit defined by CKi (as per Table 1). For example, if CKi is 4.096 MHz, the input and output data rate cannot be higher than 2.048 Mbps and the generated output clock rates cannot exceed 4.096 MHz. If the DPLL is not enabled, an external oscillator is optional in Divided Slave mode.

11.3 Multiplied Slave Mode Operation

When the device is in Multiplied Slave mode, device hardware is used to multiply CKi internally. STio0 - 31 are driven by this internally generated clock. In this mode, the output clocks and data can run at any of the specified rates, but they may have different jitter characteristics from the input clock (CKi). The input data rates are still limited by the CKi rate (as per Table 1), as input data are always sampled directly by CKi. If the DPLL is not enabled, an external oscillator is not required in Multiplied Slave mode.

12.0 Overall Operation of the DPLL

The DPLL accepts four input references and delivers six output clocks and five output frame pulses. The DPLL meets or exceeds all of the requirements of the Telcordia GR-1244-CORE standard for a Stratum 3 compliant PLL. This includes the freerun, reference switching and monitoring, jitter/wander attenuation and holdover functions. The intrinsic output jitter of the DPLL does not exceed 1 ns (except for the 1.544 MHz output).

The input locking range of the DPLL is programmable, such that it can be larger than the strict Stratum 3 requirements.

The DPLL is able to lock to an input reference presented on the REF0 - 3 inputs. It is possible to force the DPLL module to lock to a selected reference, to prefer one reference, to enter holdover mode or to freerun.

While in freerun mode, the DPLL is able to work in software mode which allows the user to program an output frequency offset value through the microport of the device. Depending on the selected software mode, the DPLL outputs can:

- a. gradually meet the given frequency offset (following pre-programmed phase alignment speed (phase slope) and internal filter response), or
- b. immediately, upon finishing the microport write, reach the given frequency offset, allowing an external filter to be used.

12.1 DPLL Timing Modes

There are four functional modes for the DPLL: normal, holdover, automatic and freerun modes. In addition to these four functional modes, the DPLL can also be programmed to internal reset mode.

12.1.1 Normal Mode

In normal timing mode, the DPLL generates clocks and frame pulses that are phase locked to the active input reference. Jitter on the input clock is attenuated by the DPLL.

12.1.2 Holdover Mode

In holdover mode, the DPLL no longer synchronizes the output clock to any input reference. It maintains the frequency that it was at prior to entering holdover mode. The holdover mode typically happens when the input clock becomes unreliable or is lost altogether. It takes some time for the system to realize that the input clock is unreliable. Meanwhile, the DPLL tracks an unreliable clock. Therefore the DPLL could hold to an invalid frequency when it enters holdover mode. In order to prevent this situation, the DPLL stores the current frequency at regular intervals in holdover memory so that it can restore the frequency of the input clock just after the input clock became unreliable.

The accuracy of the output clock with respect to the last valid input clock is subject to certain standards referred to as Stratum levels where each level requires a certain accuracy. The standards ANSI T1.101 and Telcordia GR-1244-CORE specify the Stratum level requirements. Where ANSI just gives one total number, Telcordia splits it into three components, thereby creating a more stringent requirement than ANSI.

In order to meet Stratum 3, the holdover accuracy of the DPLL is better than 0.05 ppm. Note that in order for the system to meet Stratum 3, the system clock provided by the external oscillator must meet the requirements for the temperature dependence and drift. If Stratum 3 accuracy is not required, a less stable and cheaper system clock can be used instead.

12.1.3 Automatic Mode

In this mode, the state machine controls the DPLL based on the settings in the registers and the quality of the reference input clocks. The DPLL is internally either in normal or in holdover mode. In the following two sections, the reference selection and state machine operation in automatic mode will be explained in more details.

12.1.3.1 Automatic Reference Switching Without Preferences

When the DPLL is programmed to operate in Automatic mode without Preference (RCCR Register, PMS2-0 bits = 000), all references, REF0-3, will have equal importance. A circulating *Round Robin* selection sequence determines the reference to be used as shown in Figure 21. The state machine basically searches for valid reference in a circular order of REF0 -> REF1 -> REF2 -> REF3 -> REF0, etc.

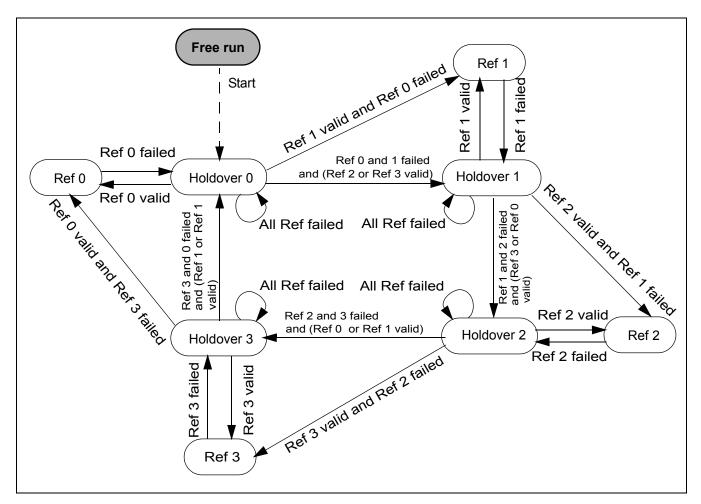


Figure 21 - Automatic Reference Switching State Diagram with No Preferred Reference

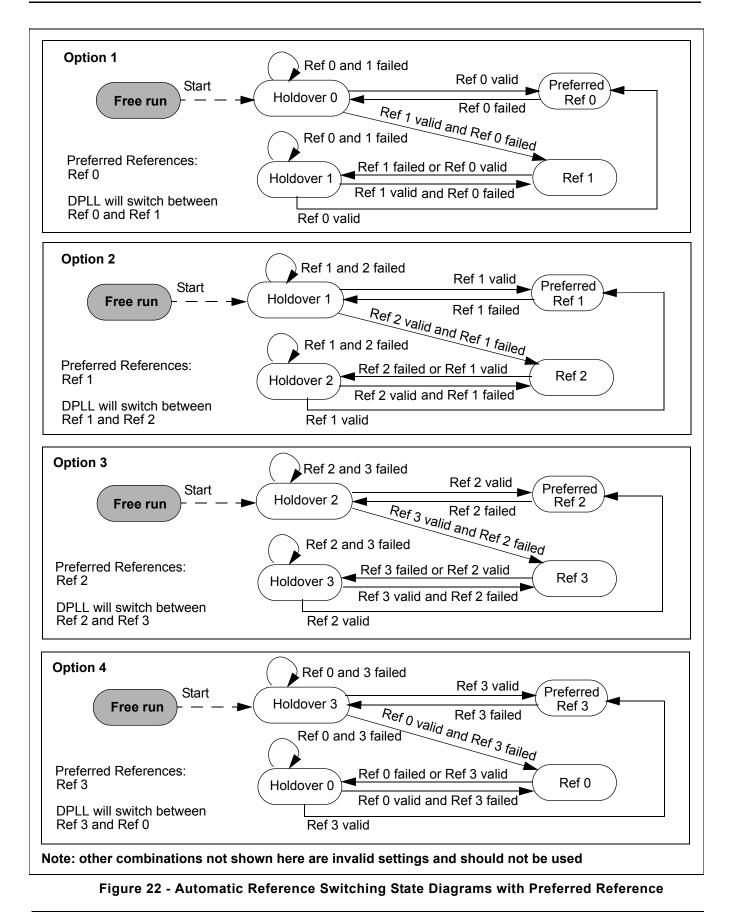
12.1.3.2 Automatic Reference Switching With Preference

If a particular reference needs to have higher priority than the others, the device can be programmed in Automatic mode with a preferred reference (RCCR Register, PMS2-0 bits = 001). When a preferred reference is selected, the device can only switch automatically between two references, as shown in Table 8. The preferred reference will be used as the primary reference and, by default, only its next consecutive reference will be used as the secondary reference. No more than two references can be used in Automatic mode when a preferred reference is selected.

	Primary Reference (Preferred)	Secondary Reference
Option 1	Ref 0	Ref 1
Option 2	Ref 1	Ref 2
Option 3	Ref 2	Ref 3
Option 4	Ref 3	Ref 0

Table 8 - Preferred Reference Selection Options

Figure 22 shows the state diagram for the four valid options of automatic reference switching with a preferred reference.



With a preferred reference, if more than two references are required, or the two references are not in consecutive order, or the roles of the two references need to be interchanged, then external software is required to manually control the reference switching of the DPLL (by monitoring the reference failure status and reprogramming the device accordingly).

12.1.4 Freerun Mode

In freerun mode, the DPLL generates a fixed output frequency based on the crystal oscillator and a programmed centre frequency. To meet Stratum 3, the accuracy of the circuitry for the freerunning output clock must be 4.6 ppm or better. The circuit's freerun accuracy is better than 0.003 ppm.

In freerun mode, the DPLL does not lock to any reference. It is important that the device is not simultaneously in freerun mode (see the RCCR Register) and fast lock mode (see the BWCR Register). Otherwise, the output frame pulse may not be generated correctly.

12.1.5 Software Controlled Mode

When the DPLL is in the freerun mode, it can be put into software controlled mode by enabling the SWE (bit 3) in the DPLL Control Register (DPLLCR). The Software Delta Frequency Register (SWDFR) contains the frequency offset to which the DPLL outputs will move. If SWF (bit 4) in the DPLL Control Register (DPLLCR) is low, the DPLL outputs will gradually move to the given frequency offset, with the speed defined by the DPLL internal filter and phase alignment speed (phase slope) limiter. If SWF (bit 4) is high, the DPLL outputs will reach the Software Delta Frequency Register (SWDFR) frequency offset immediately after it is written, allowing an external software-based filter and phase alignment speed (phase slope) limiter to be used. When SWE (bit 3) is low or the DPLL is not in the freerun mode, the value of Software Delta Frequency Register (SWDFR) will be ignored. For detailed description of the DPLL Control Register (DPLLCR) bits and the Software Delta Frequency Register (SWDFR) bits see Table 29 on page 65, and Table 33 on page 70, respectively.

12.1.6 DPLL Internal Reset Mode

DPLL_IRM (bit 0) in the DPLL Control Register (DPLLCR) enables the internal reset mode. In the internal reset mode, the DPLL module is disabled to save power. The circuit will be reset continuously and no output clocks will be generated. When the internal DPLL module is in the internal reset mode, all registers remain accessible. Note that applying the DPLL reset does not reset the DPLL registers: they preserve the values that they had prior to entering reset.

13.0 DPLL Frequency Behaviour

13.1 Input Frequencies

The DPLL is capable of synchronizing to one of the following input frequencies:

8 kHz
1.544 MHz (DS1)
2.048 MHz (E1)
4.096 MHz
8.192 MHz
16.384 MHz
19.44 MHz

Table 9 - DPLL Input Reference Frequencies

13.2 Input Frequencies Selection

The input frequencies of REF 0 - 3 can be automatically detected or programmed independently by the Reference Frequency Register (RFR) if RFRE (bit 1) in the DPLL Control Register (DPLLCR) is set. The detected frequency of the selected reference is indicated in the Reference Change Status Register (RCSR). In addition, the detected frequencies of all four references are indicated in the Reference Frequency Status Register (RFSR). See Table 29 on page 65, Table 30 on page 67, Table 41 on page 76 and Table 59 on page 91 for the detailed bit description of the DPLL Control Register (DPLLCR), Reference Frequency Register (RFR), Reference Change Status Register (RCSR) and Reference Frequency Status Register (RFSR).

13.3 Output Frequencies

The DPLL generates a limited number of output signals. All signals are synchronous to each other and in the normal operating mode, are locked to the selected input reference. The DPLL provides outputs with the following frequencies:

CKo0	4.096 MHz
CKo1	8.192 MHz
CKo2	16.384 MHz
CKo3	4.096 MHz, 8.192 MHz, 16.384 MHz or 32.768 MHz
CKo4	1.544 MHz or 2.048 MHz
CKo5	19.44 MHz
FPo0	8 kHz (244 ns wide pulse)
FPo1	8 kHz (122 ns wide pulse)
FPo2	8 kHz (61 ns wide pulse)
FPo3	8 kHz (122 ns, 61 ns or 30 ns wide pulse)
FPo5	8 kHz (51 ns wide pulse)

Table 10 - Generated Output Frequencies

13.4 Pull-In/Hold-In Range (also called Locking Range)

The widest tolerance required for any of the given input clock frequencies is ± 130 ppm for the T1 clock (1.544 MHz). If the system clock (crystal/oscillator) accuracy is ± 30 ppm, it requires a minimum pull-in range of ± 160 ppm. Users who do not require the ± 30 ppm freerun accuracy of the DPLL can use a ± 100 ppm system clock. Therefore the pull-in range is a minimal ± 230 ppm. The pull-in range is programmable through the Frequency Locking Range Register (FLRR) as described in Table 35 on page 71. Since the width of the register is 14 bits, the maximum programmable pull-in range can be as high as ± 372 ppm. The minimum pull-in/hold-in range required for Stratum 3 clocks is ± 4.6 ppm. The default pull-in range of this device is ± 20 ppm.

14.0 Jitter Performance

14.1 Input Clock Cycle to Cycle Timing Variation Tolerance

The ZL50018 has an exceptional cycle to cycle timing variation tolerance of 20 ns. This allows the ZL50018 to synchronize off a low cost DPLL when it is in either Divided Slave mode or Multiplied Slave mode.

14.2 Input Jitter Acceptance

The input jitter acceptance is specified in standards as the minimum amount of jitter of a certain frequency on the input clock that the DPLL must accept without making cycle slips or losing lock. The lower the jitter frequency, the larger the jitter acceptance. For jitter frequencies below a tenth of the cut-off frequency of the DPLL's jitter transfer function, it safely can be said that any provided input jitter will be followed by the DPLL. The maximum value of jitter tolerance for the DPLL is ± 1023 UI _{p-p}.

14.3 Jitter Transfer Function

The corner frequency (-3 dB) of the DPLL is programmable through LPF (bits 3 - 0) in the Bandwidth Control Register (BWCR) from 0.475 Hz to 15.5 kHz, in 16 steps. Stratum 3 requires a corner frequency of maximally 3 Hz. The default corner frequency is 1.9 Hz.

15.0 DPLL Specific Functions and Requirements

15.1 Lock Detector

To determine if the DPLL is locked to the input clock, a lock detector monitors the phase value output of the phase detector, which represents the difference between input reference and output feedback clock. If the phase value is below a certain threshold for a certain interval, the DPLL is pronounced locked to the input clock. The monitoring is done in intervals of 4ms. The lock detector threshold and the interval are programmable by the user through the Lock Detector Threshold Register (LDTR) and the Lock Detector Interval Register (LDIR) respectively. See Table 36 on page 72 and Table 37 on page 72 for the bit descriptions of the Lock Detector Threshold Register (LDTR) and Lock Detector Interval Register (LDTR) respectively. The value of the Lock Detector Threshold Register (LDTR) should be programmed with respect to the maximum expected jitter frequency and amplitude on the selected input references.

The lock status can be monitored through the Reference Change Status Register (RCSR). See Table 41 on page 76 for the bit description of the Reference Change Status Register (RCSR).

15.2 Maximum Time Interval Error (MTIE)

Several standards require that the output clock of the DPLL may not move in phase more than a certain amount. In order to meet those standards, a special circuit maintains the phase of the DPLL output clock during reference and mode rearrangements. The total output phase change or Maximum Timing Interval Error (MTIE) during rearrangements is less than 31 ns per rearrangement, exceeding Stratum 3 requirements. After a large number of reference switches, the accumulated phase error can become significant, so it is recommended to use MTIE reset in such situations, to realign outputs to the nearest edge of the selected reference. The MTIE reset can be programmed by setting MTR (bit 7) in the Reference Change Control Register (RCCR), as described in Table 40 on page 75.

15.3 Phase Alignment Speed (Phase Slope)

Besides total phase change, standards also require a certain rate of the phase change of the output clock. The phase alignment speed is programmable by the user through a value in the Slew Rate Limit Register (SRLR) as described in Table 38 on page 73. Stratum 3 requires that the phase alignment speed not exceed 81 ns per

1.326 ms (61 ppm). The width of the register and the limiter circuitry, if not bypassed, provide a maximum phase change alignment speed of 186 ppm.

The limiter circuitry can be bypassed by programming BLM (bit 13) in the Bandwidth Control Register (BWCR). Bypassing limiter (combined with choice of other parameters in the BWCR register) can achieve very fast lock of the output clock to the selected input reference. A side effect of the bypassing limiter is manifested through much higher intrinsic jitter. Once the bypassing is stopped, the jitter characteristics are guaranteed. The phase alignment speed default value is 56 ppm.

15.4 Fast Locking Mode

If very fast locking feature (i.e., locking time in order of 1 s) is desirable, the Bandwidth Control Register (BWCR) can be programmed to accommodate the feature for any selected corner frequency. In this mode, the DPLL's phase alignment speed limiter is bypassed. See Table 39, "Bandwidth Control Register (BWCR) Bits" on page 73.

Semi-fast locking mode does not bypass the internal phase alignment speed limiter, thereby maintaining phase alignment speed. This mode can be achieved by programming the SM_FST bit in the DPLL Control Register.

In freerun mode, the DPLL does not lock to any reference. It is important that the device is not simultaneously in freerun mode (see the RCCR Register) and fast lock mode (see the BWCR Register). Otherwise, the output frame pulse may not be generated correctly.

15.5 Reference Monitoring

The quality of the four input reference clocks is continuously monitored by the reference monitors. There are separate reference monitor circuits for the four DPLL references. References are checked for short phase (single period) deviations as well as for frequency (multi-period) deviations with hysteresis.

The Reference Status Register (RSR) reports the status of the reference monitors. The register bits are described in Table 57 on page 88. The Reference Mask Register (RMR) allows users to ignore the monitoring features of the reference monitors. See Table 58 on page 89 for details.

15.6 Single Period Reference Monitoring

Values for short phase deviations (upper and lower limit) are programmable through registers. The unit of the binary values of these numbers is 100 MHz clock period (10 ns). Single period deviation limits are more relaxed than multi period limits, and are used for early detection of the reference loss, or huge phase jumps.

Registers containing the lower and upper limits of the acceptance range for the single input reference period measurement are: Reference Lower Limit Registers: R0LLR, R1LLR, R2LLR and R3LLR and the Reference Upper Limit Registers: R0ULR, R1ULR, R2ULR and R3ULR.

The default values for the upper and lower limits are shown in the following table:

Reference Frequency	Comment
8 kHz	10 UI p-p
1.544 MHz	0.3 UI p-p
2.048 MHz	0.2 UI p-p
4.096 MHz	0.2 UI p-p
8.192 MHz	0.2 UI p-p
16.384 MHz	0.2 UI p-p
19.44 MHz	0.2 UI p-p

 Table 11 - Values for Single Period Limits

Reference Frequency	Upper Limit (in 10 ns units)	Lower Limit (in 10 ns units)	Comment
8 kHz	ʻh2E4A	'h335C	6.4 us (10 Ulp-p of 1.544 MHz)
1.544 MHz	'h002B	'h0055	0.3 Ulp-p
2.048 MHz	'h0025	'h003B	0.2 Ulp-p
4.096 MHz	'h0011	'h001E	0.2 Ulp-p
8.192 MHz	'h0007	'h000F	0.2 Ulp-p
16.384 MHz	'h0002	'h0008	0.2 Ulp-p
19.44 MHz	ʻh0002	ʻh0007	0.2 Ulp-p

Table 12 - Default Values for Single Period Limits

15.7 Multiple Period Reference Monitoring

To monitor reference failure based on frequency offset, multi period checking is performed. Reference validation time is prescribed by Telcordia GR-1244-CORE and is between 10 and 30 seconds. To meet the criteria for reference validation time, the time base for multi period monitoring has to be big enough and is programmable. To implement hysteresis, the upper limits are split into near upper and far upper limits and the lower limits are split into near lower and far lower limits. The reference failure is detectable only when the reference passes far limits, but passing is not detected until the reference is within near limits. The zone between near and far limits, called the "grey zone", is required by standards and prevents unnecessary reference switching when the selected reference is close to the boundary of failure.

The monitor makes a decision about reference validity after two consecutive measurements with respect to its time base. The time base for multi-period monitoring, by default, is 10 seconds. The time base is defined in the number of reference clock cycles and is programmable.

Assuming that the evaluation time is chosen to be the same regardless of reference frequency (10 seconds), the parameters that allow hysteresis functionality also have the same values, regardless of the reference frequency. These parameters (near lower, far lower, near upper and far upper limits) are programmable.

Registers containing the multi period count are: Reference Multi-Period Counter Registers: R0MPCRL, R0MPCRU, R1MPCRU, R2MPCRL, R2MPCRU, R3MPCRL and R3MPCRU.

For the measurement length of multiple clock periods, the period count is set by the Reference Multi-Period Count Registers - Lower 16 Bits: R0MPCRL, R1MPCRL, R2MPCRL and R3MPCRL and the Reference Multi-Period Count Registers - Upper 16 Bits: R0MPCRU, R1MPCRU, R2MPCRU, and R3MPCRU.

The near upper measurement limits are set by the Multi-Period Near Upper Limit Registers, MPNULRL and MPNULRU.

The far upper measurement limits are set by the Multi-Period Far Upper Limit Registers, MPFULRL and MPFULRU.

The near lower measurement limits are set by the Multi-Period Near Lower Limit Registers, MPNLLRL and MPNLLRU.

The far lower measurement limits are set by the Multi-Period Far Lower Limit Registers, MPFLLRL and MPFLLRU.

The registers' default values upon the device reset comply to Stratum 3 when reference frequencies are 8 kHz. If MRLE (bit 2) of the DPLL Control Register (DPLLCR) is not set, all above mentioned registers for limits and counter values will be ignored and the Stratum 3 default values will be used. The values that comply to Stratum 3 for each

detected input reference frequency are used. In order to use programmed values for the monitor registers, MRLE (bit 2) has to be set, in the eventuality that values other than Stratum 3 compliant values are desired.

	Stratum 3 Default Values (in 10 ns units)
Far Upper Limit	-11.287 ppm 'h3B9A9DE8
Near Upper Limit	-9.913 ppm 'h3B9AA346
Nominal Value	0 ppm 'h3B9AC9FF
Near Lower Limit	9.913 ppm 'h3B9AF0B8
Far Lower Limit	11.287 ppm 'h3B9AF616

 Table 13 - Default Multi-period Hysteresis Limits

16.0 Microprocessor Port

The device provides access to the internal registers, connection memories and data memories via the microprocessor port. The microprocessor port is capable of supporting both Motorola and Intel non-multiplexed microprocessors. The microprocessor port consists of a <u>16-bit parallel</u> data <u>bus</u> (D15 - 0), 14 bit address bus (A13 - 0) and six control signals (MOT_INTEL, CS, DS_RD, R/W_WR, IRQ and DTA_RDY).

The data memory can only be read from the microprocessor port. For a data memory read operation, D7 - 0 will be used and D15 - 8 will output zeros.

For a CM_L read or write operation, all bits (D15 - 0) of the data bus will be used. For a CM_H write operation, D4 - 0 of the data bus must be configured and D15 - 5 are ignored. D15 - 5 must be driven either high or low. For a CM_H read operation, D4 - 0 will be used and D15 - 5 will output zeros.

Refer to Figure 26 on page 108, Figure 27 on page 109, Figure 28 on page 110 and Figure 29 on page 111 for the microprocessor timing.

17.0 Device Reset and Initialization

The RESET pin is used to reset the ZL50018. When this pin is low, the following functions are performed:

- · synchronously puts the microprocessor port in a reset state
- tristates the STio0 31 outputs
- drives the STOHZ0 15 outputs to high
- preloads all internal registers with their default values (refer to the individual registers for default values)
- clears all internal counters

17.1 Power-up Sequence

The recommended power-up sequence is for the V_{DD_IO} supply (normally +3.3 V) to be established before the power-up of the V_{DD_CORE} supply (normally +1.8 V). The V_{DD_CORE} supply may be powered up at the same time as V_{DD_IO}, but should not "lead" the V_{DD_IO} supply by more than 0.3 V.

17.2 Device Initialization on Reset

Upon power up, the ZL50018 should be initialized as follows:

- Set the ODE pin to low to disable the STio0 31 outputs and to drive STOHZ0 15 to high
- Set the TRST pin to low to disable the JTAG TAP controller
- Reset the device by pulsing the $\overline{\text{RESET}}$ pin to zero for longer than 1 μ s
- After releasing the RESET pin from low to high, wait for a certain period of time (see Note below) for the device to stabilize from the power down state before the first microprocessor port access can occur
- Program CKIN1 0 (bit 6 -5) in the Control Register (CR) to define the frequency of the CKi and FPi inputs
- Wait at least 500 μs prior to the next microport access (see Note below)
- · Use the block programming mode to initialize the connection memory
- Release the ODE pin from low to high after the connection memory is programmed

NOTE: If an external oscillator is used, the waiting time is 500 μ s. Without the external oscillator, if CKi is 16.384 MHz, the waiting time is 500 μ s; if CKi is 8.192 MHz, the waiting time is 1ms; if CKi is 4.096 MHz, the waiting time is 2 ms.

17.3 Software Reset

In addition to the hardware reset from the $\overrightarrow{\mathsf{RESET}}$ pin, the device can also be reset by using software reset. There are two software reset bits in the Software Reset Register (SRR). SRSTDPLL (bit 0) is used to reset the DPLL while SRSTSW (bit 1) resets the rest of the switch.

18.0 Pseudo-random Bit Generation and Error Detection

The ZL50018 has one Bit Error Rate (BER) transmitter and one BER receiver for each pair of input and output streams, resulting in 32 transmitters connected to the output streams and 32 receivers associated with the input streams. Each transmitter can generate a BER sequence with a pattern of 2^{15} -1 pseudo-random code (ITU 0.151). Each transmitter can start at any location on the stream and will last for a minimum of 1 channel to a maximum of 1 frame time (125 µs). The BER receivers and transmitters are enabled by programming the RBEREN (bit 5) and TBEREN (bit 4) in the IMS register. In order to save power, the 32 transmitters and/or receivers can be disabled. (This is the default state.)

Multiple connection memory locations can be programmed for BER tests such that the BER patterns can be transmitted for multiple consecutive output channels. If consecutive input channels are not selected, the BER receiver will not compare the bit patterns correctly. The number of output channels which the BER pattern occupies has to be the same as the number of channels defined in the BER Length Register (BRLR) which defines how many BER channels are to be monitored by the BER receiver.

For each input stream, there is a set of registers for the BER test. The registers are as follows:

- BER Receiver Control Register (**BRCR**) ST[n]CBER (bit 1) is used to clear the Bit Receiver Error Register (BRER). ST[n]SBER (bit 0) is used to enable the per-stream BER receiver.
- BER Receiver Start Register (**BRSR**) ST[n]BRS7 0 (bit 7 0) defines the input channel from which the BER sequence will start to be compared.
- BER Receiver Length Register (**BRLR**) ST[n]BL8 0 (bit 8 0) define how many channels the sequence will last. Depending on the data rate being used, the BER test can last for a maximum of 32, 64, 128 or 256 channels at the data rates of 2.048, 4.096, 8.192 or 16.384 Mbps, respectively. The minimum length of the BER test is a single channel. The user must take care to program the correct channel length for the BER test so that the channel length does not exceed the total number of channels available in the stream.

 BER Receiver Error Register (BRER) - This read-only register contains the number of counted errors. When the error count reaches 0xFFFF, the BER counter will stop updating so that it will not overflow. ST[n]CBER (bit 1) in the BER Receiver Control Register is used to reset the BRER register.

For normal BER operation, CMM (bit 0) must be 1 in the Connection Memory Low (CM_L). PCC1 - 0 (bits 2 - 1) in the Connection Memory Low must be programmed to "10" to enable the per-stream based BER transmitters. For each stream, the length (or total number of channels) of BER testing can be as long as one whole frame, but the channels MUST be consecutive. Upon completion of programming the connection memory, the corresponding BER receiver can be started by setting ST[n]SBER (bit 0) in the BRCR to high. There must be at least 2 frames (250 μ s) between completion of connection memory programming and starting the BER receiver before the BER receiver can correctly identify BER errors. A 16 bit BER counter is used to count the number of bit errors.

19.0 PCM A-law/µ-law Translation

The ZL50018 provides per-channel code translation to be used to adapt pulse code modulation (PCM) voice or data traffic between networks which use different encoding laws. Code translation is valid in both Connection Mode and Message Mode.

In order to use this feature, the Connection Memory High (CM_H) entry for the output channel must be programmed. \overline{V}/D (bit 4) defines if the traffic in the channel is voice or data. Setting ICL1 - 0 (bits 3 - 2) programs the input coding law and OCL1 - 0 (bits 1- 0) programs the output coding law as shown in Table 14.

Input Coding (ICL1- 0)	Output Coding (OCL1 - 0)	Voice Coding (V/D bit = 0)	Data Coding (V/D bit = 1)
00	00	ITU-T G.711 A-law	No code
01	01	ITU-T G.711 μ-law	Alternate Bit Inversion (ABI)
10	10	A-law without Alternate Bit Inversion (ABI)	Inverted Alternate Bit Inversion (ABI)
11	11	μ-law without Magnitude Inversion (MI)	All bits inverted

The different code options are:

Table 14 - Input and Output Voice and Data Coding

For voice coding options, the ITU-T G.711 A-law and ITU-T G.711 μ -law are the standard rules for encoding. A-law without Alternate Bit Inversion (ABI) is an alternative code that does not invert the even bits (6, 4, 2, 0). μ -law without Magnitude Inversion (MI) is an alternative code that does not perform inversion of magnitude bits (6, 5, 4, 3, 2, 1, 0).

When transferring data code, the option "no code" does not invert the bits. The Alternate Bit Inversion (ABI) option inverts the even bits (6, 4, 2, 0) while the Inverted Alternate Bit Inversion (ABI) inverts the odd bits (7, 5, 3, 1). When the "All bits inverted" option is selected, all of the bits (7, 6, 5, 4, 3, 2, 1, 0) are inverted.

The input channel and output channel encoding law are configured independently. If the output channel coding is set to be different from the input channel, the ZL50018 performs translation between the two standards. If the input and output encoding laws are set to the same standard, no translation occurs. As the \overline{V}/D (bit 4) of the Connection Memory High (CM_H) must be set on a per-channel basis, it is not possible to translate between voice and data encoding laws.

20.0 Quadrant Frame Programming

By programming the Stream Input Quadrant Frame Registers (SIQFR0 - 31), users can divide one frame of input data into four quadrant frames and can force the LSB or MSB of every input channel in these quadrants to one or zero for robbed-bit signaling. The four quadrant frames are defined as follows:

Data Rate	Quadrant 0	Quadrant 1	Quadrant 2	Quadrant 3
2.048 Mbps	Channel 0 - 7	Channel 8 - 15	Channel 16 - 23	Channel 24 - 31
4.096 Mbps	Channel 0 - 15	Channel 16 - 31	Channel 32 - 47	Channel 48 - 63
8.192 Mbps	Channel 0 - 31	Channel 32 - 63	Channel 64 - 95	Channel 96 - 127
16.384 Mbps	Channel 0 - 63	Channel 64 - 127	Channel 128 - 191	Channel 192 - 255

Table 15 - Definition of the Four Quadrant Frames

When the quadrant frame control bits, STIN[n]Q3C2 - 0 (bit 11 - 9), STIN[n]Q2C2 - 0 (bit 8 - 6), STIN[n]Q1C2 - 0 (bit 5 - 3) or STIN[n]Q1C2 - 0 (bit 2 - 0), are set, the LSB or MSB of every input channel in the quadrant is forced to "1" or "0" as shown by the following table:

STIN[n]Q[y]C[2:0]	Action
0xx	Normal Operation
100	Replaces LSB of every channel in Quadrant y with '0'
101	Replaces LSB of every channel in Quadrant y with '1'
110	Replaces MSB of every channel in Quadrant y with '0'
111	Replaces MSB of every channel in Quadrant y with '1'
Note: y = 0, 1, 2, 3	

Table 16 - Quadrant Frame Bit Replacement

Note that Quadrant Frame Programming and BER reception cannot be used simultaneously on the same input stream.

21.0 JTAG Port

The JTAG test port is implemented to meet the mandatory requirements of the IEEE-1149.1 (JTAG) standard. The operation of the boundary-scan circuitry is controlled by an external Test Access Port (TAP) Controller.

21.1 Test Access Port (TAP)

The Test Access Port (TAP) accesses the ZL50018 test functions. It consists of three input pins and one output pin as follows:

- **Test Clock Input (TCK)** TCK provides the clock for the test logic. TCK does not interfere with any on-chip clock and thus remains independent in the functional mode. TCK permits shifting of test data into or out of the Boundary-Scan register cells concurrently with the operation of the device and without interfering with the on-chip logic.
- **Test Mode Selection Inputs (TMS)** The TAP Controller uses the logic signals received at the TMS input to control test operations. The TMS signals are sampled at the rising edge of the TCK pulse. This pin is internally pulled to high when it is not driven from an external source.

- **Test Data Input (TDi)** Serial input data applied to this port is fed either into the instruction register or into a test data register, depending on the sequence previously applied to the TMS input. The registers are described in a subsequent section. The received input data is sampled at the rising edge of the TCK pulse. This pin is internally pulled to high when it is not driven from an external source.
- Test Data Output (TDo) Depending on the sequence previously applied to the TMS input, the contents of
 either the instruction register or test data register are serially shifted out towards TDo. The data from TDo is
 clocked on the falling edge of the TCK pulses. When no data is shifted through the boundary scan cells, the
 TDo driver is set to a high impedance state.
- **Test Reset (TRST)** Resets the JTAG scan structure. This pin is internally pulled to high when it is not driven from an external source.

21.2 Instruction Register

The ZL50018 uses the public instructions defined in the IEEE-1149.1 standard. The JTAG interface contains a four-bit instruction register. Instructions are serially loaded into the instruction register from the TDi when the TAP Controller is in its shifted-OR state. These instructions are subsequently decoded to achieve two basic functions: to select the test data register that may operate while the instruction is current and to define the serial test data register path that is used to shift data between TDi and TDo during data register scanning.

21.3 Test Data Registers

As specified in the IEEE-1149.1 standard, the ZL50018 JTAG interface contains three test data registers:

- **The Boundary-Scan Register** The Boundary-Scan register consists of a series of boundary-scan cells arranged to form a scan path around the boundary of the ZL50018 core logic.
- **The Bypass Register** The Bypass register is a single stage shift register that provides a one-bit path from TDi to TDo.
- The Device Identification Register The JTAG device ID for the ZL50018 is 0C36214B_H

Version	<31:28>	0000
Part Number	<27:12>	1100 0011 0110 0010
Manufacturer ID	<11:1>	0001 0100 101
LSB	<0>	1

21.4 BSDL

A Boundary Scan Description Language (BSDL) file is available from Zarlink Semiconductor to aid in the use of the IEEE-1149.1 test interface.

22.0 Register Address Mapping

Address A13 - A0	CPU Access	Name	Abbreviation	Reset By
0000 _H	R/W	Control Register	CR	Switch/Hardware
0001 _H	R/W	Internal Mode Selection Register	IMS	Switch/Hardware
0002 _H	R/W	Software Reset Register	SRR	Hardware Only
0003 _H	R/W	Output Clock and Frame Pulse Control Register	OCFCR	DPLL/Hardware
0004 _H	R/W	Output Clock and Frame Pulse Selection Register	OCFSR	DPLL/Hardware
0005 _H	R/W	FPo_OFF0 Register	FPOFF0	DPLL/Hardware
0006 _H	R/W	FPo_OFF1 Register	FPOFF1	DPLL/Hardware
0007 _H	R/W	FPo_OFF2 Register	FPOFF2	DPLL/Hardware
0010 _H	R Only	Internal Flag Register	IFR	Switch/Hardware
0011 _H	R Only	BER Error Flag Register 0	BERFR0	Switch/Hardware
0012 _H	R Only	BER Error Flag Register 1	BERFR1	Switch/Hardware
0013 _H	R Only	BER Receiver Lock Register 0	BERLR0	Switch/Hardware
0014 _H	R Only	BER Receiver Lock Register 1	BERLR1	Switch/Hardware
0040 _H	R/W	DPLL Control Register	DPLLCR	DPLL/Hardware
0041 _H	R/W	Reference Frequency Register	RFR	DPLL/Hardware
0042 _H	R/W	Centre Frequency Register - Lower 16 Bits	CFRL	DPLL/Hardware
0043 _H	R/W	Centre Frequency Register - Upper 10 Bits	CFRU	DPLL/Hardware
0044 _H	R/W	Software Delta Frequency Register	SWDFR	DPLL/Hardware
0045 _H	R Only	Frequency Offset Register	FOR	DPLL/Hardware
0046 _H	R/W	Frequency Locking Range Register	FLRR	DPLL/Hardware
0047 _H	R/W	Lock Detector Threshold Register	LDTR	DPLL/Hardware
0048 _H	R/W	Lock Detector Interval Register	LDIR	DPLL/Hardware
0049 _H	R/W	Slew Rate Limit Register	SRLR	DPLL/Hardware
004A _H	R/W	Bandwidth Control Register	BWCR	DPLL/Hardware
004B _H	R/W	Reference Change Control Register	RCCR	DPLL/Hardware
004C _H	R Only	Reference Change Status Register	RCSR	DPLL/Hardware
004E _H	R/W	Multi-period Near Upper Limit Register - Lower 16 Bits	MPNULRL	DPLL/Hardware

Table 17 - Address Map for Registers (A13 = 0)

			1	
004F _H	R/W	Multi-period Near Upper Limit Register - Upper 16 Bits	MPNULRU	DPLL/Hardware
0050 _H	R/W	Multi-period Far Upper Limit Register - Lower 16 Bits	MPFULRL	DPLL/Hardware
0051 _H	R/W	Multi-period Far Upper Limit Register - Upper 16 Bits	MPFULRU	DPLL/Hardware
0052 _H	R/W	Multi-period Near Lower Limit Register - Lower 16 Bits	MPNLLRL	DPLL/Hardware
0053 _H	R/W	Multi-period Near Lower Limit Register - Upper 16 Bits	MPNLLRU	DPLL/Hardware
0054 _H	R/W	Multi-period Far Lower Limit Register - Lower 16 Bits	MPFLLRL	DPLL/Hardware
0055 _H	R/W	Multi-period Far Lower Limit Register - Upper 16 Bits	MPFLLRU	DPLL/Hardware
0056 _H	R/W	Reference 0 Multi-period Count Register - Lower 16 Bits	R0MPCRL	DPLL/Hardware
0057 _H	R/W	Reference 0 Multi-period Count Register - Upper 16 Bits	R0MPCRU	DPLL/Hardware
0058 _H	R/W	Reference 0 Upper Limit Register	R0ULR	DPLL/Hardware
0059 _H	R/W	Reference 0 Lower Limit Register	R0LLR	DPLL/Hardware
005A _H	R/W	Reference 1 Multi-period Count Register - Lower 16 Bits	R1MPCRL	DPLL/Hardware
005B _H	R/W	Reference 1 Multi-period Count Register - Upper 16 Bits	R1MPCRU	DPLL/Hardware
005C _H	R/W	Reference 1 Upper Limit Register	R1ULR	DPLL/Hardware
005D _H	R/W	Reference 1 Lower Limit Register	R1LLR	DPLL/Hardware
005E _H	R/W	Reference 2 Multi-period Count Register - Lower 16 Bits	R2MPCRL	DPLL/Hardware
005F _H	R/W	Reference 2 Multi-period Count Register - Upper 16 Bits	R2MPCRU	DPLL/Hardware
0060 _H	R/W	Reference 2 Upper Limit Register	R2ULR	DPLL/Hardware
0061 _H	R/W	Reference 2 Lower Limit Register	R2LLR	DPLL/Hardware
0062 _H	R/W	Reference 3 Multi-period Count Register - Lower 16 Bits	R3MPCRL	DPLL/Hardware
0063 _H	R/W	Reference 3 Multi-period Count Register - Upper 16 Bits	R3MPCRU	DPLL/Hardware
0064 _H	R/W	Reference 3 Upper Limit Register	R3ULR	DPLL/Hardware
0065 _H	R/W	Reference 3 Lower Limit Register	R3LLR	DPLL/Hardware
0066 _H	R Only	Interrupt Register	IR	DPLL/Hardware
0067 _H	R/W	Interrupt Mask Register	IMR	DPLL/Hardware
0068 _H	R/W	Interrupt Clear Register	ICR	DPLL/Hardware
0069 _H	R Only	Reference Status Register	RSR	DPLL/Hardware
006A _H	R/W	Reference Mask Register	RMR	DPLL/Hardware
006B _H	R Only	Reference Frequency Status Register	RFSR	DPLL/Hardware
006C _H	R/W	Output Jitter Control Register	OJCR	DPLL/Hardware
	R/W	Stream Input Control Registers 0 - 31	SICR0 - 31	Switch/Hardware

Table 17 - Address Map for Registers (A13 = 0) (continued)

0120 _H - 013F _H	R/W	Stream Input Quadrant Frame Registers 0 - 31	SIQFR0 - 31	Switch/Hardware
0200 _H - 021F _H	R/W	Stream Output Control Registers 0 - 31	SOCR0 - 31	Switch/Hardware
0300 _H - 031F _H	R/W	BER Receiver Start Registers 0 - 31	BRSR0 - 31	Switch/Hardware
0320 _H - 033F _H	R/W	BER Receiver Length Registers 0 - 31	BRLR0 - 31	Switch/Hardware
0340 _H - 035F _H	R/W	BER Receiver Control Registers 0 - 31	BRCR0 - 31	Switch/Hardware
0360 _H - 037F _H	R Only	BER Receiver Error Registers 0 - 31	BRER0 - 31	Switch/Hardware

Table 17 - Address Map for Registers (A13 = 0) (continued)

23.0 Detailed Register Description

External Reset Va		Write Addr 000 _H	ess: 0000) _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	SLV_ DPLLEN	OPM 1	OPM 0	CKi_ LP	FPIN POS	CKINP	FPINP	CKIN 1	CKIN 0	VAR EN	MBPE	OSB	MS1	MS0
Bit	N	ame						De	scripti	on					
15 - 14	Un	used	Reser	ved. Ir	n norma	al func	tional m	ode, the	ese bit	s MUS	T be se	et to zer	0.		
13		LV_ LLEN	When When CKi ar REF[3 genera	this bi this bi SLV [nd FPi :0]). Ir ation c	t is low t is higl DPLLE DPLLE CKo[this r Df the	, DPLL n and (N is se 5:4] ar mode (REF_I	is disal OSC_EI et in Sla d FPo[of opera	5] are 1 ation, th] outpu	Slave n le DPL de, CK ocked le DPI	node. L is en to[3:0] to the L reta	abled i and Fl select ins its	Po[3:0] ed inpu functio	are ge ut refe nality,	enerato rence incluc	ed from (one of ling the perating
12 - 11	OPI	W1 - 0	Opera These "ZL500	bits a	are use	ed to a g Mode	set the es" on p	device age 37	in Ma for mo	aster/S re deta	lave o ils.	peratior	n. Ref	er to	Table 7,
10	Ck	(i_LP	When When and FI CKIN1	this bi this bi Po2 re - 0 (t is low it is hig spectiv bits 6	, CKi à jh, CKi /ely, ar - 5) of	nd FPi and Fl and Fl nd CKi this re	pin and	d as in iternall FPi p hould	put pin y loop in shoi be pro	ed bac uld be gramm	tied lov	v or hi	gh ext	4 MHz) ternally; Table 7,
9	FPI	NPOS	When	this bi	t is low	, FPi st	Positio traddles starts fro	n frame l om fram	oounda e bour	ary (as ndary (a	define as defi	d by ST ned by (-BUS) GCI-B	us)	
8	Cł	KINP	When	this bi		, the C	Ki fallin	g edge a Ig edge							
7	FF	PINP	When	this b	it is lo	w, the	•					•		•	format. at.
6 - 5	CKI	N1 - 0	Input	Clock	(CKi) a	and Fr	ame Pu	ılse (FP	i) Sele	ection					
				Γ	CK	N1 - 0		FPi Acti	ve Per	iod		CKi			
				F		00		6	l ns		16	.384 M	Hz	1	
						01		12	2 ns			192 MF			
						10		24	4 ns			096 MF	Ηz		
						11				Reser					
								1 pins, a put cloo			n "Pin	Descrip	otion" c	on pag	e 13,

Table 18 - Control Register (CR) Bits

ZL50018

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	SLV_ DPLLEN	OPM 1	OPM 0	CKi_ LP	FPIN POS	CKINP	FPINP	CKIN 1	CKIN 0	VAR EN	MBPE	OSB	MS1	MS0
D ''															
Bit	Na	ame						Des	scripti	on					
4	VA	REN	When	le Dela this bit this bit	is low,	, the va	able ariable c ⁄ariable	lelay mo delay m	ode is o lode is	disable enable	d on a ed on a	device a device	-wide k e-wide	basis. basis.	
3	M	BPE	When	this bit m the c	is hid	ah, the	ning Er connec emory.	ction me	emory is low,	block the me	orogra emory	mming block pr	mode ogram	is ena iming i	abled mode
2	С	SB	•		-		bit enal							erial c	output
				RESET Pin		STSW SRR)	ODE Pin	OSB Bit		STio0 - 3	31	S	TOHZ0	- 15	
				0		Х	Х	Х		HiZ			Driven H	ligh	
				1		1	Х	Х		HiZ			Driven H	0	
				1		0	0	Х		HiZ			Driven H	0	
				1		0	1	0		HiZ			Driven H	-	
				1		0	1	1	(Cor	Active atrolled b		(Co	Active ntrolled		
				Unused .0 - 31 (ims are	tristated	d (STio	= HiZ,	STOF	IZ = Dri	ven Hi	gh). R	efer t
1 - 0	MS	61 - 0	SOCR	0 - 31 (ry Sele	bit2 - (ct Bit	0). s Thes	ams are se two b for acce	its are u	used to						
1 - 0	MS	61 - 0	SOCR	0 - 31 (ry Sele gh or da	bit2 - (ct Bit	0). s Thes emory f	se two b	its are u ss by C	used to PU:		conne				
1 - 0	MS	<u>81 - 0</u>	SOCR	0 - 31 (ry Sele gh or da	bit2 - (ect Bit ata me	0). s Thes emory f	se two b for acce	its are u ss by C	used to PU: Memo	select	conne	ection m	nemory		
1 - 0	MS	31 - 0	SOCR	0 - 31 (ry Sele gh or da	bit2 - (ect Bit ata me /IS1 - (0). s Thes emory f	se two b for acce C	its are ι ss by C	used to PU: Memo on Mer	select ry Sele mory Lo	conne	ection m ad/Write	nemory		
1 - 0	MS	51 - 0	SOCR	0 - 31 (ry Sele gh or da	bit2 - (ect Bit ata me //S1 - (00	0). s Thes emory f	se two b for acce C	oits are u ss by C onnectio	used to PU: Memo on Mer	select ry Sele mory Lo	ction ction ow Rea	ection m ad/Write	nemory		

Table 18 - Control Register (CR) Bits (continued)

ZL50018

15	14	000 _H 13	12	2	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0		0	0	0	STIO_ PD_EN	BDH	BDL	RBER EN	TBER EN	BPD 2	BPD 1	BPD 0	MBPS
			1					1	I					I		
Bit		Name								Descr	iption					
15 - 9	l	Jnused	I	Res	serve	ed. In	norma	al functio	nal moo	de, thes	e bits N	IUST b	e set t	o zero		
8	S	ΓΙΟ_ΡΕ EN)_	Wh	en th		is low	able , the pull- n, the pul								
7		BDH		Bi-c	direc	tiona	l Con	trol for S	Stream	s 16-31						
								BDH	ST	io16 - 3	81 Oper	ation				
								0	S	Ti16-3	operation 1 are inp 1 are ou	outs				
								1	STi1	5-31 tie	nal oper d low in re bi-dir	ternally				
6		BDL		Bi-o	direc	tiona	l Con	trol for S	Stream	s 0-15						
								BDL	SI	'io0 - 1	5 Opera	ation				
								0		STi0-15	operatio are inp are out	uts				
								1	STiC	-15 tied	nal oper d low int e bi-dire	ernally				
5	R	BERE	N	Wh	en th	eceiv iis bit IUST	is low	, all the E	BER rec	eivers a	are disa	bled. To	o enat	ole any	BER	receiver
4	Т	BEREN	N	Wh	en tl	nis bi	t is lo	Enable ow, all th MUST b			nitters a	are dis	abled.	To e	nable	any BE
3 - 1	B	PD2 - (0	tion MB to h Mer	mer PE b nigh, mory	nory, it in th the co Low.	whene ne Co ontent Bits 1	ng Data ⁻ ever the ntrol Reg s of the l 5 - 3 of t eroed.	memory jister is bits BPI	/ block set to h D2 - 0 a	progran nigh and are load	nming f d the M led into	eature BPS b bits 2	is act it in th - 0 of	ivated is regi the C	. After th ster is s onnectio

Table 19 - Internal Mode Selection Register (IMS) Bits

0	0	<u>^</u>			10	9	8	7	6	5	4	3	2	1	0
		0	0	0	0	0	STIO_ PD_EN	BDH	BDL	RBER EN	TBER EN	BPD 2	BPD 1	BPD 0	MBPS
Bit	r	Name							Descr	iption					
0	Ν	MBPS	A N C f is is V f	A zero f MBPS a Dnce th rames shed, th s high, Wheney unctior	to one and BF ne MB to cor he MB MBPS ver the n is sta	trans PD2 - PE binnplete PS bin or M or M or micr rted.	ogrammi ition of th 0 bits in it in the the block t returns BPE can oprocess As long a its in this	his bit st this reg Control ck prog to low, i be set sor write as this b	arts the lister mi Regist rammin ndicatir to low t es a one bit is hig	ust be o er is se g. After ng the o o abort e to the h, the u	defined et to hi the pro peration the pro MBPS user mu	in the gh, the ogram n is co gramr b bit, the st main	same e devi iming f implete ning o he bloo intain f	write ce rec functio ed. Wh peratic ck pro the sa	operatio quires t n has t nen MB on. grammi me logi



	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	SRST SW	SRST DPLL	
					Description												
Bit	t	Nar	ne		Description												
15 -	2	Unu	sed	Res	erved	. In no	rmal fu	unctior	nal mo	de, the	se bit	s MUS	T be s	set to z	zero.		
1		SRST	rsw	Whe high Refe	en this , data er to	switch	low, d ing blo 17, "Ac	ata sv ocks a ddress	vitchin re in s Map	oftware for Re	e reset	t state.		-		en this 2 for de	
0		SRST	DPLL			Reset s bit is			_	ck is in	norm	al ope	ration.	Wher	n this bi	t is high	n. th

Table 20 - Software Reset Register (SRR) Bits

			Addres	s: 0003 _H											
Reset \	value. 14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	FPOF2 EN	, FPOF1 EN	FPOF0 EN	CKO5 EN	CKO4 EN	CKO FPO3 EN	CKO FPO2 EN	CKO FPO1 EN	CKO FPO0 EN
Bit		Nam	е						Descr	iption					
15 - 9		Unuse	ed	Rese	rved. I	n norr	nal funct	ional mo	ode, thes	e bits N	IUST be	e set to	zero.		
8	F	FPOF2	2EN	When	this b	it is hi	Enable gh, outpu w, outpu	ut frame t frame p	pulse Ff pulse FP	Po_OFF o_OFF2	-2/FPo5 2/FPo5	is ena is in hię	bled. gh impe	edance	state.
7	F	FPOF1	EN	When	OFF1 this b this b	it is hi	gh, outp	ut frame t frame p	pulse FF oulse FP	Po_OFF o_OFF	-1 is en 1 is in h	abled. igh imp	edance	e state.	
6	F	FPOFO)EN	When	OFF0 this b this b	it is hi	ah, outp	ut frame t frame p	pulse FF oulse FP	Po_OFF o_OFF(-0 is en) is in h	abled. igh imp	edance	e state.	
5		CKO5	EN	When	this b this b	it is hi it is lo	w, outpu	t clock C	CKo5 is Ko5 is ir or in Sla	ו high ir	npedan	ce stat	e. PLLEN	set.	
4		CKO4	EN	When When	this b	it is hi it is lo	w, outpu	t clock C	CKo4 is Ko4 is ir or in Sla	high ir	npedan	ce stat	e. PLLEN	set.	
3	(CKOFF EN		When	this b	oit is h	E nable iigh, outp w, CKo3	out clock and FP	c CKo3 a o3 are in	and out high im	out fran Ipedano	ne puls ce state	e FPo:	3 are e	nable
2	(CKOFF EN		When	this b	oit is h	E nable igh, outp w, CKo2	out clock and FPo	c CKo2 a o2 are in	and out high im	out fran	ne puls ce state	e FPoź	2 are e	nableo
1	(CKOFF EN		When	this b	oit is h			CKo1 a c1 are in					1 are e	nable
0	(CKOFF EN		When	this t	oit is h	E nable igh, outp w, CKo0	out clock and FPo	c CKo0 a o0 are in	and out high im	out fran	ne puls ce state	e FPo() are e	nable

Table 21 - Output Clock and Frame Pulse Control Register (OCFCR) Bits

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CKO4 P	CKO4 SEL	CKO FPO3 SEL1	CKO FPO3 SEL0	B P	FPO3 P	FPO3 POS	CKO2 P	FPO2 P	FPO2 POS	CKO1 P	FPO1 P	FPO1 POS	CKO0 P	FPO0 P	FPO0 POS
Bit		Name							Descrij	ption					
15		CKO4P		Output (When th boundary frame bo CKo4 is	is bit /. Whe undary	is low, n this l	the or bit is hi	utput c gh, the	lock C outpu	t clock	CKo4	rising	edge a	ligns w	
14	С	KO4SE	,	Output (When thi When thi CKo4 is	s bit is s bit is	low, the high, the	e outpu ne outpi	t clock ut clock	CKo4 i CKo4	s 2.048 is 1.54	4 MHz.		LLEN s	set.	
13 - 12		KOFPC SEL1 - (Output Selectio		(CKo3)) Frequ	iency a	and Ou	utput F	rame I	Pulse	(FPo3)	Pulse	Cycle
							-PO3 1 - 0		FPo3		С	Ko3			
						0	0		244 ns	;	4.09	6 MHz			
						0	1		122 ns	5	8.19	2 MHz			
						1	0		61 ns		16.38	34 MHz	2		
						1	1		30 ns		32.76	68 MHz	2		
11		CKO3P	, , ,	Output (When th boundary frame bo	is bit /. Whe	is low, n this l	the o	utput c	lock C						
10		FPO3P	,	Output F When thi When thi	s bit is	low, the	e output	t frame	pulse F	Po3 ha					
	F	PO3PO	,	Output F When thi When thi	s bit is	low, FF	Po3 stra	ddles f	rame b					,).
9				Output 0			Polarit		lock C	Ko2 fa		dge ali	igns wi		frame
9		CKO2P		When the boundary frame bo	. Whe	n this I		gh, the	outpu	t clock	CKo2	rising	edge a	ligns w	ith the

Table 22 - Output Clock and Frame Pulse Selection Register (OCFSR) Bits

		000 _H													
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CKO4 P	CKO4 SEL	CKO FPO3 SEL1	CKO FPO3 SEL0	CKO3 P	FPO3 P	FPO3 POS	CKO2 P	FPO2 P	FPO2 POS	CKO1 P	FPO1 P	FPO1 POS	CKO0 P	FPO0 P	FPO0 POS
Bit		Name							Descrij	ption					
6	F	FPO2POSOutput Frame Pulse (FPo2) Position When this bit is low, FPo2 straddles frame boundary (as defined by ST-BUS). When this bit is high, FPo2 starts from frame boundary (as defined by GCI-Bus).CKO1POutput Clock (CKo1) Polarity Selection													
5		CKO1P	V b	utput (/hen th oundary ame bo	is bit /. Whei	is low, n this l	the o	utput c	lock C		•	•	•		
4		FPO1P	V	utput F /hen thi /hen thi	s bit is	low, the	e output	frame	pulse F	Po1 ha					
3	F	PO1PO	V	utput F /hen thi /hen thi	s bit is	low, FF	Po1 stra	ddles f	rame b						
2		CKO0P	V b	utput (/hen th oundary ame bo	is bit /. Whei	is low, n this l	the o	utput c	lock C						
1		FPO0P	V	output F /hen thi /hen thi	s bit is	low, the	e output	frame	pulse F	Po0 ha					
0	F	PO0PO		utput F					n Trame b	oundar	v (as d	efined	hv ST-F	SUS)	

Table 22 - Output Clock and Frame Pulse Selection Register (OCFSR) Bits (continued)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
0	0	0	0	0	FP19 EN	FOF[n] OFF7	FOF[n] OFF6	FOF[n] OFF5	FOF[n] OFF4	FOF[n] OFF3	FOF[n] OFF2	FOF[n] OFF1	FOF[n] OFF0	FOF[n] C1	FOF[n] C0		
Bit		Nar	ne						De	scripti	on						
15 - 11		Unu	sed	F	Reserved. In normal functional mode, these bits MUST be set to zero.												
				1 V	9.44MH Vhen th	his bit is a reserved bit for FPo_OFF0 and FPo_OFF1, and MUST be set to zero hen this bit is high, FPo_OFF2 is negative frame pulse output corresponding 0.44MHz without channel offset. hen this bit is low, FPo_OFF2 is output frame pulse with channel offset.											
9 - 2	FC)F[n]O	FF7 -	1 V 0 F T	9.44MH Vhen th Po_OF The bina	Iz witho is bit is l F[n] Ch iry value	low, FF nannel e of the	Po_OFF2 Offset ese bits i	2 is outport	the ch	annel of	fset fror	nnel offs n origina register.		e bound		
9 - 2 1 - 0)F[n]O		1 V 0 F T a	9.44MH Vhen th Po_OF The bina ry. Perr	Iz witho is bit is l F[n] Ch iry value	low, FF nannel e of the nannel	Po_OFF2 Offset ese bits i offset va	2 is outport	the ch	annel of	fset fror	n origina		e boun		
				1 V 0 F 1 a	9.44MH Vhen th Po_OF The bina ry. Perr	Iz witho is bit is I F[n] Ch rry value nitted ch F[n] Co Data	low, FF nannel e of the nannel	Po_OFF2 Offset ese bits i offset va bits.	2 is outport	the ch bend or	annel of	fset fror) of this DFF7 - 0 itted	n origina	I frame	e bound osition		
				1 V 0 F 1 a	9.44MH Vhen th Po_OF he bina ry. Perr Po_OF	Iz witho is bit is I F[n] Ch nitted ch F[n] Co Data (Mi	low, FF nannel e of the nannel ontrol t	Po_OFF2 Offset ese bits i offset va pits.	2 is outport refers to alues dep o OFF[n]	the ch bend or	annel of n bits 1-(FOF[n]C Perm	fset fror) of this PFF7 - 0 itted I Offset	n origina register. Polarit	I frame	osition		
				1 V 0 F 1 a	9.44MH Vhen th Po_OF he bina ry. Perr Po_OF FOF[n](0 1-0	Iz witho is bit is I F[n] Ch rry value nitted ch F[n] Co C Data (Mi 2.0	low, FF nannel e of the nannel pontrol k Nate bps)	Po_OFF2 Offset ese bits i offset va Dits. FPG Pulse one 4.0	2 is outpo refers to alues dep o_OFF[n Cycle Wi	the ch bend or dth clock	annel of n bits 1-(FOF[n]C Perm Channe	fset fror) of this DFF7 - 0 itted I Offset 31	n origina register. Polarit Contro	I frame	osition ontrol		
				1 V 0 F 1 a	9.44MH Vhen th Po_OF The bina ry. Perr Po_OF FOF[n]0 1-0	Iz witho is bit is I F[n] Ch nitted ch F[n] Co Data (Mi 2.0 4.0	low, FF nannel e of the nannel pontrol t bps) 048	Po_OFF2 Offset ese bits i offset va pits. Pulse one 4.0 one 8.1	2 is outpo refers to alues dep o_OFF[n Cycle Wi 96 MHz o	the ch bend or dth clock	annel of n bits 1-(FOF[n]C Perm Channe 0 -	fset fror) of this DFF7 - 0 itted I Offset 31 63	n origina register. Polarit Contro FPO0F	I frame	osition control O0POS		

Table 23 - FPo_OFF[n] Register (FPo_OFF[n]) Bits

	Read Addr lue: 0000 _H		10 _H													
	15	14	13	12 11	10	9	8	7	6	5	4	3	2	1	0	
	0	0	0	0 0	0	0	0	0	0	0	0	0	0	OUT ERR	IN ERR]
Bit	Nar	ne		Description												
15 - 2	Unu	sed		Description Reserved n normal functional mode, these bits are zero.												
1	OUT	ERR	Thi mo the	re than maxim	set hi the m um ca	igh w iaxim pacit	hen f um ca y sho	the to apacit uld be	y of 2 disa	048, bled.	in wh	ich c	ase th		it chann	nmed to be aels beyond
0	INE	RR	Thi tha ma	n the r	set hig naxim capac	ih wh um c ity sh	en the apaci iould	ty of	2048,	in w	/hich	case	the i	nput ch	annels	to be more beyond the ly after pro-

Table 24 - Internal Flag Register (IFR) Bits - Read Only

		Read Add lue: 0000		0011 _H													
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
1	BER F15	BER F14	BER F13	BER F12	BER F11	BER F10	BER F9	BER F8	BER F7	BER F6	BER F5	BER F4	BER F3	BER F2	BER F1	BER F0	
Bit	t	Nan	ne						[Descri	ption						
15 -	0	BERF	[n]	If BE zero.	RF[n] i		it indi		hat BE at BEF				0	`	-	-/	
Nata	[n] do	enotes in	out etro	am from	0 15												

Table 25 - BER Error Flag Register 0 (BERFR0) Bits - Read Only

	al Read/Writ /alue: 0000		ess: 0001	2 _H											
1	5 14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
BE F3		BER F29	BER F28	BER F27	BER F26	BER F25	BER F24	BER F23	BER F22	BER F21	BER F20	BER F19	BER F18	BER F17	BER F16
Bit	Nam	ıe						[Descri	ption					
Bit 15 - 0	Nan BERF		lf BEI zero.		s high,	it indi		hat BE	R Rec	ption eiver E		C	`	-	-/

Table 26 - BER Error Flag Register 1 (BERFR1) Bits - Read Only

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	BER L15	BER L14	BER L13	BER L12	BER L11	BER L10	BER L9	BER L8	BER L7	BER L6	BER L5	BER L4	BER L3	BER L2	BER L1	BER L0
Bi	t	Nam	1e						[Descri	ption					

Table 27 - BER Receiver Lock Register 0 (BERLR0) Bits - Read Only

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	BER L31	BER L30	BER L29	BER L28	BER L27	BER L26	BER L25	BER L24	BER L23	BER L22	BER L21	BER L20	BER L19	BER L18	BER L17	BER L16
Bi	t	Nam	ne							Descri	ption					

Table 28 - BER Receiver Lock Register 1 (BERLR1) Bits - Read Only

		••													
15	14	4 13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	LIN_ RES	SM_ FST	0	SWF	SWE	MRLE	RFRE	DPLL _IRM
Bit	:	Name		Description Reserved. In normal functional mode, these bits MUST be set to zero.											
15-8	8	Unused	Res	served	. In nor	mal fur	nctiona	I mode,	these	bits M	JST be	set to z	ero.		
7		LIN_RES	mul tran Whe tran regi	tiplicat sfer as en this sfer ch ster).	ion will s per B bit is naracte	be use WCR re low, no ristics.	ed to de egister on-linea (Only l	eterming for sma ar phase high jitte	e the jit all and l e multip er ampli	ter trai arge ji plicatio itudes	nsfer ch tter amp n will be	aracteri olitude). e used ne jitter	is high, stics. (F to deter transfer	ollow th mine th	ne jitte ne jitte
6		SM_FST	ena use Whe	bled, a d even en this	allowing i if the I bit is l	g the F DPLL s low, the	ast Fre lew rat e FFL3	equency te limite	/ Lock r is not s in the	(FFL3 bypas e BWC	- 0) bits sed.	s in the	i-fast lo BWCR ignored	registe	r to be
							511011	rogioto		001.					

Table 29 - DPLL Control Register (DPLLCR) Bits

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	LIN_ RES	SM_ FST	0	SWF	SWE	MRLE	RFRE	DPLL _IRM
Bit		Name							Descri	ption					
4		SWF	DP slov of S res Wh fast of Sof pha ver	LL is in w contr Softwar ponse : en this contro Softwa tware ise alig y frequ	a freeru ol mode and pha bit is h ol mode re Del Delta l gnment ent upo	n mode e is ena a Frequ ase aliq igh, the e is ena ta Fre Freque speed lating c	e (the F abled. Jency I gnmen e SWE abled. quency ncy R (phase of the S	DM1 - The DP Register t speed bit is h The DP (Regis egister, e slope) WDFR	0 bits o LL outp r (SWD (phase igh, and LL outp ster (S theref) limiter registe	of the R puts will DFR), a slope d the D puts wi WDFR fore all ore all rs to be er.	CCR re I stabiliz ffter pro) time. DPLL is II reach), imme owing e used.	egister a ze to de gramme in freeru the del ediately externa This ca	E bit is are ='11' Ita frequ ed inter un mode ta frequ after I softwa se will u	i), the se uency ce nal DPI e, the se uency ce writing are filte usually	oftware ontents L filte oftware ontents to the rs and
3		SWE	(SV bit mea out	VDFR) is high aning t put free	conten and f hat the quency,	it is ign he DP Softwa depen	ored a LL is are Del iding o	nd the s in freer ta Frequ	softwar run mo uency F alue of S	e mod de, the Registe SWF b	e of the e DPLL er contentit it of this	DPLL i softwant is use	ta Frequ is disab are moo ed to co er.	led. Wh de is e	ien thi nabled
2		MRLE	igno set reg follo	ored ar up the isters o owing	nd the S e DPLL content register	Stratum .'s refe s are i rs are	3 defa rence used to affecte	ault valu monitor o contro ed: RnU	ie for ea ring fur ol the i ILR, Ri	ach de nctions monito nLLR,	tected r . When ring fun RnMPC	eferenc this bi ictionali CRL, Rr	hitor reg e freque t is hig ty of th MPCR LRL, MI	ency is the the the device b, the the the device b, MPN	used to monito e. The IULRL
1		RFRE	valu	ue useo is high	d in the	DPLL	comes	from a	opropria	ate refe	erence f	requen	e refere cy deteo e Frequ	ctor. Wh	nen thi
0		DPLL_ IRM		LL Inte									le is in t		

Table 29 - DPLL Control Register (DPLLCR) Bits (continued)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	R3F2	R3F1	R3F0	R2F2	R2F1	R2F0	R1F2	R1F1	R1F0	R0F2	R0F1	R0F0
		II			I										I
			1												
Bit	Ν	ame						D	escrip	otion					
15-12	Ur	lused		erved											
			In no	ormal fu	Inction	al mode	e, these	bits M	UST b	e set to	zero.				
11 - 9	R3	F2 - 0		erence				~ -							
							he DPLL hen the							d to se	lect th
						R3F2	R3F1	-	F0		Input F				
						0	0	()		8 kHz		,		
						0	0		1		1.544 N	lHz			
						0	1	()		2.048 N	1Hz			
						0	1		1		4.096 N	lHz			
						1	0	()		8.192 N				
						1	0		1		16.384 N				
						1	1	(19.44 N				
						1	1		1		Reserv	ed			
8 - 6	R2	F2 - 0		erence:			Bits he DPLL	CR re	aister	is hiah	these	hits a	re liser	t to se	lect th
							hen the								
						R2F2	R2F1	R2	F0	REF 2	Input F	requen	су		
						0	0	()		8 kHz	<u>z</u>			
						0	0		1		1.544 N	1Hz			
						0	1	()		2.048 N	1Hz			
						0	1		1		4.096 N				
						1	0)		8.192 N				
						1	0	-	1		16.384 N	ЛНz			
						1	1	-)		19.44 N				

Table 30 - Reference Frequency Register (RFR) Bits

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	R3F2	R3F1	R3F0	R2F2	R2F1	R2F0	R1F2	R1F1	R1F0	R0F2	R0F1	R0F0
Bit	N	ame						D	escrip	tion					
5 - 3	R1	F2 - 0	Whe		RFRE	bit of th	Bits ne DPLL hen the							d to se	lect th
						R1F2	R1F1	R1	F0	REF 1	Input F	requenc	cy (
						0	0	()		8 kHz	Z			
						0	0	-	1		1.544 N	1Hz			
						0	1	()		2.048 N	1Hz			
						0	1		1		4.096 N	1Hz			
						1	0	()		8.192 N				
						1	0	-	1		16.384 N	MHz			
						1	1)		19.44 N				
						1	1		1		Reserv	ed			
2 - 0	R0	F2 - 0	Whe		RFRE	bit of th	Bits ne DPLL hen the							d to se	lect th
						R0F2	R0F1	R0	F0	REF 0	Input F	requenc	су		
						0	0	()		8 kHz	Z			
						0	0		1		1.544 N	1Hz			
						0	1	()		2.048 N	1Hz			
						0	1		1		4.096 N				
						1	0	()		8.192 N				
	1					1	0		1		16.384 N				
						. —			`		40 44 1		1		
						1	1	(1		19.44 N	IHZ			

Table 30 - Reference Frequency Register (RFR) Bits (continued)

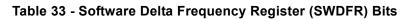
External F Reset Val			ess: 004	2 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CFN 15	CFN 14	CFN 13	CFN 12	CFN 11	CFN 10	CFN 9	CFN 8	CFN 7	CFN 6	CFN 5	CFN 4	CFN 3	CFN 2	CFN 1	CFN 0
Bit	Na	ame						D	escrip	tion					
15 - 0	CFN	115 - 0	and t		RU regi		•	-				-		of thes cording	e bits g to the
								four	$= \frac{\text{CFN}}{2^{26}}$	× fmclk					
			clock	. For gi	ven ma	aster cl		quency	of 100						master quency
					CFN =	2 ²⁶ ×	65.536N 100MI	$\frac{1}{1}$ =	$2^{26} \times 0.$	65536	= 43980	465 = 2	29F16B	1н	
			cryst	al) freq	uency	offset is	s requir	ed.						cillator	
			•			•	ency is N shoul			•		lz -> 5	times r	nultiplie	ed c20i
				С	FN = 2	$\frac{26}{26} \times \frac{68}{10}$	5.536MI 0.002M	$\frac{Hz}{Hz} = 2$	²⁶ × 0.6	553468	9 = 439	979585 -	= 29F13	341н	
			The	default	value o	of this r	egister	SHOU	LD NO	T be cl	nanged	in any	other of	circums	tances.

Table 31 - Centre Frequency Register - Lower 16 Bits (CFRL)

External Reset Val		rite Addre F _H	ss: 0043	3 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	CFN 25	CFN 24	CFN 23	CFN 22	CFN 21	CFN 20	CFN 19	CFN 18	CFN 17	CFN 16
Bit	Na	ame						[)escrip	otion					
15 - 10	Un	used	Rese	erved.	In norr	mal fun	ctional	mode,	these b	oits MU	ST be :	set to z	ero.		
9 - 0	CFN	25 - 16	The quen The lator	total b icy nur default	inary v nber ((value vstal) fro	alue of CFN) ex of this	kplained register	bits and d under should	I the C CFRL I be ch	FRL reg registe anged	er bits e only if (xplana	tion. sation	for inp	nter fre- ut oscil- ny other



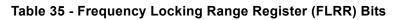
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	SDF 14	SDF 13	SDF 12	SDF 11	SDF 10	SDF 9	SDF 8	SDF 7	SDF 6	SDF 5	SDF 4	SDF 3	SDF 2	SDF 1	SDF 0
Bit	N	lame						0	Descrip	otion					
15	U	nused	Res	served	. In nor	mal fur	octional	mode,	this bit	MUST	be set	to zero	0.		
14 - 0	SD	F14 - 0	anc bina cen the alig or t	l the DF ary valu ter frec deviati nment he DPL	PLL is i ue of th uency on will speed .L is no	n freeru ese bits (delta f be met (phase t in free	un mod s repre- requen immec slope) erun mo	le (the l sents th icy). De liately c time. V ode, the	FDM1-(ne targe pendin or after Vhen th ese bits	SWE bit o bits o eted de ig on th progra ne SWE s are ig olemen	f the R viation e SWF mmed bit in nored.	CCR re of the bit in t filter re the DP	egister a DPLL c he DPL sponse	are ='1 output f LCR r and p	1'), th from it egiste hase



15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	FOF 14	FOF 13	FOF 12	FOF 11	FOF 10	FOF 9	FOF 8	FOF 7	FOF 6	FOF 5	FOF 4	FOF 3	FOF 2	FOF 1	FOF 0
Bit	N	ame		Description											
15	Ur	used	Rese	erved.	n norm	nal func	tional r	node, t	his bit i	s zero.					
14 - 0	FOF	-14 - 0	of the comp In the	e DPLL blemen e softwa	output t forma are fas	Bits: T from it t. t mode gnment	s cente these l	er frequ bits do	ency. E not rep	Defined resent	in sam frequer	e units	as CF	N in the	e 2's



	External Read/Write Address: 0046 _H Reset Value: 0370 _H (see Note)														
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	FLR 13	FLR 12	FLR 11	FLR 10	FLR 9	FLR 8	FLR 7	FLR 6	FLR 5	FLR 4	FLR 3	FLR 2	FLR 1	FLR 0
Bit	Name		Description												
15 - 14	Unused		Reserved. In normal functional mode, these bits MUST be set to zero.												
13 - 0	13 - 0FLR13 - 0Frequency Lock Range Bits: If not in the limiter bypass mode, the binary value of these bits defines the maximum allowed deviation of the DPLL output from its center frequency. If the DPLL limiter bypass is set in the Bandwidth Control Register, the DPLL output fre- quency can exceed the value specified by these bits, since the proportional value of ref- erence-to-feedback difference is predominant to the integration value in that case. Defined in same units as CFN (unsigned).														
Note: The	defau	lt value is	s ±20 pp	om ('h03	70/CFN	= 20 ppi	m).								



15	14	13	12	12 11 10 9 8 7 6 5 4 3 2 1 0											0
LDT 15	LDT 14	LDT 13	LDT 12	LDT 11	LDT 10	LDT 9	LDT 8	LDT 7	LDT 6	LDT 5	LDT 4	LDT 3	LDT 2	LDT 1	LDT 0
							I					I			
Bit	N	ame		Description											
	 15 - 0 LDT15 - 0 Lock Detect Threshold Bits The binary value of these bits defines the upper limit of the absolute phase for phase detector output for lock detection. When the value of the absolute phase is less than or equal to LDT for duration or defined by the LDIR register, the DPLL locks. When the value of the absolute phase is greater than LDT for duration of time detector the LDIR register divided by 256, the DPLL does not lock. 										ation of	time			
Note: Ll using th				ited as			num ex <u>X_EXF</u> 15.2	IITTE		-	itter on	the ac	tive inp	out refe	rence

Table 36 - Lock Detector Threshold Register (LDTR) Bits

	External Read/Write Address: 0048 _H Reset Value: 2C00 _H														
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
LDI 15	LDI 14	LDI 13	LDI 12	LDI 11	LDI 10	LDI 9	LDI 8	LDI 7	LDI 6	LDI 5	LDI 4	LDI 3	LDI 2	LDI 1	LDI 0
Bit	Name		Description												
	N	ame							coonp						

Table 37 - Lock Detector Interval Register (LDIR) Bits

External F Reset Val				9 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	SRL 12	SRL 11	SRL 10	SRL 9	SRL 8	SRL 7	SRL 6	SRL 5	SRL 4	SRL 3	SRL 2	SRL 1	SRL 0
Bit	Na	ame						D	escrip	tion					
15 - 13	Un	used	Rese	erved.	n norm	nal func	tional r	node, t	hese bi	ts MUS	ST be s	et to ze	ero.		
12 - 0	SRL	.12 - 0	phas	e chan	ge (ph	ase slo		nere th	e phase	e repre	sents o	differen	ce betv	veen th	of DPLL ne input

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	BLM	FLF_ QS	FLC 3	FLC 2	FLC 1	FLC 0	FFL 3	FFL 2	FFL 1	FFL 0	LPF 3	LPF 2	LPF 1	LPF 0
Bit	N	ame		Description Reserved. In normal functional mode, these bits MUST be set to zero. Bypass Limiter Bit: When this bit is high, the DPLL slew rate limiter is bypassed											
15 - 14	Ur	nused	Rese												
			lockii Whe	ng of th n this b	ie DPL bit is lov	L outpu w, the [ut clock	s to the erform	select	- 0, FFL ed refe al lock	rence.				
12	FL	F_QS	interr Whei value Whei	nal freq n this b e, allow n this b	uency hit is hig ing ver it is lov	stabiliz gh, the y fast s v, the in	ation. DPLL i storage iternal f	nternal of hold requer	freque over fre cy valu	Bit: Th ncy will equence le will b	l quickl y value e reac	y stabil e. ned ove	ize to t er norm	he app al locki	ropriate
			İt is r		nended	to set		if fast l	ocking	functio				u.	

Table 39 - Bandwidth Control Register (BWCR) Bits

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15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	BLM	FLF_ QS	FLC 3	FLC 2	FLC 1	FLC 0	FFL 3	FFL 2	FFL 1	FFL 0	LPF 3	LPF 2	LPF 1	LPF 0
Bit	N	ame						D	escrip	tion					
7 - 4		L3 - 0	bit in spee spee outpu Whe	the D d of th d grac ut freq n both	PLLCR e DPLL le that uency. the BLI	registe output interna The big M and t	er is hig t clocks I frequ ger the the SM	gh, valu s to the ency va e value, _FST b	e of the active i lue, us the fas its are	ese bit input r sed in ster the low, th	is regis s (unsig eferenc holdove locking nese bits	ned) re e. The er mod g. are ig	epreser value a e, reac nored.	nts fast also rep ches the	lockir resen
3 - 0	LP	F3 - 0	Low	Pass	Filter C	ontrol	Bits: [Define t	ne DPL	L low	pass fill	er corr	ner freq	uency.	
					LPF3	LP	F2	LPF1	LPF	=0		R FREG	UENCY TER	OF	
					0	C)	0	0			0.47 ⊦	lz		
					0	C		0	1			0.95 H			
					0	C		1	0			1.9 H			
				_	0	0		1	1			3.8 H			
				-	0	1		0	0			7.6 H			
				-	0	1		1	0			30.4 F			
				-	0	1		1	1			60.7 F			
					1	C		0	0			121 H			
				_	1	C)	0	1			243 H	z		
					1	C)	1	0			486 H	z		
					1	C)	1	1			971 H	z		
					1	1		0	0			1.94 kl	Ηz		
					1	1		0	1			3.88 kl	Ηz		
					1	1		1	0			7.77 kl	Ηz		
					1	1		1	1			15.54 k	Hz		
ote 1:	The de	efault con	l ner fregu	Jency (-3 dB poi	nt) of the	e low na	iss filter i	s 1.9 Hz	<u>.</u>					
ote 2:	To set LPF3-(FFL3-(fast lock) ->'h8, u) ->'hF 0 ->'hF, if)S -> 1	mode, i inless a	t is reco specific	ommende filter res ount of jit	ed to pro sponse (gram th Iow pas	e registe s filter ch	r bits as aracteri	follows stic) is	required				
ote 3:	In fast	lock mod			nt that the generate			lso in fre	erun mo	de (see	e the RC0	CR Regi	ster). Ot	herwise,	the
ote 4:	If the s	elected r	eference OHz (i e	e is 8 kl	Hz, LPF3 PF3 - 0 s	- 0 shou	uld not b	e chose	n to have	e corne maller i	r frequen than 1010	cy highe	er than 1	/10 of th	e carrie

Table 39 - Bandwidth Control Register (BWCR) Bits (continued)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	MTR	PRS 1	PRS 0	PMS 2	PMS 1	PMS 0	FDM 1	FDM 0
Bit	N	ame						C)escrip	tion					
15 - 8	Un	used	Rese	erved.	In norr	nal fund	tional	mode, t	these b	its MUS	ST be s	et to ze	ero.		
7	N	1TR	refere main value	ence tained e is res	input o I. Wher	en this clock a this bi ero, cau erence.	nd the t is hig	e DPLL jh, MTI	. outpu E circui	ut cloci it is in i	k and its rese	the pl t state	hase c and th	offset v e phase	alue e offs
6 - 5	PR	S1 - 0	of the	e input		n ce Se l nces. T pred.									
						PRS1	F	PRS0	PREF	ERRED SELEC		NCE			
						0		0		RE	=0				
						0		1		RE	=1				
						1		0		RE					
						1		1		RE	=3				
4 - 2	PM	S2 - 0	Prefe	erence	e Mode	Select	ion Bi	ts: The	se bits	select	one of t	he pref	ference	modes	8:
					PMS2	PN	/IS1	PMS0		PREFE	RENCE	MODE			
				F	0		0	0		No	Preferer	nce			
					0		0	1	Pre	eference the	as per th PRS1 - 0		g of		
					0		1	0			orce REF				
					0		1	1			orce REF				
				_	1		0	0			orce REF				
					1		0	1			orce REF				
				L		110	- 111				Reserved	t i			
						de with achine v	•			•					

Table 40 - Reference Change Control Register (RCCR) Bits

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0					
0	0	0	0	0	0	0	0	MTR	PRS 1	PRS 0	PMS 2	PMS 1	PMS 0	FDM 1	FDM 0					
Bit	N	ame		Description																
1 - 0	FDI	VI1 - 0			L Timi	ing Mo	ode: Th	Description rce DPLL Timing Mode: These bits force the DPLL into one of the valid timing												
			mode	es.																
			mode	es.	F	DM1	FDM	D	DPLL	TIMING	MODE									
			mode	es.	F	DM1 0	FDM	D		TIMING Automat										
			mode	es.	F			0			c									
			mode	es.	F	0	0	0		Automat	ic									

Table 40 - Reference Change Control Register (RCCR) Bits (continued)

Externa	al Read	Only Add	ress: 00	4C _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	SLM	LST	RFR2	RFR1	RFR0	RES1	RES0	DPM1	DPM0
				Description											
Bit	N	ame		Description											
15 - 9	Ur	nused	Res	erved.	In norn	nal fund	ctional	mode,	these b	its are	zero.				
8	ę	SLM	diffe	rence b	betwee		put an	d outpu	it clock				-		phase defined
7	I	_ST	prog	ramme	ed prop	erly, the	DPLL	output	clocks	are loc	ked to t	the sele	ected in	put refe	ters are erence. erence.

Table 41 - Reference Change Status Register (RCSR) Bits - Read Only

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											_		-			
15	14	13	12	11	10	9		7			5	4	3	2	1	0
0	0	0	0	0	0	0	SLM	1 LST	RFF	R2	RFR1	RFR0	RES1	RES0	DPM1	DPM0
Bit	N	lame							Desc	ripti	ion					
6 - 4	RF	R2 - 0					y Indic cated b								quency er.	of the
					RFF	R2	RFR1	RFR	0	Fre Sele	equer ected	icy of t Refere	he nce			
					0		0	0			81	κHz				
					0		0	1				4 MHz				
					0		1	0				3 MHz				
					0		1	1				6 MHz		_		
					1		0	0				2 MHz 4 MHz		_		
					1		1	0				4 MHz		_		
					1		1	1				erved		-		
3 - 2	RE	S1 - 0					icator is being						ch one	of the	four re	ference
						RES	61 R	ES0	Input	t Ref	ferenc	e in us	e			
						0		0		F	REF 0					
						0		1		F	REF 1					
						1		0			REF 2					
						1		1		F	REF 3					
1 - 0	DP	PM1 - 0	DPL	L Tim	ing M	ode S	tatus B	its: Th	ese bit	s inc	dicate	the DF	PLL's ti	ming m	ode sta	tus.
						DPN	/11 D	PM0	DPLL	Timi	ing M	ode Sta	ate			
						0		0		1	MTIE					
						0		1		N	lorma					
						1		0			oldove					
						1		1		F	reerur	ר ר				

Table 41 - Reference Change Status Register (RCSR) Bits - Read Only (continued)

		/rite Addr 46 _H (Note		.Е _Н											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MNU 15	MNU 14	MNU 13	MNU 12	MNU 11	MNU 10	MNU 9	MNU 8	MNU 7	MNU 6	MNU 5	MNU 4	MNU 3	MNU 2	MNU 1	MNU 0
Bit	N	lame						[Descrip	otion					
15 - 0	MN	U15 - 0	MF refe	NULRI	J regist	ter bits	Upper defines 1. The	the ne	ar uppe	er limit	for the	multiple	e perio	d count	of any
Note 1:	The de value)	efault val , regardie	ue repre ess of th	esents ne le refere	ear uppe nce freq	er limit fo uency.	r all refe	rence fr	equencie	es, whicł	n is +9.9	13 ppm	(Stratum	3 compl	iant
Note 2:	The na	ame 'upp	er' is ba	ised on f	requenc	y.									



External Reset Va		/rite Addi 9A _H (Not		4F _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MNU 31	MNU 30	MNU 29	MNU 28	MNU 27	MNU 26	MNU 25	MNU 24	MNU 23	MNU 22	MNU 21	MNU 20	MNU 19	MNU 18	MNU 17	MNU 16
Bit		Name							Descr	iption					
15 - 0	M	NU31 -		Multipl MPNUI any ref clock p	_RL reo erence	gister b	its defi	nes the	near u	upper li	mit for	the mu	ltiple p	eriod c	ount of
Note 1:				esents ne he refere			r all refe	rence fre	equencie	es, which	n is +9.9	13 ppm	(Stratum	3 comp	liant
Note 2:	The na	ame 'upp	er' is ba	ased on f	requenc	y.									

Table 43 - Multi-period Near Upper Limit Register - Upper 16 Bits (MPNULRU)

		/rite Addr DE8 _H (No		60 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MFU 15	MFU 14	MFU 13	MFU 12	MFU 11	MFU 10	MFU 9	MFU 8	MFU 7	MFU 6	MFU 5	MFU 4	MFU 3	MFU 2	MFU 1	MFU 0
Bit	N	lame						[Descrip	otion					
15 - 0	MF	U15 - 0	MP	FÜLRU	J regist	er bits		the fa	r uppei	r limit f	or the r	nultiple	period	l count	nd the of any z clock
Note 1:		efault valı , regardle					all refere	nce frec	uencies	, which i	s +11.28	7 ppm (Stratum	3 compli	ant
Note 2:	The na	ame 'upp	er' is ba	ised on f	requenc	у.									



External Reset Va				51 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MFU 31	MFU 30	MFU 29	MFU 28	MFU 27	MFU 26	MFU 25	MFU 24	MFU 23	MFU 22	MFU 21	MFU 20	MFU 19	MFU 18	MFU 17	MFU 16
Bit		Name							Descr	iption					
15 - 0	MF	-U31 -	16	Multipl MPFUL referen periods	.RL reg ce inpu	jister bi	ts defin	es the	far upp	er limit	for the	multiple	e perio	d count	of any
Note 1:				esents fa he refere			all refere	nce freq	uencies	, which i	s +11.28	7 ppm (Stratum	3 compli	ant
Note 2:	The na	ame 'upp	oer' is b	ased on f	requenc	у.									

Table 45 - Multi-period Far Upper Limit Register - Upper 16 Bits (MPFULRU)

		Vrite Addro 38 _H (Note		62 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MNL 15	MNL 14	MNL 13	MNL 12	MNL 11	MNL 10	MNL 9	MNL 8	MNL 7	MNL 6	MNL 5	MNL 4	MNL 3	MNL 2	MNL 1	MNL 0
	T														
Bit	١	lame						[Descrip	otion					
15 - 0	MN	IL15 - 0	MF	NLLRI	J regist	er bits	defines	the ne	ar lowe	er limit f	for the	multiple	e perioc	l count	nd the of any z clock
Note 1:		efault val , regardle					r all refe	rence fr	equencie	es, which	n is -9.91	3 ppm (Stratum	3 compl	iant
Note 2:	The na	ame 'lowe	er' is ba	ised on f	requenc	у.									

Table 46 - Multi-period Near Lower Limit Register - Lower 16 Bits (MPNLLRL)

		/rite Addı 39A _H (No)53 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MNL 31	MNL 30	MNL 29	MNL 28	MNL 27	MNL 26	MNL 25	MNL 24	MNL 23	MNL 22	MNL 21	MNL 20	MNL 19	MNL 18	MNL 17	MNL 16
Bit		Name							Descri	ption					
15 - 0	M	NL31 - 1		Multiple MPNLLI any refe clock pe	RL reg erence	ister bit	ts defin	es the	near lo	wer lin	nit for t	he mul	tiple pe	eriod co	ount of
Note 1:				resents n the refere			r all refe	rence fre	equencie	es, which	ı is -9.91	3 ppm (Stratum	3 compli	iant
Note 2:	The na	ame 'low	er' is b	ased on f	requenc	;y.									

Table 47 - Multi-period Near Lower Limit Register - Upper 16 Bits (MPNLLRU)

		Vrite Addr 16 _H (Note		54 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MFL 15	MFL 14	MFL 13	MFL 12	MFL 11	MFL 10	MFL 9	MFL 8	MFL 7	MFL 6	MFL 5	MFL 4	MFL 3	MFL 2	MFL 1	MFL 0
Bit	N	ame							Descri	ption					
15 - 0	MF	L15 - 0	MF ref	PFLLR	J regist	ter bits	define	s the f	ar lowe	er limit '	for the	multip	le perio	od cou	and the nt of any Hz clock
Note 1:		efault vali regardie					all refer	ence fre	quencie	s, which	is -11.2	87 ppm	(Stratun	n 3 com	pliant
					requend										

	nal Read/\ Value: 3E)055 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MFL 31	MFL 30	MFL 29	MFL 28	MFL 27	MFL 26	MFL 25	MFL 24	MFL 23	MFL 22	MFL 21	MFL 20	MFL 19	MFL 18	MFL 17	MFL 16
Bit		Name							Desci	ription					
15 - 0	MF	⁻ L31 - 1	6	MPFLL	RL regi ce inpu	ister bit	s defin	es the	far low	er limit	for the	e multip	le peri	od cou	and the nt of any Hz clock
Note 1				resents fa			all refer	ence fre	quencie	s, which	is -11.2	87 ppm	(Stratun	n 3 comj	oliant
Note 2	The na	ame 'low	er' is b	ased on t	requent	cy.									

Table 49 - Multi-period Far Lower Limit Register - Upper 16 Bits (MPFLLRU)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MC[n] 15	MC[n] 14	MC[n] 13	MC[n] 12	MC[n] 11	MC[n] 10	MC[n] 9	MC[n] 8	MC[n] 7	MC[n] 6	MC[n] 5	MC[n] 4	MC[n] 3	MC[n] 2	MC[n] 1	MC[n] 0
	1														
Bit	N	ame						D	escrip	tion					
15 - 0		n]15 - 0				-	iod Co				•				
	(n =	= 0 - 3)			•		defines ency ch					•	iods to minus		easured
Note 1:	The de	= 0 - 3) fault valuation tim	for th	ne mult	i-perioc	freque	ency ch	eck for	the RE	Fn inp	ut moni	toring,	minus	1.	

Table 50 - Multi-period Count Register - Lower 16 Bits (RnMPCRL) Bits, (n = 0 - 3)

45		001 _H (see			10	0	•	-	0	-		0	0		0
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MC[n] 31	MC[n] 30	MC[n] 29	MC[n] 28	MC[n] 27	MC[n] 26	MC[n] 25	MC[n] 24	MC[n] 23	MC[n] 22	MC[n] 21	MC[n] 20	MC[n] 19	MC[n] 18	MC[n] 17	MC[n] 16
	T														
Bit	N	lame						[Descrip	otion					
15 - 0	-	n]31 - 1		Description Reference n Multi-period Count Bits: Total binary value of these bits and the RnMPCRL register bits defines the number of reference clock periods to be measured											
Note 1:		= 0 - 3)	for	the mu	ulti-perio	od freq	uency o	check fo	or the F	of refere REFn in	ence cle put mo	ock per nitoring	iods to 9, minu	be me s 1 .	
Note 1:	The de	= 0 - 3) efault val vation tim	for ue repre	the mu	ulti-perio	od freq	uency o	check fo	or the F	of refere REFn in	ence cle put mo	ock per nitoring	iods to 9, minu	be me s 1 .	

Table 51 - Multi-period Count Register - Upper 16 Bits (RnMPCRU) Bits, (n = 0 - 3)

		Vrite Ado 4A _H (se			05C _H , 0)60 _H , 00	64 _H								
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
UL[n] 15	UL[n] 14	UL[n] 13	UL[n] 12	UL[n] 11	UL[n] 10	UL[n] 9	UL[n] 8	UL[n] 7	UL[n] 6	UL[n] 5	UL[n] 4	UL[n] 3	UL[n] 2	UL[n] 1	UL[n] 0
			T												
Bit	Na	ame						0	escrip	otion					
15 - 0 Note 1:	(n =	n]15 - 0 0 - 3)	uppe mea	er limit sured i	for the n 100 N	perioc /IHz clo	l of the ock peri	REFn	input,	minus	5 1 . Th	e unit (of the		ines the value is
Note 2:	When t or progr 'h2E4A 'h002B 'h0025 ('h0011 ('h0007 ('h0002 (he MRLI ammed (10UIp-r (0.3UIp- (0.2UIp-r (0.2UIp-r (0.2UIp-r	E bit of I through o of 1.54 p) - if re p) - if ref p) - if ref p) - if ref	DPLLCR the Ref 4 MHz i ference ference ference ference ference	register erence F .e. 6.4 μ frequenc frequence frequence frequence frequence	is low, requences) - if re cy is 1.5 cy is 2.04 cy is 4.09 cy is 8.19 cy is 16.3	these re cy Regis ference 44 MHz 48 MHz 96 MHz 92 MHz 384 MHz	gisters a ter), the frequent	re ignor followin	ed. Dep g values	ending o	n refere	nce freq	uency (d	letected
Note 3:	The nar	ne 'uppe	er' is bas	ed on fr	equency	<u>.</u>									



15	14	35C _H (see 13	12	11	10	9	8	7	6	5	4	3	2	1	0
LL[n] 15	LL[n] 14	LL[n] 13	LL[n] 12	LL[n] 11	LL[n] 10	LL[n] 9	LL[n] 8	, LL[n] 7	LL[n] 6	LL[n] 5	LL[n] 4	LL[n] 3	LL[n] 2	' LL[n] 1	UL[n]
Bit	Na	ame		11 10 9 8 7 6 5 4 3 2 1 0 Description											
15 - 0	LLIn]15 - 0	Refe	Description Reference n Single Period Lower Limit Bits: The binary value of these bits defines the lower limit for the period of the REFn input, minus 1. The unit of the binary value is											
10-0	(n =	0 to 3) ault valu	meas	sured i	n 100 N	/Hz clc	ock peri	ods.	-					binary	value is

Table 53 - Lower Limit Register (RnLLR) Bits, (n = 0 - 3)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	LCI	RCI	HOI	SLI
Bit		Name							Descri	ption					
15 - 4		Unused	d R	eserve	d. In no	ormal fu	Inction	al mode	, these	e bits is	zero.				
3		LCI		ock Ch as chan	-	nterrup	ot Bit:	If the d	evice s	ets this	s bit to	high, tl	he devi	ce lock	statu
2		RCI		eference		-	-	t Bit:	f the c	device	sets th	nis bit t	o high,	, the s	electe
1		HOI		oldove ecovere		-				this bit	to high	n, the d	evice h	nas ente	ered o
0		SLI		lew Ra tatus ha			•					-		device	phas

Table 54 - Interrupt Register (IR) Bits - Read Only

External Reset Va		l/Write Addro 000F _H	ess: 006	87 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	LIM	RIM	HIM	SIM
Bit		Name						D	escrip	tion					
15 - 4	ŀ	Unused	Rese	erved.	In norr	nal fun	ctional	mode,	these	bits ML	JST be	set to	zero.		
3		LIM	Lock inter		rupt N	lask E	Bit: Wh	ien this	s bit is	high,	it mas	ks the	lock s	tatus (change
2		RIM		erence ige inte		ge Inte	rrupt l	Mask B	it: Wh	en this	bit is ł	nigh, it	masks	the ref	ference
1		HIM	Hold inter		nterru	pt Mas	sk Bit:	When	this bit	is high	n, it ma	asks th	e holdo	over er	ntry/exi
0		SIM	Slew inter		Limite	er Intei	rupt N	lask B	it: Whe	en this	bit is ł	nigh, it	masks	the sle	ew rate

Table 55 - Interrupt Mask Register (IMR) Bits

External Reset V		Vrite Addi 100 _H	ress: 000	68 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	ICB 3	ICB 2	ICB 1	ICB 0
Bit		Name							Descri	iption					
15 - 4	ι	Jnused	Re	serve	d. In no	ormal fu	unction	al mod	e, thes	e bits N	NUST	oe set t	o zero.		
3 - 0	ļ	CB3 - 0	со	rrespoi	nding		the Int	errupt	Regist	er (IR). The	Interru	upt Cle	ear Re	lear the gister is to 0.

Table 56 - Interrupt Clear Register (ICR) Bits

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15	14	13		12	11	10	9	8	7	6	5	4	3	2	1	0
R3 FML	R3 FMU	R3 FL		R3 FU	R2 FML	R2 FMU	R2 FL	R2 FU	R1 FML	R1 FMU	R1 FL	R1 FU	R0 FML	R0 FMU	R0 FL	R0 FU
Bit		Nam	e							Descrip	otion					
15		R3FM	1L	in	put REI	=3 fails	the mu		od lowe	nit Fail er limit c						
14		R3FM	IU	in	put RE	EF3 fa	ils the		-period	nit Fail upper ge 47)						
13		R3FI	_	in	put RE	EF3 fa	ils the		e-perio	imit Fa d lower ge 47)						
12		R3FI	J	in	put RE	F3 fa	ils the		e-perioo	imit Fa l uppe ge 47)						
11		R2FM	1L	in	put REI	=2 fails	the mu		od lowe	nit Fail er limit c						
10		R2FM	IU	in	put RE	EF2 fa	ils the		-period	nit Fail upper ge 47)						
9		R2FI	_	in		F2 fails	the si	ngle-pe		imit Fa ver limit						
8		R2FI	J	in		F2 fails	the si	ngle-pe		imit Fa i per limi						
7		R1FM	1L	in	put REI	-1 fails	the mu		od lowe	nit Fail er limit c						•
6		R1FM	IU	in	put RE	EF1 fa	ils the	-	-period	nit Fail upper ge 47)						-
5		R1FI	_	in		F1 fails	the si	ngle-pe		imit Fa ver limit						•

Table 57 - Reference Failure Status Register (RSR) Bits - Read Only

Extern	nal Re	ead Only Add	lress	: 0069 _H												
15	14	13	12	2 11	10	9	8	7	6	5	4	3	2	1	0	
R3 FML	R3 FM		R: Fl		R2 FMU	R2 FL	R2 FU	R1 FML	R1 FMU	R1 FL	R1 FU	R0 FML	R0 FMU	R0 FL	R0 FU	
Bit		Name		Description Reference 1 Single Period Upper Limit Fail Bit: If the device sets this bit to high, the												
4		R1FU		input RE	Reference 1 Single Period Upper Limit Fail Bit: If the device sets this bit to high, the input REF1 fails the single-period upper limit check. (See Table 11, "Values for Single Period Limits" on page 45) Reference 0 Multi-period Lower Limit Fail Bit: If the device sets this bit to high, the input REF0 fails the multi-period lower limit check. (See Table 13, "Default Multi-period Hysteresis Limits" on page 47)											
3		R0FML	-	input RE												
2		R0FMU	J	Reference input RE Multi-per	EF0 fa	ils the	e multi	-period	upper						•	
1		R0FL		Reference input RE Period Li	F0 fails	the si	ngle-pe									
0		R0FU		Reference input RE Period Li	F0 fails	the si	ngle-pe									

Table 57 - Reference Failure Status Register (RSR) Bits - Read Only (continued)

	hal Read/ Value: 0		dress: 00)6A _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R3 MML	R3 MMU	R3 ML	R3 MU	R2 MML	R2 MMU	R2 ML	R2 MU	R1 MML	R1 MMU	R1 ML	R1 MU	R0 MML	R0 MMU	R0 ML	R0 MU

Bit	Name	Description
15	R3MML	Reference 3 Multi-period Lower Limit Mask Bit: When this bit is high, it masks the multi-period lower limit check (or forces pass) for REF3.
14	R3MMU	Reference 3 Multi-period Upper Limit Mask Bit: When this bit is high, it masks the multi-period upper limit check (or forces pass) for REF3.
13	R3ML	Reference 3 Single-period Lower Limit Mask Bit: When this bit is high, it masks the single-period lower limit check (or forces pass) for REF3.
12	R3MU	Reference 3 Single-period Upper Limit Mask Bit: When this bit is high, it masks the single-period upper limit check (or forces pass) for REF3.

Table 58 - Reference Mask Register (RMR) Bits

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15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
R3 MML	R3 MMU	R3 ML	R3 ML		R2 MMU	R2 ML	R2 MU	R1 MML	R1 MMU	R1 ML	R1 MU	R0 MML	R0 MMU	R0 ML	R0 MU	
Bit		Name	9						Descri	ption						
11		R2MM	IL	Referen multi-per								this bi	t is high	n, it ma	sks th	
10		R2MM	U	Reference 2 Multi-period Upper Limit Mask Bit: When this bit is high, it masks the multi-period upper limit check (or forces pass) for REF2.												
9		R2MI	-		Reference 2 Single-period Lower Limit Mask Bit: When this bit is high, it masks the single-period lower limit check (or forces pass) for REF2.											
8		R2MU Reference 2 Single-period Upper Limit Mask Bit: When this bit is high, it masks the single-period upper limit check (or forces pass) for REF2.														
7		R1MM	IL	single-period upper limit check (or forces pass) for REF2. Reference 1 Multi-period Lower Limit Mask Bit: When this bit is high, it masks the multi-period lower limit check (or forces pass) for REF1.												
6		R1MM	U	Referen multi-per								this bi	t is high	n, it ma	sks th	
5		R1MI	-	Referen single-pe								n this b	it is higl	n, it ma	sks th	
4		R1M	J	Referen single-pe								n this b	it is higl	n, it ma	sks th	
3		R0MM	IL	 single-period upper limit check (or forces pass) for REF1. Reference 0 Multi-period Lower Limit Mask Bit: When this bit is high, it masks the multi-period lower limit check (or forces pass) for REF0. 												
2		R0MM	ROMMU Reference 0 Multi-period Upper Limit Mask Bit: When this bit is high, it masks the multi-period upper limit check (or forces pass) for REF0.													
1		R0MI	-	Referen single-pe								n this b	it is higl	n, it ma	sks th	
0		R0MU	J	Referen	ce 0 Si	ngle-p	eriod L	Jpper L	imit M	ask Bi	t: Wher	n this b	it is higl	n, it ma	sks th	

Table 58 - Reference Mask Register (RMR) Bits (continued)

External	Read Only Add	ress: 006B _H	I									
15	14 13	12	11 10	98	7	6	5	4	3	2	1	0
0	0 0	0 R	3FS R3FS 2 1	R3FS R2F 0 2		R2FS 0	R1FS 2	R1FS 1	R1FS 0	R0FS 2	R0FS 1	R0FS 0
Bit	Name				D	escrip	tion					
15 - 12	Unused	Reserv	ed. In norm	al function	al mode, tł	nese b	its are	zero.				
11 - 9	R3FS2 - 0	Refere	nce 3 Frequ	iency Stat	us Bits: ⊺	hese b	oits rep	ort dete	cted fre	equenc	y of RE	F3.
			R3FS2	R3FS1	R3FS0	RE	F3 Fre	quency	Measu	iremen	t	
			0	0	0			8 k⊢	z			
			0	0	1			1.544 I	ИНz			
			0	1	0			2.048 I	MHz			
			0	1	1			4.096 I	ИНz			
			1	0	0			8.192 I	ИНz			
			1	0	1			16.384				
			1	1	0			19.44 I				
			1	1	1			Reser	ved			
8 - 6	R2FS2 - 0	Referei	nce 2 Frequ	-	I					-	-	F2.
			R2FS2	R2FS1	R2FS0	RE	F2 Fre	quency		remen	t	
			0	0	0			8 k⊦				
			0	0	1			1.544				
			0	1	0			2.048				
			0	1	1			4.096				
			1	0	0			8.192				
			1	0	1			16.384				
			1	1	0			19.44 M				
			1	1	1			Reser	vea			

Table 59 - Reference Frequency Status Register (RFSR) Bits - Read only

ZL50018

45	14	40	10	44	10	0	0	7	0	-	4	2	0	4	0
15		13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	R3FS 2	R3FS 1	R3FS 0	R2FS 2	R2FS 1	R2FS 0	R1FS 2	R1FS 1	R1FS 0	R0FS 2	R0FS 1	R0FS 0
Bit	N	ame						D	escrip	tion					
5 - 3	R1F	S2 - 0	Refe	rence	1 Frequ	iency S	Statu	s Bits: ⊺	hese b	oits rep	ort dete	cted fre	equenc	y of RE	F1.
				F	R1FS2	R1F	S1	R1FS0	RE	F1 Fre	quency	Measu	iremen	t	
					0	0		0			8 kH	z			
					0	0		1			1.544 N	ИНz			
					0	1		0			2.048 N	ИНz			
					0	1		1			4.096 N	ИНz			
					1	0		0			8.192 N	ИНz			
					1	0		1			16.384				
					1	1		0			19.44 N				
					1	1		1			Reser	ved			
2 - 0	R0F	-S2 - 0	Refe	rence	0 Frequ	iency \$	Statu	s Bits: ⊺	hese b	oits rep	ort dete	cted fre	equenc	y of RE	F0.
				F	R0FS2	R0F	S1	R0FS0	RE	F0 Fre	quency	Measu	iremen	t	
					0	0		0			8 kH	z			
					0	0		1			1.544 N	ИНz			
					0	1		0			2.048 N	ИНz			
					0	1		1			4.096 N	ИНz			
					1	0		0			8.192 N				
					1	0		1			16.384				
					1	1		0			19.44 N				
					1	1		1			Reser	hav			

Table 59 - Reference Frequency Status Register (RFSR) Bits - Read only (continued)

		ad/Write Ad : 0002 _H	dress:	006C _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	OJP2	OJP1	OJP0
Bit		Name	e						Descri	ption					
15 - 3	3	Unuse													
2 - 0		OJP2 -	• 0	Output perform value (u value of	ance w Insigne	rith res d) mea	pect to ans mor	the no e filter	ise rece ing, wh	eived t iile zer	hrough o meai	the ouns filter	itput pir r bypas	ns. The	higher

 Table 60 - Output Jitter Control Register (OJCR) Bits

	nal Re t Value			ress: 0	100 _H -	011F _ł	4								
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	STIN[n] BD2	STIN[n] BD1	STIN[n] BD0	STIN[n] SMP1	STIN[n] SMP0	STIN[n] DR3	STIN[n] DR2	STIN[n] DR1	STIN[n] DR0
Bit	t		N	lame)					D	escripti	on			
15 -	9		Uı	nuse	d		Reserve	d. In nor	mal funct	ional mo	de, thes	e bits M	UST be s	set to zer	0.
8 -	6	S	TIN[n]BC	02 - 0	-	The bina	y value		bits refe					put strean no delay.
5 -	4	S	TIN[r	n]SM	P1 - (0 1	Input Da	ta Samp	oling Poi	nt Selec	tion Bits	S:			
							STIN[n]SI	/IP1-0	2.048 Mbp	•	ling Point ops, 8.192	Mbps stre	ams) (Samplin 16.384 Mbp	g Point os streams)
							00			3/4	l point			2/4 p	oint
							01			1/4	l point				
							10			2/4	l point			4/4 p	oint
		1					11			4/4	point				

Table 61 - Stream Input Control Register 0 - 31 (SICR0 - 31) Blts

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	STIN[n] BD2	STIN[n] BD1	STIN[n] BD0	STIN[n] SMP1	STIN[n] SMP0	STIN[n] DR3	STIN[n] DR2	STIN[n] DR1	STIN[n] DR0
Bi	t		N	lame	•					D	escripti	on			
3 -	0	S	TIN[n]DF	83 - 0)	nput Da	ta Rate S	Selectio	n Bits:					
									STIN	l[n]DR3-0		Data Rate	;		
										0000	Str	eam Unu	sed		
										0001	2	.048 Mbp	S		
									(0010	4	.096 Mbp	S		
										0011	8	.192 Mbp	S		
									(0100	16	6.384 Mbj	os		
									010	1 - 1111		Reserved	1		

Table 61 - Stream Input Control Register 0 - 31 (SICR0 - 31) Blts (continued)

15 14	13 12	11	10	9	8	7	6	5	4	3	2	1	0
0 0	0 0	STIN[n] Q3C2	STIN[n] Q3C1	STIN[n] Q3C0	STIN[n] Q2C2	STIN[n] Q2C1	STIN[n] Q2C0	STIN[n] Q1C2	STIN[n] Q1C1	STIN[n] Q1C0	STIN[n] Q0C2	STIN[n] Q0C1	STIN[n] Q0C0
Bit	1	Name						Desci	ription				
15 - 12	U	Inused	F	Reserve	d. In no	rmal fur	nctional	mode, t	these bi	ts MUS	T be se	t to zero).
11 - 9	11 - 9 STIN[n]Q3C2 - 0 Quadrant Frame 3 Control Bits. These three bits are used to control S quadrant frame 3, which is defined as Ch24 to 31, Ch48 to 63, Ch96 to 12 Ch192 to 255 for the 2.048 Mbps, 4.096 Mbps, 8.192 Mbps, and 16.384 modes respectively. STIN[n]Q3C STIN[n]Q3C 2-0 Operation												
					2-0	5			•				
					0x:				normal			" • "	
				_	10	-					laced by laced by		_
					10 11						laced by		_
				_									_
8 - 6 STIN[n]Q2C2 - 0 Quadrant Frame 2 Control Bits. These three bits are used to con quadrant frame 2, which is defined as Ch16 to 23, Ch32 to 47, Ch6 Ch128 to 191 for the 2.048 Mbps, 4.096 Mbps, 8.192 Mbps, and 16 modes respectively.											, Ch64	to 95 ar	
						N[n]Q2C 2-0			Ope	ration			
						0xx			normal	operatio	n		
						100	LS	SB of ea	ch chanr	nel is rep	laced by	"0"	
						101	LS	SB of ea	ch chanr	nel is rep	laced by	"1"	
						110				•	laced by		
						111		SB of ea					

Table 62 - Stream Input Quadrant Frame Register 0 - 31 (SIQFR0 - 31) Bits

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	STIN[n] Q3C2	STIN[n] Q3C1	STIN[n] Q3C0	STIN[n] Q2C2	STIN[n] Q2C1	STIN[n] Q2C0	STIN[n] Q1C2	STIN[n] Q1C1	STIN[n] Q1C0	STIN[n] Q0C2	STIN[n] Q0C1	STIN[n] Q0C0
Bi	t			Name						Desci	ription				
5 -	2		TINIC	n]Q1C2		Juadran	4 F uene	. 1 Cor	tual Di			hite en			
J -	5		, IIV	njaroz	q C	uadrant h64 to hodes re	frame 127 for	1, which the 2.0	n is defi	ned as	Ch8 to	15, Ch1	16 to 31	, Ch32	to 63 a
							ST	IN[n]Q10 2-0	C		Ope	eration			
								0xx			normal	operatio	n		
								100	L	SB of ea	ch chani	nel is rep	placed by	· "0"	
								101	L	SB of ea	ch chani	nel is rep	laced by	′ "1"	
								110	Μ	ISB of ea	ach chan	nel is rep	placed by	/ "0"	
								111	М	ISB of ea	ach chan	nel is rep	placed by	/ "1"	
2 -	0	S	TIN[n]Q0C2	110 MSB of each channel is replaced by "0" 111 MSB of each channel is replaced by "1"										and C
							STI	N[n]Q0C	2-0		Ope	eration			
								0xx			normal	operatio	on		
								100	L	SB of ea	ach chan	nel is re	placed by	y "0"	
								101	L	SB of ea	ach chan	nel is re	placed by	y "1"	
								110	N	ISB of ea	ach char	inel is re	placed b	y "0"	
								111	N	ISB of ea	ach char	nel is re	nlaced b	v "1"	

Table 62 - Stream Input Quadrant Frame Register 0 - 31 (SIQFR0 - 31) Bits (continued)

15 14	4	13	12	11		10	9	8	7	6	5	4	3	2	1	0
0 0		0	0	STOHZ [n]A2		OHZ i]A1	STOHZ [n]A0	STO[n] FA1	STO[n] FA0	STO[n] AD2	STO[n] AD1	STO[n] AD0	STO[n] DR3	STO[n] DR2	STO[n] DR1	STO[n] DR0
Bit			Na	me							Descri	iption				
5 - 12			Uni	used		Res	erved.	In nor	mal fun	ctional r	node, tł	nese bi	ts MUS	T be se	et to zei	<i>°</i> О.
11 - 9		STO	DHZ	[n]A2 -	0	STO	HZ Ad	dition	al Adva	nceme	nt Bits					
		(only for 0-15)			STOH	Z[n]A2-0)	(2.048 M	al Advan bps, 4.09 192 Mbps	6 Mbps,		Additiona (16.	al Advanc 384 Mbp	
								000			0 bit				0 bit	
							001			1/4 bit				2/4 bit		
								010 011			2/4 bit 3/4 bit				4/4 bit eserved	
								100			4/4 bit				eserveu	
		STOInIFA1 - 0				10	1-111		F	Reserved						
8 - 7		STO[n]FA1 - 0				Out	put Str	eam[n] Fract	ional A	dvance	ment E	Bits:			
		STO[n]FA1 - 0				ę	STO[n]FA	.1-0	(2.048	Mbps, 4.	vancemer 096 Mbps streams)		Mbps		Advance 384 Mbps	ment s streams)
							00				0				0	
							01				1/4 bit				2/4	
							10				2/4 bit				Reserv	/ed
							11				3/4 bit					
6 - 4		STO[n]AD2 - 0				The	binary	value vance	of these		ers to th	ne num	ber of b	oits that		put stre means
3 - 0		ST	O[n]	DR3 -	0	Out	put Da	ta Rate	e Selec	tion Bit	s:					
								S	STIN[n]D	R3 - 0		Da	ata Rate	;		
									000	0			ed: STio Z driven			
									000	1		-	48 Mbp			
									001	0			96 Mbp			
									001	1			92 Mbp			
									010	0			384 Mbp			
					1											

Table 63 - Stream Output Control Register 0 - 31 (SOCR0 - 31) Bits

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Reset V	/alue: (0000 _H													
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	ST[n] BRS7	ST[n] BRS6	ST[n] BRS5	ST[n] BRS4	ST[n] BRS3	ST[n] BRS2	ST[n] BRS1	ST[n] BRS0
Bit		Name							D	escript	ion				
15 - 8	ι	Jnused	ł	Reser	ved. I	n norr	nal fui	nctional	mode,	these b	oits MUS	ST be se	et to zei	ю.	
7 - 0		ST[n] RS7 -	0						Bits: T starts to		-		se bits	refers to	o the in



15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	ST[n] BL8	ST[n] BL7	ST[n] BL6	ST[n] BL5	ST[n] BL4	ST[n] BL3	ST[n] BL2	ST[n] BL1	ST[n] BL0
Bit		Name	•						De	scripti	on				
15 - 9		Unuse	d	Rese	rved.	In nor	rmal fun	ctional	mode, t	hese bi	ts MUS	T be se	t to zero	Э.	
8 - 0		ST[n] BL8 -		conse BER 8.192	ecutive chanr 2 Mbps	e char Iels is 8 and	nnels ex 32, 64	pected 128 ar Mbps re	to rece nd 256 espectiv	ive the for the rely. The	BER pa data rat e minim	ttern. T es of 2 um nun	he max .048 Mt	kimum r ops, 4.0	number of number of 96 Mbps nannels is

Table 65 - BER Receiver Length Register [n] (BRLR[n]) Bits

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	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	ST[n] CBER	ST[n] SBER	
				Γ	Description												
Bit		Nam	9		Description												
15 - 2		Unuse	ed	Rese	Description Reserved. In normal functional mode, these bits MUST be set to zero.												
1		ST[n CBEF	-												h, it res o zero.	ets the i	interna
0		ST[n SBEF	-	recei	ver; s	tarts t	he bi	t erro	r rate	test.	The	bit err	or tes	st resi		ables th ept in th st, set th	ie BEl

Table 66 - BER Receiver Control Register [n] (BRCR[n]) Bits

	nal Read Value: 0	Address: 0000 _H)360 _H ·	- 037F _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ST[n] BC15	ST[n] BC14		ST[n] BC12	ST[n] BC11	ST[n] BC10	ST[n] BC9	ST[n] BC8	ST[n] BC7	ST[n] BC6	ST[n] BC5	ST[n] BC4	ST[n] BC3	ST[n] BC2	ST[n] BC1	ST[n] BC0
Bit		Name						l	Descrij	otion					
					1 BED	Count	Bits (F	Read C	nlv). T	he bina	arv valu	ue of th	iese bit	s refer	e to the

Table 67 - BER Receiver Error Register [n] (BRER[n]) Bits - Read Only

24.0 Memory

24.1 Memory Address Mappings

When A13 is high, the data or connection memory can be accessed by the microprocessor port. Bit 1 - 0 in the Control Register determine the access to the data or connection memory (CM_L or CM_H).

1 0 0 0 0 Stream 0 1 1<	MSB (Note 1)				am Add (St0 - 31								annel / (Ch0 -	Addres 255)	s	
1 0 0 0 1 Stream 1 0 0 0 0 0 0 1 Ch 1 1 0 0 0 1 0 Stream 2 .	A13	A12	A11	A10	A9	A8	Stream [n]	A7	A6	A5	A4	A3	A2	A1	A0	Channel [n]
1 0 0 1 0 Stream 2 .<	1				-	-										
1 0 0 1 1 Stream 3 .<	1	-	-	-	0			0	0	0	0	0	0	0	1	Ch 1
1 0 0 1 0 0 Stream 4 0 0 1<	1	-	-	-	1	-				•	•		•			•
1 0 0 1 Stream 5 0 0 1 0 0 1 0 0 0 1 1 1 1 1 1 1 0 1 1 1 0 0 0 1 1 1 0 0 0 1 1 1 0 0 1 1 1 0 1 0 0 1 1 1 1 1 0 0 0 1<	1	-	-	-									:	;		
1 0 0 1 1 0 0 1 0 0 0 0 0 0 0 1 0 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 1 0 0 0 1 1 1 1 1 1 1 1 0 0 0 0 0 1 1 1 1 0 0 0 0 0 0 0 0 1 1 1 1 0 0 0 0 1 1 1 1 0 0 0 0 1 1 1 1 0 0 0 1 1 1 1 0	1	-	-	-	-									-		
1 0 0 1 1 1 Stream 7 0 0 1 0 0 0 1 0 0 1 Ch 33 1 0 1 0 0 0 0 Stream 8 .	1	-	-		-	-		-	-	-	-	-		-		
1 0 1 0 0 0 Stream 8 .<	1	-	-		1	-		-	-	-	-	-	-	-	-	
1 1	1	-	-					-	0		U	0	0	0		011 33
0 0 1	1	0														•
. 0 0 1	•	•	. . <td>Ch 62</td>													Ch 62
	•	•	0 0 1 1 1 1 1 0 Ch62													
. .	1		0 0 1 1 1 1 1 1 Ch 63 (Note 3													
1 0 1 1 1 0 Stream 14 .												÷				
. 0 1 1 1 1 1 1 0 Ch126 0 1 </td <td>1</td> <td>0</td> <td></td> <td></td> <td>1</td> <td>0</td> <td>Stream 14</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td>	1	0			1	0	Stream 14									
. 0 1	1	0	1	1	1	1	Stream 15									
.								0	1	1	1	1	1	1	0	Ch126
								0	1	1	1	1	1	1	1	Ch 127 (Note 4)
. .									-							
. .									-							
111110Stream 3011<	-									-	•					
1 1	:		:	:	:	:	•		:	:			:	:		
Note 1: A13 must be high for access to data and connection memory positions. A13 must be low to access inte registers. Note 2: Channels 0 to 31 are used when serial stream is at 2.048 Mbps.		-				-								-		
registers. Note 2: Channels 0 to 31 are used when serial stream is at 2.048 Mbps.	1	1	1	1	1	1	Stream 31	1	1	1	1	1	1	1	1	Ch 255 (Note 5)
	Note 1:	A13 m registe	nust be ers.	high fo	or acce	ess to d	lata and conn	ection	mem	ory po	osition	is. A1	3 mus	t be lo	ow to	access internal
Note 3: Channels 0 to 63 are used when serial stream is at 4.096 Mbps.	Note 2:	Chanr	nels 0 t	o 31 ai	re used	d when	serial stream	is at	2.048	Mbps						
	Note 3:	Chanr	nels 0 t	o 63 ai	re used	d when	serial stream	is at	4.096	Mbps	i.					
Note 4: Channels 0 to 127 are used when serial stream is at 8.192 Mbps.	Note 4:	Chanr	nels 0 t	o 127 a	are use	ed whe	n serial strea	m is a	t 8.19	2 Mbp	s.					
Note 5: Channels 0 to 255 are used when serial stream is at 16.384 Mbps.	Note 5:	Chanr	nels 0 t	o 255 a	are use	ed whe	n serial strea	m is a	t 16.3	84 Mb	ops.					

Table 68 - Address Map for Memory Locations (A13 = 1)

24.2 Connection Memory Low (CM_L) Bit Assignment

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When the CMM bit (bit 0) in the connection memory low is zero, the per-channel transmission is set to the normal channel-switching. The connection memory low bit assignment for the channel transmission mode is shown in Table 69 on page 101.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
UA EN	V/C	SSA 4	SSA 3	SSA 2	SSA 1	SSA 0	SCA 7	SCA 6	SCA 5	SCA 4	SCA 3	SCA 2	SCA 1	SCA 0	CMM =0
Bit	N	ame						[Descri	ption					
15	U	AEN	Wh tior Wh	n mem nen thi	s bit is ory hi s bit is	s low, 1 gh will s high,	norma l be igi switcl	l switc nored. n with	h with μ-law/	out µ-l ′A-law	aw/A- conve				onnec- tion
14		V/C	Wh sta Wh var	memory high controls the conversion method. Variable/Constant Delay Control When this bit is low, the output data for this channel will be taken from con- stant delay memory. When this bit is set to high, the output data for this channel will be taken from variable delay memory. Note that VAREN must be set in Control Register first.											
13 - 9	SS	A4 - 0		urce S e bina				bits r	eprese	ents th	e inpu	t strea	ım nur	nber.	
8 - 1	SC	A7 - 0		urce (e bina	-			bits r	eprese	ents th	e inpu	t chan	inel nu	ımber.	
0	CM	1M = 0	lf ti	nnect nis is le re the	ow, th	e conr	, nectior	n mem					ching r	mode.	Bit13 -
Note: Fo															

Table 69 - Connection Memory Low (CM_L) Bit Assignment when CMM = 0

When CMM is one, the device is programmed to perform one of the special per-channel transmission modes. Bits PCC0 and PCC1 from connection memory are used to select the per-channel tristate, message or BER test mode as shown in Table 70 on page 102.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
UA EN	0	0	0	0	MSG 7	MSG 6	MSG 5	MSG 4	MSG 3	MSG 2	MSG 1	MSG 0	PCC 1	PCC 0	CMM =1
Bit		Nam	e						De	scripti	on				
15		UAE	N	Wh tior Wh	nen this n mem nen this	s bit is ory hig s bit is	low, m h will b high, n	essage e igno nessag	e mode red. je moc		ιο μ-lav μ-law//	v√A-lav A-law o	v conve	ersion.	n ly) Connec nd con-
14 - 11	ι	Jnuse	ed	Re	served	l. In no	ormal fu	unctior	al mo	de, the	se bits	MUST	be se	t to zei	о.
10 - 3	М	SG7	- 0				Bits: 8 tate an			he mes nodes.	ssage	mode.	Not us	ed in tl	ne
2 - 1	P	CC1	- 0				ontrol io strea		hese	two bit	s contr	ol the o	corresp	ondin	g entry's
							PC C1	PC CC	(hannel	Output	Mode			
							0	0	F	Per Cha	annel Tr	istate			
							0	1		Mess	age Mo	ode			
							1	0		BER	Test Mo	ode			
							1	1		Re	eserved				
									4 16				nection		

Table 70 - Connection Memory Low (CM_L) Bit Assignment when CMM = 1

24.3 Connection Memory High (CM_H) Bit Assignment

Connection memory high provides the detailed information required for μ -law and A-law conversion. ICL and OCL bits describe the Input Coding Law and the Output Coding Law, respectively. They are used to select the expected PCM coding laws for the connection, on the TDM inputs, and on the TDM outputs. The V/D bit is used to select the class of coding law. If the V/D bit is cleared (to select a voice connection), the ICL and OCL bits select between A-law and μ -law specifications related to G.711 voice coding. If the V/D bit is set (to select a data connection), the ICL and OCL bits select between various bit inverting protocols. These coding laws are illustrated in the following table. If the ICL is different than the OCL, all data bytes passing through the switch on that particular connection are translated between the indicated laws. If the ICL and the OCL are the same, no coding law translation is performed.

The ICL, the OCL bits and \overline{V}/D bit only have an effect on PCM code translations for constant delay connections, variable delay connections and per-channel message mode.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	V/D	ICL 1	ICL 0	OCL 1	OCL 0
Bit	N	lame							Descri	ption					
15 - 5	Ur	nused	Re	serve	ed. In n	ormal	functi	onal n	node, f	hese	bits M	UST b	e set	to zero) .
4	;	V/D	Wh	nen th	ata Co iis bit is iis bit is	s low, t		•	•						
3 - 2	IC	L1 - 0	Inp	out C	oding	Law									
					ICL1-				Input (Coding	Law				
					0	Fo	r Voice	(V/D b	oit = 0)		For Da	ta (V /D	bit = 1)	
					00		CCITT	ITU A-	law		1	No cod	е		
					01		CCITT	.ITU μ-	law			ABI			
					10		A-law	/ w/o A	BI		١n	verted /	ABI		
					11	μ-	law w/e Inv	o Magr ersion	itude		All E	Bits Invo	erted		
1 - 0	00	CL1 - 0	Ou	tput	Coding	g Law	,								
				Γ	OCL1				Output	Codin	g Law				
					-0	Fo	r Voice	(V/D b	it = 0)		For Da	ta (V /D	bit = 1	I)	
					00		CCITT.	ITU A-	law			No cod	е		
					01		CCITT	ITU μ-	law			ABI			
					10		A-law	w/o A	BI		Inv	verted a	ABI		
					11	μ-	law w/o Inv	o Magr ersion	itude		Ali e	Bits Inv	erted		

Table 71 - Connection Memory High (CM_H) Bit Assignment

25.0 Applications

This section contains application-specific details for clock and crystal operation and power supply decoupling.

25.1 OSCi Master Clock Requirement

The device requires a 20 MHz master clock source at the OSCi pin when operating in Master mode or in Divided Slave with OSC mode. The clock source may be either an external clock oscillator connected to the OSCi pin, or an external crystal connected between the OSCi and OSCo pins. If an external clock source is present, OSC_EN must be tied high.

Note that using a crystal is only suitable for wider tolerance applications (i.e. \pm 100 ppm). Stratum 4E applications (i.e. \pm 32 ppm) should use a clock oscillator while Stratum 3 applications (i.e. \pm 4.6 ppm) should use a temperature-compensated clock module. See Application Note ZLAN-68 for a list of Oscillators and Crystals that can be used with Zarlink PLL's and Digital Switches with embedded PLL's.

25.1.1 External Crystal Oscillator

When an external crystal oscillator is used, a complete oscillator circuit made up of a crystal, resistor and capacitors is shown in Figure 23 on page 104. XC is a buffered version of the 20 MHz input clock connected to the internal circuitry.

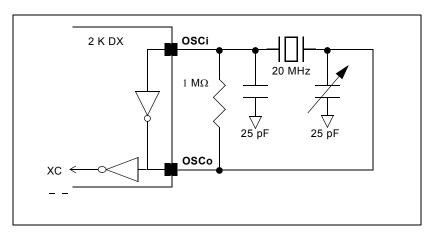


Figure 23 - Crystal Oscillator Circuit

The accuracy of a crystal oscillator circuit depends on the crystal tolerance as well as the load capacitance tolerance. Typically, for a 20 MHz crystal specified with a 32 pF load capacitance, each 1 pF change in load capacitance contributes approximately 9 ppm to the frequency deviation. Consequently, capacitor tolerances and stray capacitances have a major effect on the accuracy of the oscillator frequency. The trimmer capacitor shown in Figure 23 on page 104 may be used to compensate for capacitive effects.

The crystal should be a fundamental mode type - not an overtone. The fundamental mode crystal permits a simpler oscillator circuit with no additional filter components and is less likely to generate spurious responses. The crystal accuracy only affects the output clock accuracy in the freerun or the holdover mode. The crystal specification is as follows:

Frequency	20 MHz
Tolerance	As required
Oscillation Mode	Fundamental
Resonance Mode	Parallel

Load Capacitance	20 pF - 32 pF
Maximum Series Resistance	35 Ω
Approximate Drive Level	1 mW

25.1.2 External Clock Oscillator

When an external clock oscillator is used, numerous parameters must be considered. They include absolute frequency, frequency change over temperature, output rise and fall times, output levels and duty cycle.

The output clock should be connected directly (not AC coupled) to the OSCi input of the device, and the OSCo output should be left open as shown in Figure 24 on page 105. XC is a buffered version of the 20 MHz input clock connected to the internal circuitry.

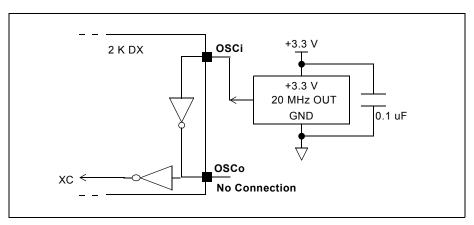


Figure 24 - Clock Oscillator Circuit

For applications requiring ±32ppm clock accuracy, the following requirements should be met:

Frequency	20.000 MHz
Tolerance	±32 ppm
Rise and Fall Time	10 ns
Duty Cycle	40% to 60%

For applications requiring Stratum 3 compliance (\pm 4.6 ppm clock accuracy), the following temperature compensated clock oscillator module may be used.

Frequency	20.000 MHz
Tolerance	±4.6 ppm
Rise and Fall Time	10 ns
Duty Cycle	40% to 60%

26.0 DC Parameters

Absolute Maximum Ratings*

	Parameter	Symbol	Min.	Max.	Units
1	I/O Supply Voltage	V _{DD_IO}	-0.5	5.0	V
2	Core Supply Voltage	V _{DD_CORE}	-0.5	2.5	V
3	Input Voltage	V _{I_3V}	-0.5	V _{DD} + 0.5	V
4	Input Voltage (5 V-tolerant inputs)	V _{I_5V}	-0.5	7.0	V
5	Continuous Current at Digital Outputs	ا _ہ		15	mA
6	Package Power Dissipation	PD		1.5	W
7	Storage Temperature	Τ _S	- 55	+125	°C

* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

Recommended Operating Conditions - Voltages are with respect to ground (V_{SS}) unless otherwise stated.

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units
1	Operating Temperature	T _{OP}	-40	25	+85	°C
2	Positive Supply	V _{DD_IO}	3.0	3.3	3.6	V
3	Positive Supply	V _{DD_CORE}	1.71	1.8	1.89	V
4	Input Voltage	VI	0	3.3	V _{DD_IO}	V
5	Input Voltage on 5V-Tolerant Inputs	$V_{I_{5V}}$	0	5.0	5.5	V

[‡] Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

Characteristics Typ.[‡] Units **Test Conditions** Sym. Min. Max. Supply Current - V_{DD CORE} 1 165 mΑ IDD CORE 2 Supply Current - V_{DD_IO} 75 mΑ C_I = 30 pF V 3 Input High Voltage 2.0 VIH Input Low Voltage V 4 VIL 0.8 0≤<V_{IN}≤V_{DD_IO} See Note 1 5 Input Leakage (input pins) 5 μA Ι_{ΙL} Input Leakage (bi-directional pins) 5 μA I_{BL} Weak Pullup Current -33 Input at 0V 6 μA I_{PU} Weak Pulldown Current Input at V_{DD} IO 7 33 I_{PD} μA 8 Input Pin Capacitance C 3 pF 9 **Output High Voltage** 2.4 V V_{OH} I_{OH} = 8 mA 10 Output Low Voltage V V_{OL} 0.4 $I_{OL} = 8 \text{ mA}$ $0 < V < V_{DD}$ Output High Impedance Leakage 11 5 I_{OZ} μΑ 12 10 **Output Pin Capacitance** CO 5 pF

DC Electrical Characteristics[†] - Voltages are with respect to ground (V_{ss}) unless otherwise stated.

† Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

* Note 1: Maximum leakage on pins (output or I/O pins in high impedance state) is over an applied voltage (V_{IN}).

27.0 AC Parameters

	Characteristics	Sym.	Level	Units	Conditions
1	CMOS Threshold	V _{CT}	0.5 V _{DD_IO}	V	
2	Rise/Fall Threshold Voltage High	V _{HM}	0.7 V _{DD_IO}	V	
3	Rise/Fall Threshold Voltage Low	V_{LM}	0.3 V _{DD_IO}	V	

† Characteristics are over recommended operating conditions unless otherwise stated.

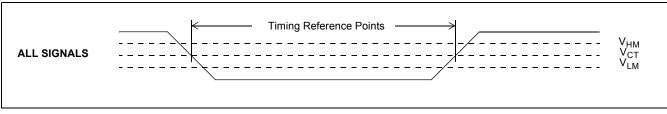
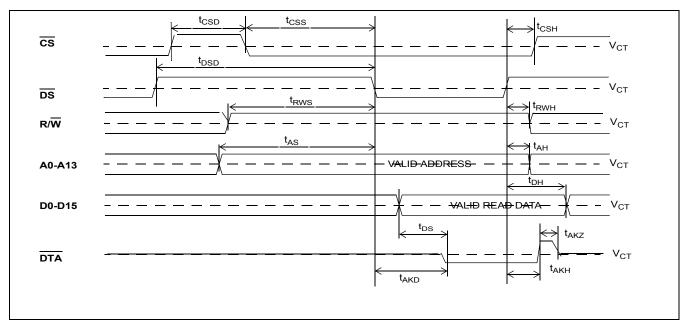


Figure 25 - Timing Parameter Measurement Voltage Levels

	Characteristics	Sym	Min.	Тур.	Max.	Units	Test Conditions ²
1	CS de-asserted time	t _{CSD}	15			ns	
2	DS de-asserted time	t _{DSD}	15			ns	
3	CS setup to DS falling	t _{CSS}	0			ns	
4	R/\overline{W} setup to \overline{DS} falling	t _{RWS}	10			ns	
5	Address setup to DS falling	t _{AS}	5			ns	
6	CS hold after DS rising	t _{CSH}	0			ns	
7	R/W hold after DS rising	t _{RWH}	0			ns	
8	Address hold after DS rising	t _{AH}	0			ns	
9	Data setup to DTA Low	t _{DS}	8			ns	C _L = 50 pF
10	Data hold after DS rising	t _{DH}	7			ns	C _L =50pF, R _L =1 K (Note 1)
11	Acknowledgement delay time. From DS low to DTA low: Registers Memory	t _{AKD}			75 185	ns ns	C _L = 50 pF C _L = 50 pF
12	Acknowledgement hold time. From DS high to DTA high	t _{AKH}	4		12	ns	C _L = 50 pF, R _L = 1 K (Note 1)
13	DTA drive high to HiZ	t _{AKZ}				ns	
lote lote	 High impedance is measured by pulling discharge C_L. A delay of 500 μs to <u>2 ms (see Section</u> performed after the RESET pin is set high 	17.2 on pag	•	-	-		

AC Electrical Characteristics[†] - Motorola Non-Multiplexed Bus Mode - Read Access

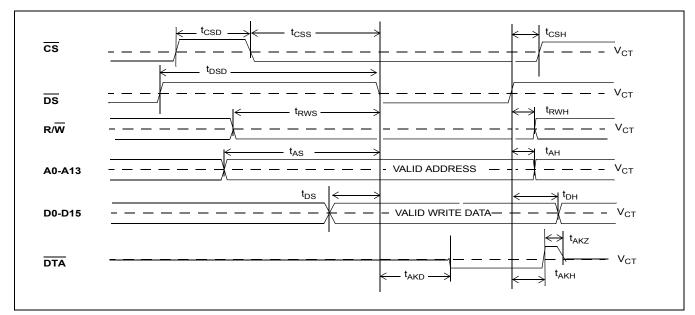
† Characteristics are over recommended operating conditions unless otherwise stated.





Characteristics	Sym.	Min.	Тур.	Max.	Units	Test Conditions ²
CS de-asserted time	t _{CSD}	15			ns	
DS de-asserted time	t _{DSD}	15			ns	
CS setup to DS falling	t _{CSS}	0			ns	
R/\overline{W} setup to \overline{DS} falling	t _{RWS}	10			ns	
Address setup to DS falling	t _{AS}	5			ns	
Data setup to DS falling	t _{DS}	0			ns	C _L = 50 pF
CS hold after DS rising	t _{CSH}	0			ns	
R/W hold after DS rising	t _{RWH}	0			ns	
Address hold after DS rising	t _{AH}	0			ns	
Data hold from $\overline{\text{DS}}$ rising	t _{DH}	5			ns	C _L = 50 pF, R _L = 1 K (Note 1)
Acknowledgement delay time. From DS low to DTA low: Registers Memory	t _{AKD}			55 150	ns ns	C _L = 50 pF C _L = 50 pF
Acknowledgement hold time. From DS high to DTA high	t _{AKH}	4		12	ns	C _L = 50 pF, R _L = 1 K (Note 1)
DTA drive high to HiZ	t _{AKZ}			8	ns	
	CS de-asserted time DS de-asserted time CS setup to DS falling R/W setup to DS falling Address setup to DS falling Data setup to DS falling CS hold after DS rising R/W hold after DS rising Address hold after DS rising Acknowledgement delay time. From DS low to DTA low: Registers Memory Acknowledgement hold time. From DS high to DTA high	CS de-asserted time t _{CSD} DS de-asserted time t _{DSD} CS setup to DS falling t _{CSS} R/W setup to DS falling t _{RWS} Address setup to DS falling t _{AS} Data setup to DS falling t _{DS} CS hold after DS rising t _{CSH} R/W hold after DS rising t _{RWH} Address hold after DS rising t _{AH} Data hold from DS rising t _{DH} Acknowledgement delay time. t _{AKD} From DS low to DTA low: Registers Memory t _{AKH}	CSde-asserted timet_{CSD15DSde-asserted timet_{DSD15CSsetup to DSfallingt_{CSS0R/W setup to DSfallingt_RWS10Address setup to DSfallingt_AS5Data setup to DSfallingt_DS0CShold after DSrisingt_CSH0R/W hold after DSrisingt_CSH0R/W hold after DSrisingt_RWH0Address hold after DSrisingt_AH0Data hold from DSrisingt_DH5Acknowledgement delay time. From DS low to DTA low: Registers Memoryt_AKH4From DShigh to DTA hight_AKH4	CS de-asserted timet t CS15DS de-asserted timet DSD15DS de-asserted timet t DSD15CS setup to DS fallingt R CSS0R/W setup to DS fallingt ASS10Address setup to DS fallingt AS5Data setup to DS fallingt DS0CS hold after DS risingt CSH0R/W hold after DS risingt R CSH0Address hold after DS risingt AH0Data hold from DS risingt AH0Acknowledgement delay time. Registers Memoryt AKH4From DS high to DTA hight 	CSde-asserted timet_{CSD15DSde-asserted timet_{DSD15DSde-asserted timet_{DSD15CSsetup to DS fallingt_{CSS}0R/W setup to DS fallingt_{RWS10Address setup to DS fallingt_{AS5Data setup to DS fallingt_DS0CS hold after DS risingt_CSH0R/W hold after DS risingt_RWH0Address hold after DS risingt_AH0Data hold from DS risingt_DH5Acknowledgement delay time. From DS low to DTA low: Registers Memoryt_AKH4Acknowledgement hold time. From DS high to DTA hight_AKH4	CSde-asserted timettnsDSde-asserted timett15nsDSde-asserted timett0nsCSsetup to DS fallingtt0nsR/W setup to DS fallingtt10nsAddress setup to DS fallingtt5nsData setup to DS fallingtt0nsCS hold after DS risingtt0nsR/W hold after DS risingtt0nsAddress hold after DS risingtt0nsAddress hold after DS risingtt0nsAddress hold after DS risingtt0nsAcknowledgement delay time.tt5nsFrom DS low to DTA low:tt55nsRegistersMemoryt412nsMemoryto DTA highttt12ns

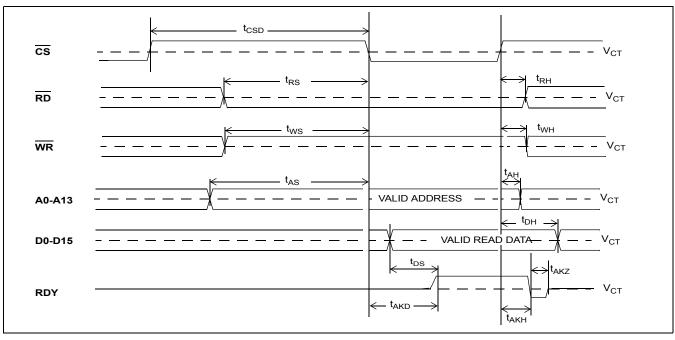
AC Electrical Characteristics[†] - Motorola Non-Multiplexed Bus Mode - Write Access

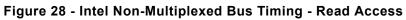




	Characteristics	Sym.	Min.	Тур.	Max.	Units	Test Conditions ²
27	CS de-asserted time	t _{CSD}	15			ns	
28	RD setup to CS falling	t _{RS}	10			ns	
29	WR setup to CS falling	t _{WS}	10			ns	
30	Address setup to CS falling	t _{AS}	5			ns	
31	RD hold after CS rising	t _{RH}	0			ns	
32	WR hold after CS rising	t _{WH}	0			ns	
33	Address hold after CS rising	t _{AH}	0			ns	
34	Data setup to RDY high	t _{DS}	8			ns	C _L = 50 pF
35	Data hold after CS rising	t _{DH}	7			ns	C _L =50pF, R _L =1K (Note 1)
36	Acknowledgement delay time. From CS low to RDY high: Registers Memory	t _{AKD}			175 185	ns ns	C _L = 50 pF C _L = 50 pF
37	Acknowledgement hold time. From CS high to RDY low	t _{AKH}	4		12	ns	C _L = 50 pF, R _L = 1 K (Note 1)
38	RDY drive low to HiZ	t _{AKZ}			8	ns	
Note Note	discharge C _L .	17.2 on pag					

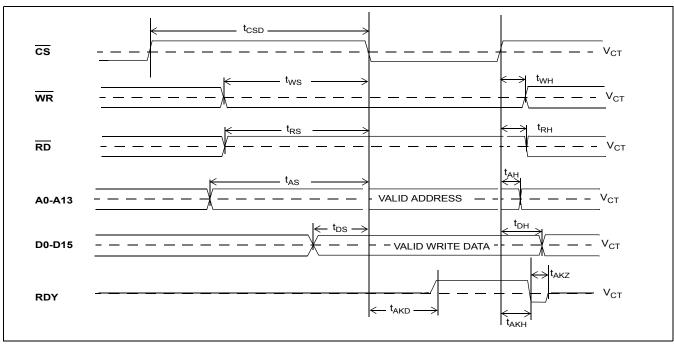
AC Electrical Characteristics[†] - Intel Non-Multiplexed Bus Mode - Read Access

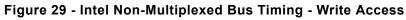




	Characteristics	Sym.	Min.	Тур.	Max.	Units	Test Conditions ²
39	CS de-asserted time	t _{CSD}	15			ns	
40	WR setup to CS falling	t _{WS}	10			ns	
41	RD setup to CS falling	t _{RS}	10			ns	
42	Address setup to CS falling	t _{AS}	5			ns	
43	Data setup to CS falling	t _{DS}	0			ns	C _L = 50 pF
44	WR hold after CS rising	t _{WH}	0			ns	
45	RD hold after CS rising	t _{RH}	0			ns	
46	Address hold after CS rising	t _{AH}	10			ns	
47	Data hold after CS rising	t _{DH}	5			ns	C _L = 50 pF, R _L = 1 K (Note 1)
48	Acknowledgement delay time. From CS low to RDY high: Registers Memory	t _{AKD}			55 150	ns ns	C _L = 50 pF C _L = 50 pF
49	Acknowledgement hold time. From CS high to RDY low	t _{AKH}	4		12	ns	C _L = 50 pF, R _L = 1 K (Note 1)
50	RDY drive low to HiZ	t _{AKZ}	1		8	ns	
Note Note	discharge C _L .			_	-		

AC Electrical Characteristics[†] - Intel Non-Multiplexed Bus Mode - Write Access

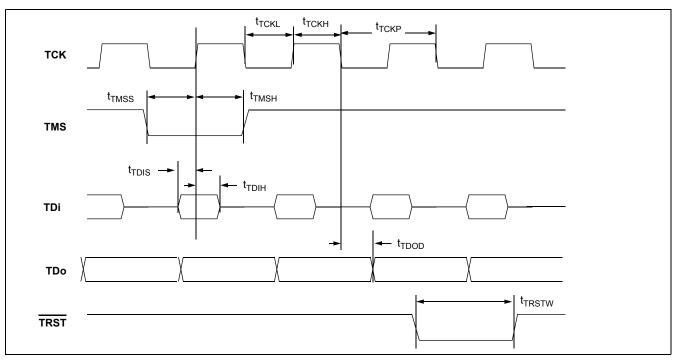




AC Electrical Characteristics † - JTAG Test Port Timing

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Notes
1	TCK Clock Period	t _{TCKP}	100			ns	
2	TCK Clock Pulse Width High	t _{тскн}	20			ns	
3	TCK Clock Pulse Width Low	t _{TCKL}	20			ns	
4	TMS Set-up Time	t _{TMSS}	10			ns	
5	TMS Hold Time	t _{TMSH}	10			ns	
6	TDi Input Set-up Time	t _{TDIS}	20			ns	
7	TDi Input Hold Time	t _{TDIH}	60			ns	
8	TDo Output Delay	t _{TDOD}			30	ns	C _L = 30 pF
9	TRST pulse width	t _{TRSTW}	200			ns	

† Characteristics are over recommended operating conditions unless otherwise stated.





AC Electrical Characteristics[†] - OSCi 20 MHz Input Timing

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Notes†
1	Input frequency accuracy		-4.6		4.6	ppm	1
2	Duty cycle		40		60	%	
3	Input rise or fall time	t _{IR,} t _{IF}			3	ns	17

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ See "Performance Characteristics Notes" on page 133.

	-						
	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPi Input Frame Pulse Width	t _{FPIW}	40	61	115	ns	
2	FPi Input Frame Pulse Setup Time	t _{FPIS}	20			ns	
3	FPi Input Frame Pulse Hold Time	t _{FPIH}	20			ns	
4	CKi Input Clock Period	t _{CKIP}	55	61	67	ns	
5	CKi Input Clock High Time	t _{CKIH}	27		34	ns	
6	CKi Input Clock Low Time	t _{CKIL}	27		34	ns	
7	CKi Input Clock Rise/Fall Time	t _r CKi, t _f CKi			3	ns	
8	CKi Input Clock Cycle to Cycle Variation	t _{CVC}	0		20	ns	

AC Electrical Characteristics[†] - FPi and CKi Timing when CKIN1-0 bits = 00 (16.384 MHz)

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - FPi and CKi Timing when CKIN1-0 bits = 01 (8.192 MHz)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPi Input Frame Pulse Width	t _{FPIW}	90	122	220	ns	
2	FPi Input Frame Pulse Setup Time	t _{FPIS}	45			ns	
3	FPi Input Frame Pulse Hold Time	t _{FPIH}	45			ns	
4	CKi Input Clock Period	t _{CKIP}	110	122	135	ns	
5	CKi Input Clock High Time	t _{CKIH}	55		69	ns	
6	CKi Input Clock Low Time	t _{CKIL}	55		69	ns	
7	CKi Input Clock Rise/Fall Time	t _r CKi, t _f CKi			3	ns	
8	CKi Input Clock Cycle to Cycle Variation	t _{CVC}	0		20	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - FPi and CKi Timing when CKIN1-0 bits = 10 (4.096 MHz)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPi Input Frame Pulse Width	t _{FPIW}	90	244	420	ns	
2	FPi Input Frame Pulse Setup Time	t _{FPIS}	110			ns	
3	FPi Input Frame Pulse Hold Time	t _{FPIH}	110			ns	
4	CKi Input Clock Period	t _{CKIP}	220	244	270	ns	
5	CKi Input Clock High Time	t _{CKIH}	110		135	ns	
6	CKi Input Clock Low Time	t _{CKIL}	110		135	ns	
7	CKi Input Clock Rise/Fall Time	t _r CKi, t _f CKi			3	ns	
8	CKi Input Clock Cycle to Cycle Variation	t _{CVC}	0		20	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

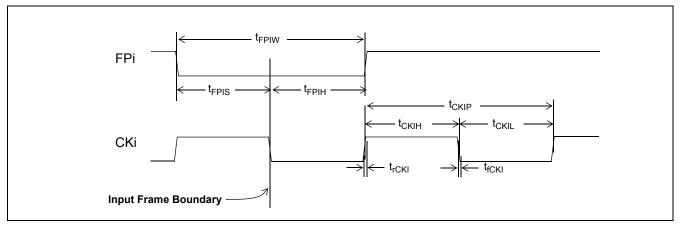


Figure 31 - Frame Pulse Input and Clock Input Timing Diagram (ST-BUS)

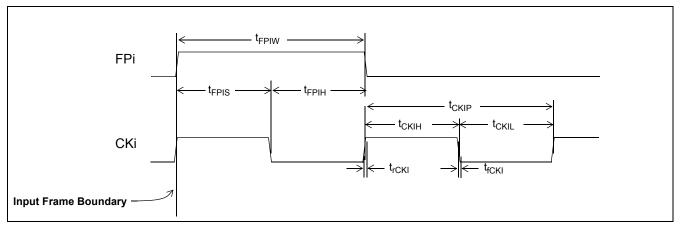


Figure 32 - Frame Pulse Input and Clock Input Timing Diagram (GCI-Bus)

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Test Conditions
1	STi Setup Time						
	2.048 Mbps 4.096 Mbps 8.192 Mbps 16.384 Mbps	t _{SIS2} t _{SIS4} t _{SIS8} t _{SIS16}	5 5 5 8			ns ns ns ns	
2	STi Hold Time						
	2.048 Mbps 4.096 Mbps 8.192 Mbps 16.384 Mbps	t _{SIH2} t _{SIH4} t _{SIH8} t _{SIH16}	8 8 8 8			ns ns ns ns	

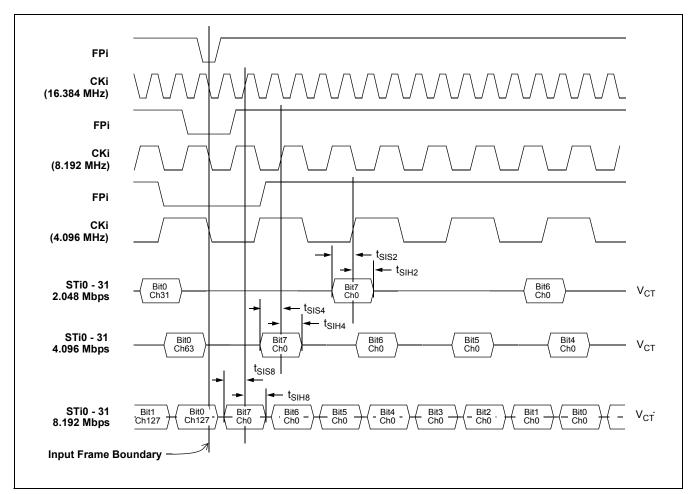


Figure 33 - ST-BUS Input Timing Diagram when Operated at 2 Mbps, 4 Mbps, 8 Mbps

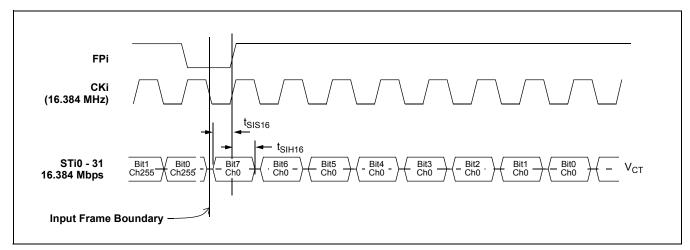


Figure 34 - ST-BUS Input Timing Diagram when Operated at 16 Mbps

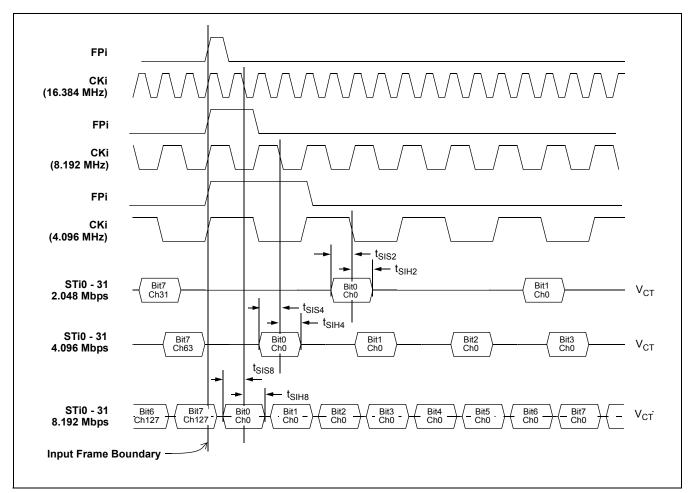


Figure 35 - GCI-Bus Input Timing Diagram when Operated at 2 Mbps, 4 Mbps, 8 Mbps

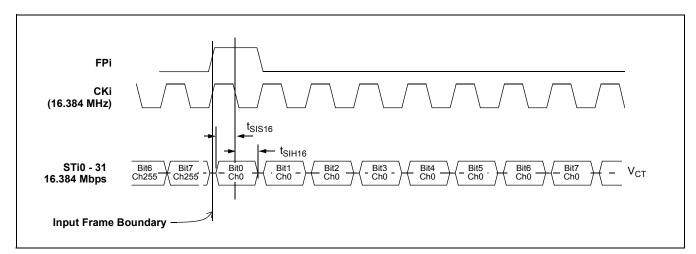


Figure 36 - GCI-Bus Input Timing Diagram when Operated at 16 Mbps

AC Electrical Characteristics[†] - ST-BUS/GCI-Bus Master Mode Output Timing

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Test Conditions
1	STio Delay - Active to Active						C _L = 30pF
	at 2.048 Mbps at 4.096 Mbps at 8.192 Mbps at 16.384 Mbps	t _{SOD2} t _{SOD4} t _{SOD8} t _{SOD16}	1 1 1		8 8 8	ns ns ns ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - ST-BUS/GCI-Bus Multiplied Slave Mode Output Timing

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Test Conditions
1	STio Delay - Active to Active						C _L = 30pF
	at 2.048 Mbps at 4.096 Mbps at 8.192 Mbps at 16.384 Mbps	t _{SOD2} t _{SOD4} t _{SOD8} t _{SOD16}	0 0 0		666 66	ns ns ns ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - ST-BUS/GCI-Bus Divided Slave Mode Output Timing

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Test Conditions
1	STio Delay - Active to Active						C _L = 30pF
	at 2.048 Mbps at 4.096 Mbps at 8.192 Mbps at 16.384 Mbps	t _{SOD2} t _{SOD4} t _{SOD8} t _{SOD16}	-6 -6 -6		0 0 0 0	ns ns ns ns	

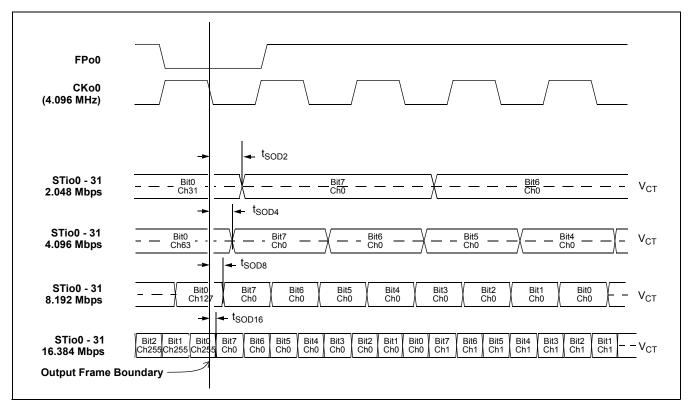


Figure 37 - ST-BUS Output Timing Diagram when Operated at 2, 4, 8 or 16 Mbps

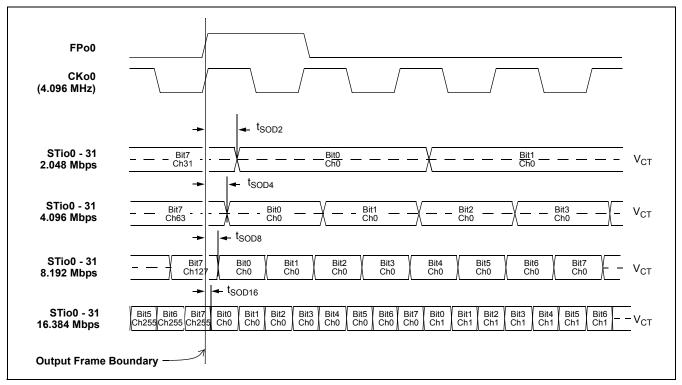


Figure 38 - GCI-Bus Output Timing Diagram when Operated at 2, 4, 8 or 16 Mbps

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Test Conditions [*]
1	STio Delay - Active to High-Z	t _{DZ}	-2		8	ns	Master Mode
			-3		7	ns	Multiplied Slave Mode
			-8		0	ns	Divided Slave Mode
2	STio Delay - High-Z to Active	t _{ZD}	-2		8	ns	Master Mode
			-3		7	ns	Multiplied Slave Mode
			-8		0	ns	Divided Slave Mode
3	Output Drive Enable (ODE) Delay	t _{ZD_ODE}					Master or
	- High-Z to Active	_			77	ns	Multiplied Slave Mode
	CKi @ 4.096 MHz				260	ns	Divided Slave Mode
	CKi @ 8.192 MHz				138	ns	
	CKi @ 16.384 MHz				77	ns	
4	Output Drive Enable (ODE) Delay	t _{DZ ODE}					Master or
	- Active to High-Z				77	ns	Multiplied Slave Mode
						ns	
	CKi @ 4.096 MHz				260	ns	Divided Slave Mode
	CKi @ 8.192 MHz				138		
	CKi @ 16.384 MHz				77		

AC Electrical Characteristics[†] - ST-BUS/GCI-Bus Output Tristate Timing

† Characteristics are over recommended operating conditions unless otherwise stated.

* Test condition is $R_L = 1 \text{ k}$, $C_L = 30 \text{ pF}$; high impedance is measured by pulling to the appropriate rail with R_L , with timing corrected to cancel the time taken to discharge C_L .

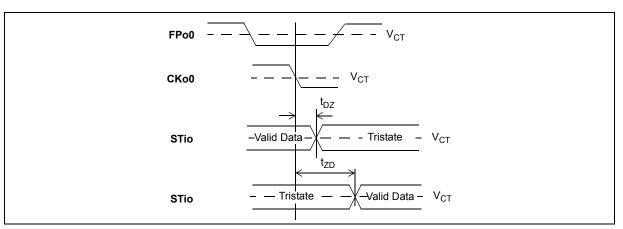


Figure 39 - Serial Output and External Control

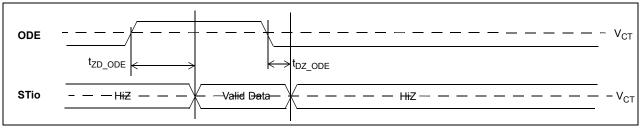


Figure 40 - Output Drive Enable (ODE)

		-					
	Characteristic	Sym.	Min.	Тур.	Max.	Units	Notes
1	Input and Output Frame Offset in Divided Slave with CKi mode	t _{FBOS}	5		13	ns	
2	Input and Output Frame Offset in Multiplied Slave	t _{FBOS}	2		10		Input reference jitter is equal to zero.

AC Electrical Characteristics[†] - Slave Mode Input/Output Frame Boundary Alignment

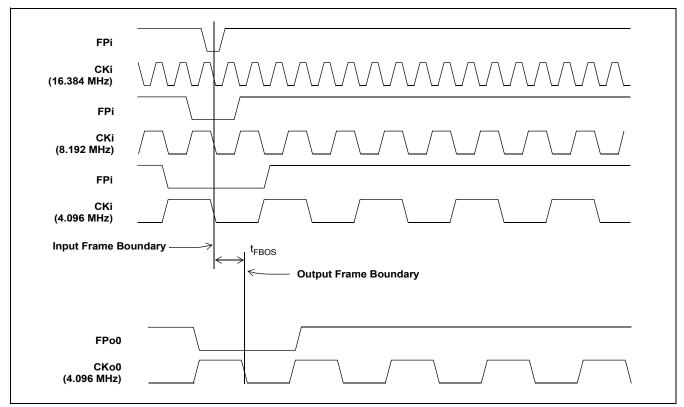


Figure 41 - Input and Output Frame Boundary Offset

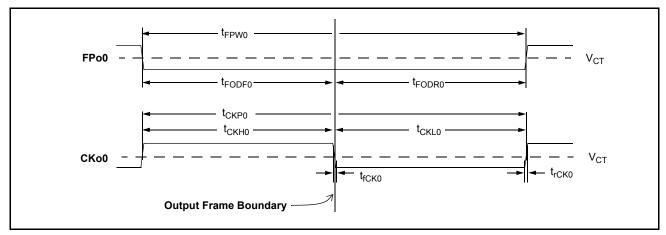


Figure 42 - FPo0 and CKo0 or FPo3 and CKo3 (4.096 MHz) Timing Diagram

AC Electrical Characteristics[†] - FPo0 and CKo0 or FPo3 and CKo3 (4.096 MHz) Timing (Master Mode, Divided Slave Mode, or Multiplied Slave Mode with less than 10 ns of jitter on CKi)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo0 Output Pulse Width	t _{FPW0}	239	244	249	ns	
2	FPo0 Output Delay from the FPo0 falling edge to the output frame boundary	t _{FODF0}	117		127	ns	C _L = 30 pF
3	FPo0 Output Delay from the output frame boundary to the FPo0 rising edge	t _{FODR0}	117		127	ns	
4	CKo0 Output Clock Period	t _{CKP0}	239	244	249	ns	
5	CKo0 Output High Time	t _{CKH0}	117		127	ns	C _L = 30 pF
6	CKo0 Output Low Time	t _{CKL0}	117		127	ns	
7	CKo0 Output Rise/Fall Time	t _{rCK0} , t _{fCK0}			5	ns	

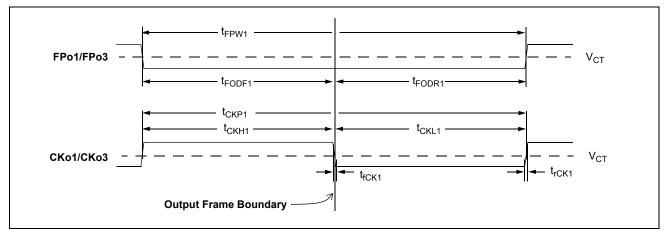
† Characteristics are over recommended operating conditions unless otherwise stated.

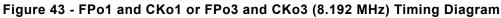
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - FPo0 and CKo0 or FPo3 and CKo3 (4.096 MHz) Timing (Multiplied Slave Mode with more than 10 ns of jitter on CKi)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo0 Output Pulse Width	t _{FPW0}	218	244	270	ns	
2	FPo0 Output Delay from the FPo0 falling edge to the output frame boundary	t _{FODF0}	117		127	ns	C _L = 30 pF
3	FPo0 Output Delay from the output frame boundary to the FPo0 rising edge	t _{FODR0}	97		146	ns	
4	CKo0 Output Clock Period	t _{CKP0}	218	244	270	ns	
5	CKo0 Output High Time	t _{CKH0}	117		127	ns	C _L = 30 pF
6	CKo0 Output Low Time	t _{CKL0}	97		146	ns	
7	CKo0 Output Rise/Fall Time	t _{rCK0} , t _{fCK0}			5	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.





AC Electrical Characteristics[†] - FPo1 and CKo1 or FPo3 and CKo3 (8.192 MHz) Timing (Master Mode, Divided Slave Mode, or Multiplied Slave Mode with less than 10 ns of jitter on CKi)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo1 Output Pulse Width	t _{FPW1}	117	122	127	ns	
2	FPo1 Output Delay from the FPo1 falling edge to the output frame boundary	t _{FODF1}	56		66	ns	C _L = 30 pF
3	FPo1 Output Delay from the output frame boundary to the FPo1 rising edge	t _{FODR1}	56		66	ns	
4	CKo1 Output Clock Period	t _{CKP1}	117	122	127	ns	
5	CKo1 Output High Time	t _{CKH1}	56		66	ns	C _L = 30 pF
6	CKo1 Output Low Time	t _{CKL1}	56		66	ns	
7	CKo1 Output Rise/Fall Time	t _{rCK1} , t _{fCK1}			5	ns	

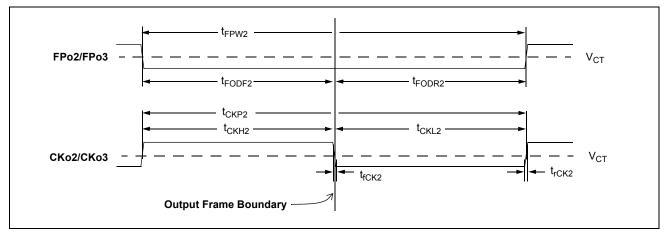
+ Characteristics are over recommended operating conditions unless otherwise stated.

‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - FPo1 and CKo1 or FPo3 and CKo3 (8.192 MHz) Timing (Multiplied Slave Mode with more than 10 ns of jitter on CKi)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo1 Output Pulse Width	t _{FPW1}	106	122	127	ns	
2	FPo1 Output Delay from the FPo1 falling edge to the output frame boundary	t _{FODF1}	56		66	ns	C _L = 30 pF
3	FPo1 Output Delay from the output frame boundary to the FPo1 rising edge	t _{FODR1}	46		66	ns	
4	CKo1 Output Clock Period	t _{CKP1}	106	122	148	ns	
5	CKo1 Output High Time	t _{CKH1}	46		87	ns	C _L = 30 pF
6	CKo1 Output Low Time	t _{CKL1}	46		87	ns	
7	CKo1 Output Rise/Fall Time	t _{rCK1} , t _{fCK1}			5	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.





AC Electrical Characteristics[†] - FPo2 and CKo2 or FPo3 and CKo3 (16.384 MHz) Timing (Master Mode, Divided Slave Mode, or Multiplied Slave Mode with less than 10 ns of jitter on CKi)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo2 Output Pulse Width	t _{FPW2}	56	61	66	ns	
2	FPo2 Output Delay from the FPo2 falling edge to the output frame boundary	t _{FODF2}	25		36	ns	C _L = 30 pF
3	FPo2 Output Delay from the output frame boundary to the FPo2 rising edge	t _{FODR2}	25		36	ns	
4	CKo2 Output Clock Period	t _{CKP2}	56	61	66	ns	
5	CKo2 Output High Time	t _{CKH2}	25		36	ns	C _L = 30 pF
6	CKo2 Output Low Time	t _{CKL2}	25		36	ns	
7	CKo2 Output Rise/Fall Time	t _{rCK2} , t _{fCK2}			5	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - FPo2 and CKo2 or FPo3 and CKo3 (16.384 MHz) Timing (Multiplied Slave Mode with more than 10 ns of jitter on CKi)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo2 Output Pulse Width	t _{FPW2}	56	61	66	ns	
2	FPo2 Output Delay from the FPo2 falling edge to the output frame boundary	t _{FODF2}	25		36	ns	C _L = 30 pF
3	FPo2 Output Delay from the output frame boundary to the FPo2 rising edge	t _{FODR2}	25		36	ns	
4	CKo2 Output Clock Period	t _{CKP2}	47	61	76	ns	
5	CKo2 Output High Time	t _{СКН2}	17		43	ns	C _L = 30 pF
6	CKo2 Output Low Time	t _{CKL2}	17		43	ns	
7	CKo2 Output Rise/Fall Time	t _{rCK2} , t _{fCK2}			5	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

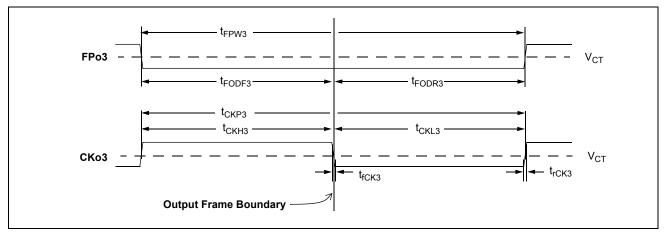


Figure 45 - FPo3 and CKo3 (32.768 MHz) Timing Diagram

AC Electrical Characteristics[†] - FPo3 and CKo3 (32.768 MHz) Timing (Master Mode, Divided Slave Mode, or Multiplied Slave Mode with less than 10 ns of jitter on CKi)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo3 Output Pulse Width	t _{FPW3}	27	30.5	34	ns	
2	FPo3 Output Delay from the FPo3 falling edge to the output frame boundary	t _{FODF3}	10		18	ns	C _L = 30 pF
3	FPo3 Output Delay from the output frame boundary to the FPo3 rising edge	t _{FODR3}	10		21	ns	
4	CKo3 Output Clock Period	t _{CKP3}	27	30.5	34	ns	
5	CKo3 Output High Time	t _{СКНЗ}	12		19	ns	C _L = 30 pF
6	CKo3 Output Low Time	t _{CKL3}	12		19	ns	
7	CKo3 Output Rise/Fall Time	t _{rCK3} , t _{fCK3}			5	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - FPo3 and CKo3 (32.768 MHz) Timing (Multiplied Slave Mode with more than 10 ns of jitter on CKi

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo3 Output Pulse Width	t _{FPW3}	27	30.5	34	ns	
2	FPo3 Output Delay from the FPo3 falling edge to the output frame boundary	t _{FODF3}	12		19	ns	C _L = 30 pF
3	FPo3 Output Delay from the output frame boundary to the FPo3 rising edge	t _{FODR3}	12		19	ns	
4	CKo3 Output Clock Period	t _{CKP3}	17	30.5	44	ns	
5	CKo3 Output High Time	t _{СКНЗ}	5		32	ns	C _L = 30 pF
6	CKo3 Output Low Time	t _{CKL3}	12		18	ns	
7	CKo3 Output Rise/Fall Time	t _{rCK3} , t _{fCK3}			5	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

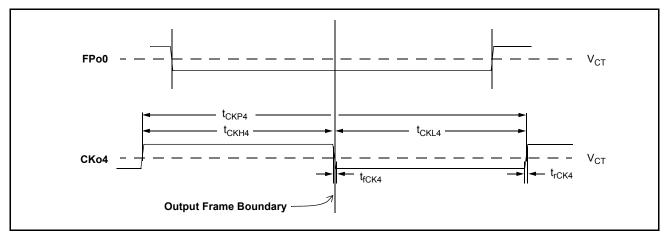


Figure 46 - FPo4 and CKo4 Timing Diagram (1.544/2.048 MHz)

AC Electrical Characteristics[†] - CKo4 (1.544 MHz) Timing (Only when DPLL is active)

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Notes
1	CKo4 Output Clock Period	t _{CKP4}	645		650	ns	
2	CKo4 Output High Time	t _{CKH4}	320		327	ns	C _L =30pF
3	CKo4 Output Low Time	t _{CKL4}	320		327	ns	
4	CKo4 Output Rise/Fall Time	t _{rCK4} , t _{fCK4}			5	ns	

+ Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - CKo4 (2.048 MHz) Timing (Only when DPLL is active)

	Characteristic	Sym.	Min.	Тур.	Max.	Units	Notes
1	CKo4 Output Clock Period	t _{CKP4}	485		492	ns	
2	CKo4 Output High Time	t _{CKH4}	241		247	ns	C _L =30pF
3	CKo4 Output Low Time	t _{CKL4}	241		247	ns	
4	CKo4 Output Rise/Fall Time	t _{rCK4} , t _{fCK4}			5	ns	

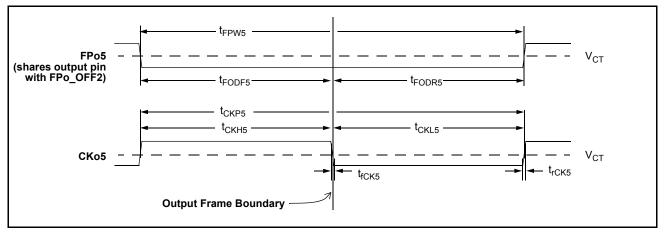


Figure 47 - CKo5 Timing Diagram

AC Electrical Characteristics [†] - CM	o5 (19.44 MHz) Timing	g (Only when DPLL is active)
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	Characteristic	Sym.	Min.	Тур.	Max.	Units	Notes
1	FPo5 Output Pulse Width	t _{FPW5}	49		55	ns	
2	FPo5 Output Delay from the FPo5 falling edge to the output frame boundary	t _{FODF5}	22		28	ns	C _L = 30pF
3	FPo5 Output Delay from the output frame boundary to the FPo5 rising edge	t _{FODR5}	21		32	ns	
4	CKo5 Output Clock Period	t _{CKP5}	50		53	ns	
5	CKo5 Output High Time	t _{CKH5}	23		27	ns	
6	CKo5 Output Low Time	t _{CKL5}	24		28	ns	
7	CKo5 Output Rise/Fall Time	t _{rCK5} , t _{fCK5}			5	ns	

AC Electrical Characteristics[†] - REF0-3 Reference Input to CKo Output Timing

	Characteristic	Sym.	Min.	Max.	Units	Notes [‡]
1	Minimum input pulse width high or low	t _{RPMIN}	16		ns	1,2,3,16
2	Input rise or fall time	$t_{IR,(or} t_{IF)}$		5	ns	
3	Input to CKo0 output delay (no input jitter) with reference	t _{RD}			ns	
	8 k, 2 M, 4 M, 8 M and 16 MHz		-7	0		
	1.544 MHz 19.44 MHz		6 -10	15 -2		

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ See "Performance Characteristics Notes" on page 133

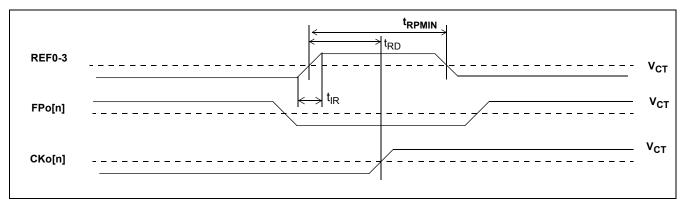


Figure 48 - REF0 - 3 Reference Input/Output Timing

AC Electrical Characteristics[†] - Master Mode Output Timing

	Characteristic	Sym.	Min.	Max.	Units	Notes [‡]
1	CKo0 to CKo1 (8.192 MHz) delay	t _{C1D}	-1	2	ns	1-5,16
2	CKo0 to CKo2 (16.384 MHz) delay	t _{C2D}	-1	3	ns	
3	CKo0 to CKo3 (32.768 MHz/16.384 MHz/8.192 MHz/4.096 MHz) delay	t _{C3D}	-4	0	ns	
4	CKo0 to CKo4 delay 2.048 MHz 1.544 MHz	t _{C4D}	-2 -12	3 7	ns	
5	CKo0 to CKo5 (19.44 MHz) delay	t _{C5D}	6	12	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ See "Performance Characteristics Notes" on page 133

AC Electrical Characteristics[†] - Divided Slave Mode Output Timing

	Characteristic	Sym.	Min.	Max.	Units	Notes [‡]
1	CKo0 to CKo1 (8.192 MHz) delay	t _{C1D}	-1	2	ns	1-5,16
2	CKo0 to CKo2 (16.384 MHz) delay	t _{C2D}	-1	3	ns	
3	CKo0 to CKo3 (32.768 MHz/16.384 MHz/8.192 MHz/4.096 MHz) delay	t _{C3D}	-2	2	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ See "Performance Characteristics Notes" on page 133

AC Electrical Characteristics[†] - Multiplied Slave Mode Output Timing

	Characteristic	Sym.	Min.	Max.	Units	Notes [‡]
1	CKo0 to CKo1 (8.192 MHz) delay	t _{C1D}	-1	2	ns	1-5,16
2	CKo0 to CKo2 (16.384 MHz) delay	t _{C2D}	-1	3	ns	
3	CKo0 to CKo3 (32.768 MHz/16.384 MHz/8.192 MHz/4.096 MHz) delay	t _{C3D}	-1	3	ns	

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ See "Performance Characteristics Notes" on page 133

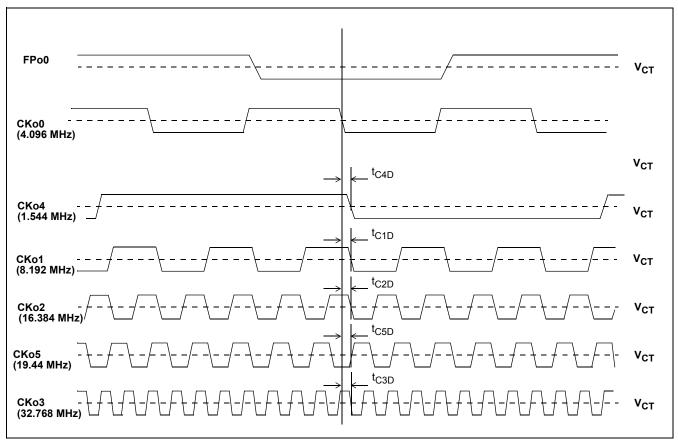


Figure 49 - Output Timing (ST-BUS Format)

DPLL Performance Characteristics[†] - Accuracy & Switching

	Characteristics	Min.	Max.	Units	Conditions/Notes [‡]
1	Freerun Mode accuracy	-0.003	0	ppm	1,5,7
2	Initial Holdover Frequency Stability	-0.03	0.03	ppm	1,4,8
3	Pull-in/Hold-in range (Stratum 3)	-20	20	ppm	1,3,7,9
4	Reference Far Hysteresis Limit (Stratum 3)	-11.4	11.4	ppm	1,3,7,9,15
5	Reference Near Hysteresis Limit (Stratum 3)	-9.8	9.8	ppm	
6	Output phase continuity for reference switch ¹		31	ns	15
7	Normal output phase alignment speed (phase slope)		56	μs/s	10
8	Normal Phase lock time ²		60	s	1,3,7,9,10,12
9	Fast phase lock time		1	s	1,3,7,9,10,11,12

1. Reference switching to normal, holdover, or freerun mode

2. -4.6 to +4.6 ppm locking

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ See "Performance Characteristics Notes" on page 133

	Characteristics	Typ.‡	Units	Conditions/Notes*
1	Jitter at CKo0 and CKo3 (4.096 MHz)	810	ps-pp	1-6,16
2	Jitter at CKo1 and CKo3 (8.192 MHz)	800	ps-pp	
3	Jitter at CKo2 and CKo3 (16.384 MHz)	710	ps-pp	
4	Jitter at CKo3 (4.096, 8.192, 16.384, or 32.768 MHz)	670	ps-pp	
5	Jitter at CKo4 (1.544 MHz or 2.048 MHz) 1.544 MHz 2.048 MHz	1060 630	ps-pp ps-pp	
6	Jitter at CKo5 (19.44 MHz) unfiltered jitter 500 Hz - 1.3 MHz jitter 65 kHz - 1.3 MHz jitter 12 kHz - 1.3 MHz jitter	770 540 460 510	ps-pp ps-pp ps-pp ps-pp	

DPLL Performance Characteristics[†] - Output Jitter Generation (Unfiltered except for CKo5)

† Characteristics are over recommended operating conditions unless otherwise stated.

‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

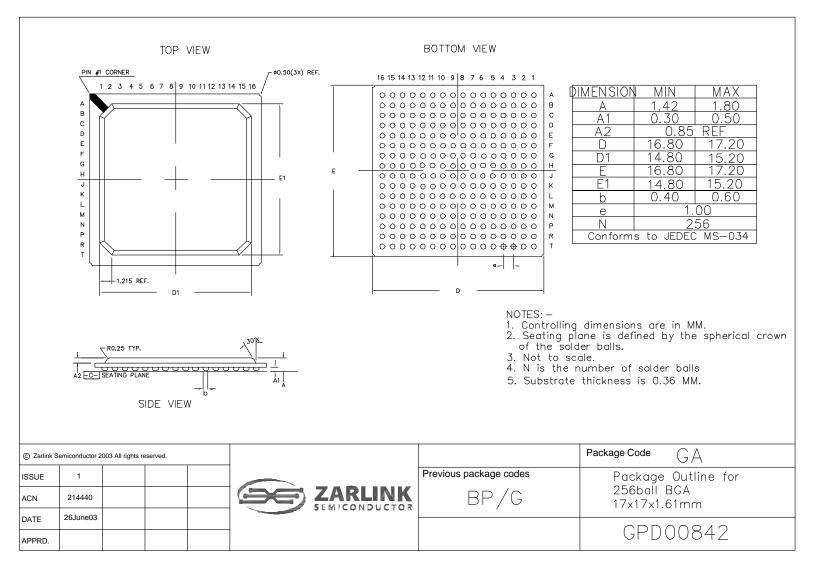
* See "Performance Characteristics Notes" on page 133.

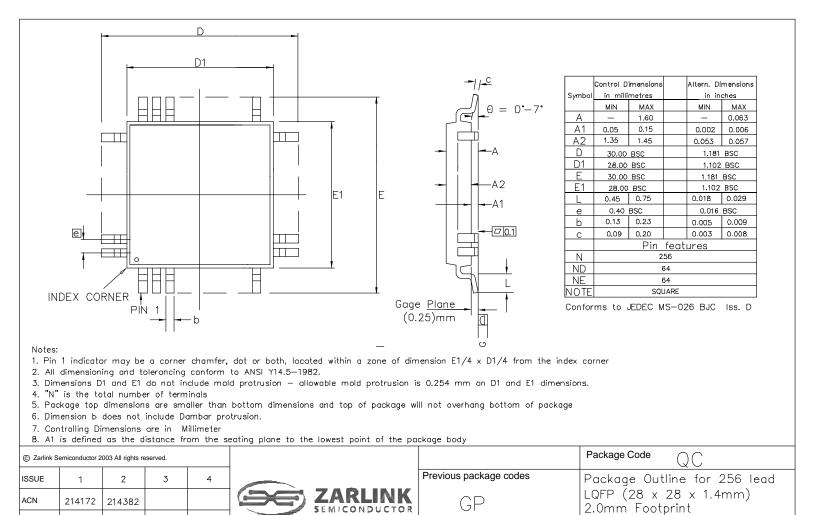
Performance Characteristics Notes

† Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, V_{DD_CORE} at 1.8 V and V_{DD_IO} at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

- 1. Jitter on master clock input (XIN) is 100 ps pp or less.
- 2. Jitter on reference input (REF0-3) is 2 ns pp or less.
- 3. Normal Mode selected.
- 4. Holdover Mode selected.
- 5. Freerun Mode selected.
- 6. Jitter is measured without an output filter.
- 7. Accuracy of master clock input (XIN) is 0 ppm.
- 8. Accuracy of master clock input (XIN) is 100 ppm.
- 9. Capture range is programmed to +/-20 ppm; inaccuracy of XIN shifts this range.
- 10. Phase alignment speed (phase slope) is programmed to 7 ns/125 μ s.
- 11. Fast lock is enabled.
- 12. Low pass filter is programmed to 1.9 Hz.
- 13. Applies to all programmable low pass filter selections of 1.9 Hz and above.
- 14. Any input reference switch or state switch (e.g.; REF0 to REF3, Normal to Holdover, etc.).
- 15. Auto-holdover is programmed to 9.913 ppm & 11.287 ppm.
- 16. 30 pF load on output pin.





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